











LMK04228
ZHCSK16A – OCTOBER 2017 – REVISED JULY 2019

# 具有双环路 PLL 的 LMK04228 超低噪声且符合 JESD204B 标准的时钟抖动清除器

## 1 特性

- JEDEC JESD204B 支持
- 超低 RMS 抖动
  - 156fs RMS 抖动(12kHz 至 20MHz)
  - 245fs RMS 抖动(100Hz 至 20MHz)
  - 245.76MHz 时具有 -162.5dBc/Hz 本底噪声
- PLL2 提供多达 14 个差动器件时钟
  - 多达 7 个 SYSREF 时钟
  - 最高时钟输出频率: 1.25GHz
  - PLL2 提供 LVPECL、LVDS 可编程输出
- PLL1 提供缓冲的 VCXO 或晶体输出
  - LVPECL、LVDS、2xLVCMOS 可编程输出
- 双环路 PLLatinum™锁相环 (PLL) 架构
- PLL1
  - 多达3个冗余输入时钟
    - 自动和手动切换模式
    - 无中断切换和 LOS
  - 集成低噪声晶体振荡器电路
  - 输入时钟丢失时采用保持模式

#### PLL2

- 标准 [1Hz] PLL 本底噪声为 -224dBc/Hz
- 相位检测器频率高达 155MHz
- OSCin 倍频器
- 两个集成低噪声 VCO
- 50% 占空比输出分配,1至32 (偶数和奇数)
- 精密数字延迟
- 25ps 步长模拟延迟
- 多模式:双 PLL 或单 PLL
- 工业温度范围: -40°C 至 85°C
- 3.15V 至 3.45V 工作电压
- 封装: 64 引脚 WQFN (9.0 × 9.0 × 0.8mm)

## 2 应用

- 无线基础设施
- 数据转换器时钟
- 网络、SONET/SDH、DSLAM
- 医疗/视频/军事/航天
- 测试和测量

# 3 说明

LMK04228 器件是支持 JEDEC JESD204B 且在业界 具有高性能的时钟调节器。

PLL2 可以配置 14 个时钟输出以驱动 7 个 JESD204B 转换器或其他逻辑器件(使用器件和 SYSREF 时钟)。SYSREF 可以通过直流和交流耦合提供。不只是 JESD204B 应用,14 个输出中的每一个输出都可以单独配置为用于传统时钟系统的高性能输出。

LMK04228 既具有出色的性能, 又具有 多种特性, 如功率和性能均衡调节、双 VCO、保持模式和可根据输出调节的模拟和数字延迟, 是提供灵活的高性能时钟树的理想器件。

## 器件信息(1)

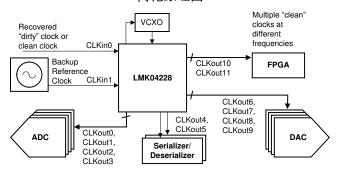
| 器件型号     | 封装        | 封装尺寸 (标称值)      |  |
|----------|-----------|-----------------|--|
| LMK04228 | WQFN (64) | 9.00mm x 9.00mm |  |

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附录。

## 频率输出

| 器件型号     | VCO0 频率              | VCO1 频率           |
|----------|----------------------|-------------------|
| LMK04228 | 2370MHz 至<br>2630MHz | 2920MHz 至 3080MHz |

## 简化原理图



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| 1 | 特性1  |     | 9.3 Feature Description                                   | 23 |
|---|--|-----|---|----|
| 2 | 应用1  |     | 9.4 Programming   |    |
| 3 |  |     | 9.5 Register Maps   |    |
| 4 | 修订历史记录   | 10  | Application and Implementation                            | 75 |
| 5 | Device Comparison Table 4                            |     | 10.1 Application Information                              | 75 |
| 6 | Pin Configuration and Functions4                     |     | 10.2 Typical Application                                  | 78 |
| 7 | _  |     | 10.3 Do's and Don'ts                                      | 79 |
| ′ | Specifications 6 7.1 Absolute Maximum Ratings 6      | 11  | Power Supply Recommendations                              | 80 |
|   | 7.2 ESD Ratings                                      |     | 11.1 Current Consumption / Power Dissipation Calculations | 80 |
|   | 7.3 Recommended Operating Conditions 6               | 12  | Layout  | 81 |
|   | 7.4 Thermal Information                              |     | 12.1 Layout Guidelines                                    |    |
|   | 7.5 Electrical Characteristics                       |     | 12.2 Layout Example                                       |    |
|   | 7.6 SPI Interface Timing                             | 13  | 器件和文档支持   |    |
|   | 7.7 Timing Diagram                                   |     | 13.1 器件支持   |    |
| 8 | Parameter Measurement Information 15                 |     | 13.2 社区资源   |    |
|   | 8.1 Charge Pump Current Specification Definitions 15 |     | 13.3 商标   |    |
|   | 8.2 Differential Voltage Measurement Terminology 16  |     | 13.4 静电放电警告   |    |
| 9 | Detailed Description 17                              |     | 13.5 Glossary   |    |
|   | 9.1 Overview 17                                      | 14  | 机械、封装和可订购信息   |    |
|   | 9.2 Functional Block Diagrams                        | 1-7 | <b>ル むかい マコッダイト こ 1 以 以 日 5</b>                           | 00 |
|   |  |     |   |    |

# 4 修订历史记录

| Cł | hanges from Original (October 2017) to Revision A  | Page |
|----|--|------|
| •  | 将数据表版本状态从产品定制更改为产品目录   | 1    |
| •  | 已删除 删除了有关分配模式的参考内容(不支持)  | 1    |
| •  | 已删除 删除了有关动态延迟的参考内容(不支持)  | 1    |
| •  | Updated default output table note  | 11   |
| •  | Added missing cross reference to differential voltage definition                                     | 12   |
| •  | Removed typical phase noise plots  | 13   |
| •  | Updated description for improved clarity   | 17   |
| •  | Deleted reference to distribution mode (unsupported)   | 17   |
| •  | Updated delay circuit descriptions for improved clarity  | 18   |
| •  | Deleted reference to dynamic delay (unsupported)   | 19   |
| •  | Deleted reference to dynamic delay, bypass mode in clock output block diagram (unsupported)          | 21   |
| •  | Deleted reference to distribution mode in SYNC/SYSREF clocking path diagram (unsupported)            | 22   |
| •  | Clarified digital lock detect for cases where phase detector frequency exceeds default PLL1_WND_SIZE | 29   |
| •  | Removed device functional modes section  | 32   |
| •  | Clarified requirements for unused registers in recommended programming sequence                      | 32   |
| •  | Added registers 0x171 and 0x172 to default register programming                                      | 32   |
| •  | Deleted redundant user-inaccessible registers in register map  | 33   |
| •  | Changed address bits to clarify address position relative to data bits                               | 33   |
| •  | Deleted references to dynamic delay in register map (unsupported)                                    | 33   |
| •  | Corrected CLKinX_R register size in register map   | 35   |
| •  | Corrected PLL1_N register size in register map   | 35   |
| •  | Deleted reference to DCLKoutX_MUX bypass mode (unsupported)  | 40   |
| •  | Corrected delay value descriptions for SDCLKoutY_ADLY  | 41   |
| •  | Deleted reference to dynamic delay (unsupported)   | 42   |



# 修订历史记录 (接下页)

| • | Updated missing cross-reference  | . 49 |
|---|--|------|
| • | Corrected CLKinX_R register length                                       | . 59 |
| • | Corrected PLL1_N register length   | 60   |
| • | Corrected PLL2_R register length   | 64   |
| • | Split PLL2_FCAL_DIS and PLL2_N register tables into separate definitions | . 66 |
| • | Added register 0x171 and 0x172 to register descriptions                  | . 72 |
| • | Corrected RB_PLL1_LD and RB_PLL2_LD polarity                             | . 73 |
| • | Added note clarifying PLL1_WND_SIZE and impact on holdover exit          | . 75 |
| • | Changed references to deprecated software tools to point to TICS Pro     | . 78 |
| • | Removed application curves section                                       | . 79 |
| • | Deleted unused column in typical current consumption table               | . 80 |
| • | Fixed truncated layout example image                                     | . 82 |
| • | 已删除 删除了弃用软件工具的链接   | 83   |
|   |  |      |



## 5 Device Comparison Table

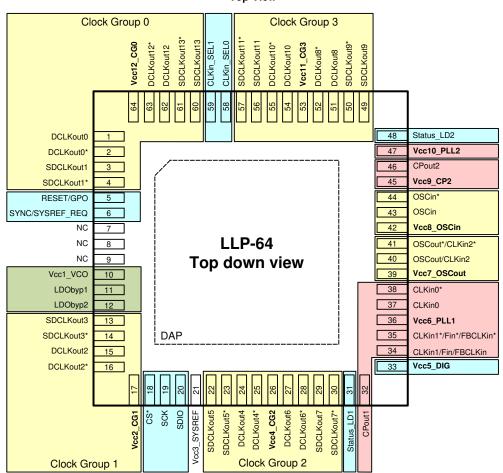
**Table 1. Device Configuration Information** 

| PART NUMBER | REF-<br>ERENCE<br>INPUTS <sup>(1)</sup> | OSCout (BUFFERED<br>OSCin Clock) LVDS/<br>LVPECL/ LVCMOS <sup>(1)</sup> | PLL2<br>PROGRAMMABLE<br>LVDS/LVPECL<br>OUTPUTS | VCO0 FREQUENCY   | VCO1 FREQUENCY   |
|-------------|---|---|--|------------------|------------------|
| LMK04228    | Up to 3                                 | Up to 1   | 14   | 2370 to 2630 MHz | 2920 to 3080 MHz |

<sup>(1)</sup> OSCout may also be third clock input, CLKin2.

# 6 Pin Configuration and Functions

#### NKD Package 64-Pin WQFN Top View



## Pin Functions<sup>(1)</sup>

| PIN |            | I/O TYPE | DESCRIPTION  |                                |
|-----|------------|----------|--------------|--------------------------------|
| NO. | NAME       | 1/0      | TYPE         | DESCRIPTION                    |
| 1   | DCLKout0   | 0        | Programmable | Device clock output 0.         |
| 2   | DCLKout0*  |          |              |                                |
| 3   | SDCLKout1  | 0        | Programmable | SYSREF / Device clock output 1 |
| 4   | SDCLKout1* | U        |              |                                |

(1) See Pin Connection Recommendations section for recommended connections.



# Pin Functions<sup>(1)</sup> (continued)

|          | PIN CONTINUES (CONTINUES) |     |              |   |  |  |  |
|----------|---------------------------|-----|--------------|---|--|--|--|
| NO.      | NAME                      | I/O | TYPE         | DESCRIPTION   |  |  |  |
| 5        | RESET/GPO                 | ı   | CMOS         | Device reset input or GPO   |  |  |  |
| 6        | SYNC/SYSREF_REQ           | I   | CMOS         | Synchronization input or SYSREF_REQ for requesting continuous SYSREF. |  |  |  |
| 7, 8, 9  | NC                        | _   | _            | Do not connect. These pins must be left floating.                     |  |  |  |
| 10       | Vcc1_VCO                  | _   | PWR          | Power supply for VCO LDO.   |  |  |  |
| 11       | LDObyp1                   | _   | ANLG         | LDO Bypass, bypassed to ground with 10-µF capacitor.                  |  |  |  |
| 12       | LDObyp2                   | _   | ANLG         | LDO Bypass, bypassed to ground with a 0.1-μF capacitor.               |  |  |  |
| 13       | SDCLKout3                 |     |              |   |  |  |  |
| 14       | SDCLKout3*                | 0   | Programmable | SYSREF / Device Clock output 3.                                       |  |  |  |
| 15       | DCLKout2                  |     |              |   |  |  |  |
| 16       | DCLKout2*                 | 0   | Programmable | Device clock output 2.  |  |  |  |
| 17       | Vcc2_CG1                  | _   | PWR          | Power supply for clock outputs 2 and 3.                               |  |  |  |
| 18       | CS*                       | ı   | CMOS         | Chip Select   |  |  |  |
| 19       | SCK                       | i   | CMOS         | SPI Clock   |  |  |  |
| 20       | SDIO                      | I/O | CMOS         | SPI Data  |  |  |  |
| 21       | Vcc3_SYSREF               | -   | PWR          | Power supply for SYSREF divider and SYNC.                             |  |  |  |
| 22       | SDCLKout5                 |     | TVIX         | Tower supply for OTONEL divides and OTNO.                             |  |  |  |
| 23       | SDCKLout5*                | 0   | Programmable | SYSREF / Device clock output 5.                                       |  |  |  |
|          |                           |     |              |   |  |  |  |
| 24       | DCLKout4                  | 0   | Programmable | Device clock output 4.  |  |  |  |
| 25       | DCLKout4*                 |     |              |   |  |  |  |
| 26       | Vcc4_CG2                  | _   | PWR          | Power supply for clock outputs 4, 5, 6 and 7.                         |  |  |  |
| 27       | DCLKout6                  | 0   | Programmable | Device clock output 6.  |  |  |  |
| 28       | DCLKout6*                 |     |              | ·   |  |  |  |
| 29       | SDCLKout7                 | 0   | Programmable | SYSREF / Device clock output 7.                                       |  |  |  |
| 30       | SDCLKout7*                |     |              | '   |  |  |  |
| 31       | Status_LD1                | I/O | Programmable | Programmable status pin.  |  |  |  |
| 32       | CPout1                    | 0   | ANLG         | Charge pump 1 output.   |  |  |  |
| 33       | Vcc5_DIG                  | _   | PWR          | Power supply for the digital circuitry.                               |  |  |  |
| 34       | CLKin1                    | 1   | ANLG         | Reference Clock Input Port 1 for PLL1.                                |  |  |  |
| 35       | CLKin1*                   |     | 711120       | Noticional Charlet Fact Flori Feet.                                   |  |  |  |
| 36       | Vcc6_PLL1                 | _   | PWR          | Power supply for PLL1, charge pump 1, holdover DAC                    |  |  |  |
| 37       | CLKin0                    | ı   | ANLG         | Reference Clock Input Port 0 for PLL1.                                |  |  |  |
| 38       | CLKin0*                   |     | AIVLO        | Neierence Glock input For Color FEET.                                 |  |  |  |
| 39       | Vcc7_OSCout               | _   | PWR          | Power supply for OSCout port.   |  |  |  |
| 40       | OSCout/CLKin2             | 0   | Programmable | Buffered output of OSCin port.  |  |  |  |
| 41       | OSCout*/CLKin2*           | U   | Frogrammable | Reference Clock Input Port 2 for PLL1.                                |  |  |  |
| 42       | Vcc8_OSCin                | _   | PWR          | Power supply for OSCin  |  |  |  |
| 43       | OSCin                     |     | ANLG         | Feedback to PLL1, Reference input to PLL2, AC-coupled.                |  |  |  |
| 44       | OSCin*                    |     | ANLG         | reeaback to PLL1, Reference input to PLL2. AC-coupled.                |  |  |  |
| 45       | Vcc9_CP2                  | _   | PWR          | Power supply for PLL2 Charge Pump.                                    |  |  |  |
| 46       | CPout2                    | 0   | ANLG         | Charge pump 2 output.   |  |  |  |
| 47       | Vcc10_PLL2                | _   | PWR          | Power supply for PLL2.  |  |  |  |
| 48       | Status_LD2                | I/O | Programmable | Programmable status pin.  |  |  |  |
| 49       | SDCLKout9                 |     | -            |   |  |  |  |
| 50       | SDCLKout9*                | 0   | Programmable | SYSREF / Device clock 9   |  |  |  |
| 51       | DCLKout8                  |     |              |   |  |  |  |
| 52       | DCLKout8*                 | 0   | Programmable | Device clock output 8.  |  |  |  |
| 53       | Vcc11_CG3                 | _   | PWR          | Power supply for clock outputs 8, 9, 10, and 11.                      |  |  |  |
| 54       | DCLKout10                 |     | -            |   |  |  |  |
| 55       | DCLKout10*                | 0   | Programmable | Device clock output 10.   |  |  |  |
| 56       | SDCLKout11                |     |              |   |  |  |  |
| 57       | SDCLKout11*               | 0   | Programmable | SYSREF / Device clock output 11.                                      |  |  |  |
|          |                           | I/O | Programmable | Programmable status nin   |  |  |  |
| 58<br>59 | CLKin_SEL0                | 1/0 | •            | Programmable status pin.  |  |  |  |
|          | CLKin_SEL1                | 1/0 | Programmable | Programmable status pin.  |  |  |  |
| 60       | SDCLKout13                | 0   | Programmable | SYSREF / Device clock output 13.                                      |  |  |  |
| 61       | SDCLKout13*               |     |              |   |  |  |  |



## Pin Functions<sup>(1)</sup> (continued)

| PIN |            | I/O | TYPE         | DESCRIPTION                                      |
|-----|------------|-----|--------------|--|
| NO. | NAME       | 1/0 | ITPE         | DESCRIPTION                                      |
| 62  | DCLKout12  | 0   | Programmable | Device clock output 12.                          |
| 63  | DCLKout12* |     |              |  |
| 64  | Vcc12_CG0  | _   | PWR          | Power supply for clock outputs 0, 1, 12, and 13. |
| _   | DAP        | _   | GND          | DIE ATTACH PAD, connect to GND.                  |

# 7 Specifications

## 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)(2)(3)

|                  |  | MIN  | MAX              | UNIT |
|------------------|--|------|------------------|------|
| V <sub>CC</sub>  | Supply voltage <sup>(4)</sup>                        | -0.3 | 3.6              | V    |
| V <sub>IN</sub>  | Input voltage  | -0.3 | $(V_{CC} + 0.3)$ | V    |
| TL               | Lead temperature (solder 4 seconds)                  |      | +260             | °C   |
| T <sub>J</sub>   | Junction temperature                                 |      | 150              | °C   |
| I <sub>IN</sub>  | Differential input current (CLKinX/X*, OSCin/OSCin*) |      | ±5               | mA   |
| MSL              | Moisture sensitivity level                           |      | 3                |      |
| T <sub>stg</sub> | Storage temperature                                  | -65  | 150              | °C   |

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) This device is a high performance RF integrated circuit with an ESD rating up to 2-kV Human Body Model, up to 150-V Machine Model, and up to 250-V Charged Device Model and is ESD-sensitive. Handling and assembly of this device should only be done at ESD-free workstations
- (3) Stresses in excess of the absolute maximum ratings can cause permanent or latent damage to the device. These are absolute stress ratings only. Functional operation of the device is only implied at these or any other conditions in excess of those given in the operation sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.
- (4) Never to exceed 3.6 V.

## 7.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
|                    |                         | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)                         | ±2000 |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  | V    |
|                    |                         | Machine model (MM)   | ±150  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions. Pins listed as ±2000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions. Pins listed as ±250 V may actually have higher performance.

## 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                 |                      | MIN  | TYP | MAX  | UNIT |
|-----------------|----------------------|------|-----|------|------|
| $T_J$           | Junction temperature |      |     | 125  | °C   |
| T <sub>A</sub>  | Ambient temperature  | -40  | 25  | 85   | °C   |
| V <sub>CC</sub> | Supply voltage       | 3.15 | 3.3 | 3.45 | V    |



#### 7.4 Thermal Information

|                        |   | LMK04228   |      |
|------------------------|---|------------|------|
|                        | THERMAL METRIC <sup>(1)</sup>                             | NKD (WQFN) | UNIT |
|                        |   | 64 PINS    |      |
| $R_{\theta JA}$        | Junction-to-ambient thermal resistance (2)                | 24.3       | °C/W |
| $R_{\theta JC(top)}$   | Junction-to-case (top) thermal resistance <sup>(3)</sup>  | 6.1        | °C/W |
| $R_{\theta JB}$        | Junction-to-board thermal resistance (4)                  | 3.5        | °C/W |
| ΨЈТ                    | Junction-to-top characterization parameter <sup>(5)</sup> | 0.1        | °C/W |
| ΨЈВ                    | Junction-to-board characterization parameter (6)          | 3.5        | °C/W |
| R <sub>0</sub> JC(bot) | Junction-to-case (bottom) thermal resistance (7)          | 0.7        | °C/W |

- For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.
- (2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, High-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (3) The junction-to-case(top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.
- (4) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.
- (5) The junction-to-top characterization parameter, Ψ<sub>JT</sub>, estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R<sub>θJA</sub>, using a procedure described in JESD51-2a (sections 6 and 7).
   (6) The junction-to-board characterization parameter, Ψ<sub>JB</sub> estimates the junction temperature of a device in a real system and is extracted
- (6) The junction-to-board characterization parameter, Ψ<sub>JB</sub> estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R<sub>θJA</sub>, using a procedure described in JESD51-2a (sections 6 and 7).
- (7) The junction-to-case(bottom) thermal resistance is obtained by simulating a cold plate test on the exposed (power) pad. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

## 7.5 Electrical Characteristics

 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40^{\circ}\text{C} < \text{T}_{A} < 85^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|   | PARAMETER  | TEST CONDITIONS  | MIN   | TYP | MAX  | UNIT |
|---|--|--|-------|-----|------|------|
| CURRENT CO                                    | ONSUMPTION   |  |       |     |      |      |
| I <sub>CC_PD</sub>                            | Power-down supply current  |  |       | 1   | 3    | mA   |
| I <sub>CC_CLKS</sub>                          | Supply current <sup>(1)</sup> 14 LVDS clocks enabled PLL1 and PLL2 locked.     |  |       | 485 |      | mA   |
| CLKin0/0*, CL                                 | Kin1/1*, AND CLKin2/2* INPUT (   | CLOCK SPECIFICATIONS   | ·     |     |      |      |
| f <sub>CLKin</sub>                            | Clock input frequency  |  | 0.001 |     | 400  | MHz  |
| SLEW <sub>CLKin</sub>                         | Clock input slew rate (2)  | 20% to 80%   | 0.15  | 0.5 |      | V/ns |
| V <sub>ID</sub> CLKin                         | Clock input  |  | 0.125 |     | 1.55 | V    |
| V <sub>SS</sub> CLKin                         | differential input voltage (3)<br>Figure 2                                     | AC-coupled   | 0.25  |     | 3.1  | Vpp  |
| V   | Clock input  | AC-coupled to CLKinX;<br>CLKinX* AC-coupled to Ground<br>CLKinX_TYPE = 0 (Bipolar) | 0.25  |     | 2.4  | Van  |
| V <sub>CLKin</sub> single-ended input voltage | AC-coupled to CLKinX;<br>CLKinX* AC-coupled to Ground<br>CLKinX_TYPE = 1 (MOS) | 0.35   |       | 2.4 | Vpp  |      |

See applications section Power Supply Recommendations for specific part configuration and how to calculate the I<sub>CC</sub> for a specific design.

<sup>(2)</sup> To meet the jitter performance listed in the subsequent sections of this data sheet, the minimum recommended slew rate for all input clocks is 0.5 V/ns. This is especially true for single-ended clocks. Phase noise performance will begin to degrade as the clock input slew rate is reduced. However, the device will function at slew rates down to the minimum listed. When compared to single-ended clocks, differential clocks (LVDS, LVPECL) will be less susceptible to degradation in phase noise performance at lower slew rates due to their common-mode noise rejection. However, TI also recommends using the highest possible slew rate for differential clocks to achieve optimal phase noise performance at the device outputs.

<sup>(3)</sup> See Differential Voltage Measurement Terminology for definition of V<sub>ID</sub> and V<sub>OD</sub> voltages.



(3.15 V <  $V_{CC}$  < 3.45 V,  $-40^{\circ}$ C <  $T_{A}$  < 85°C. Typical values at  $V_{CC}$  = 3.3 V,  $T_{A}$  = 25°C, at the Recommended Operating Conditions and are **not** assured.)

|                                       | PARAMETER  | TEST CONDITIONS  | MIN  | TYP         | MAX      | UNIT    |
|---------------------------------------|--|--|------|-------------|----------|---------|
|                                       | DC offset voltage between  | Each pin AC-coupled, CLKin0/1/2<br>CLKinX_TYPE = 0 (Bipolar)                   |      | 0           |          |         |
| $V_{CLKinX-offset}$                   | CLKinX/CLKinX* (CLKinX* – CLKinX)                                  | Each pin AC-coupled, CLKin0/1<br>CLKinX_TYPE = 1 (MOS)                         |      | 55          |          | mV      |
|                                       | DC offset voltage between CLKin2/CLKin2* (CLKin2* – CLKin2)        | Each pin AC-coupled<br>CLKinX_TYPE = 1 (MOS)                                   |      | 20          |          |         |
| V <sub>CLKin-</sub> V <sub>IH</sub>   | High input voltage   | DC-coupled to CLKinX;  | 2    |             | $V_{CC}$ | V       |
| V <sub>CLKin</sub> - V <sub>IL</sub>  | Low input voltage  | CLKinX* AC-coupled to Ground<br>CLKinX_TYPE = 1 (MOS)                          | 0    |             | 0.4      | V       |
| PLL1 SPECIFIC                         | ATIONS   |  |      |             |          |         |
| f <sub>PD1</sub>                      | PLL1 phase detector frequency                                      |  |      |             | 40       | MHz     |
|                                       |  | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 0                     |      | 50          |          |         |
|                                       | $V_{CPout1} = V_{CC}/2$ , PLL1_CP_GAIN = 1                         | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 1                     |      | 150         |          |         |
| I <sub>CPout1</sub> SOURCE            | PLL1 charge  | $V_{CPout1} = V_{CC}/2$ , PLL1_CP_GAIN = 2                                     |      | 250         |          | μΑ      |
| ICPout1300RCL                         | pump source current (4)  |  |      | •••         |          | μΑ      |
|                                       |  | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 14                    |      | 1450        |          |         |
|                                       |  | V <sub>CPout1</sub> = V <sub>CC</sub> /2, PLL1_CP_GAIN = 15                    |      | 1550        |          |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 0                      |      | <b>-</b> 50 |          |         |
| I <sub>CPout1</sub> SINK              | PLL1 charge<br>pump sink current <sup>(4)</sup>                    | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 1                      |      | -150        |          |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 2                      |      | -250        |          |         |
|                                       |  |  |      |             |          | μΑ      |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 14                     |      | -1450       |          |         |
|                                       |  | V <sub>CPout1</sub> =V <sub>CC</sub> /2, PLL1_CP_GAIN = 15                     |      | -1550       |          |         |
| I <sub>CPout1</sub> %MIS              | Charge pump sink / source mismatch                                 | V <sub>CPout1</sub> = V <sub>CC</sub> /2, T = 25 °C                            |      | 1%          | 10%      |         |
| I <sub>CPout1</sub> V <sub>TUNE</sub> | Magnitude of charge pump current variation vs. charge pump voltage | 0.5 V < V <sub>CPout1</sub> < V <sub>CC</sub> - 0.5 V<br>T <sub>A</sub> = 25°C |      | 4%          |          |         |
| I <sub>CPout1</sub> %TEMP             | Charge pump current vs. temperature variation                      |  |      | 4%          |          |         |
| I <sub>CPout1</sub> TRI               | Charge pump TRI-STATE leakage current                              | 0.5 V < V <sub>CPout</sub> < V <sub>CC</sub> - 0.5 V                           |      |             | 5        | nA      |
|                                       | PLL 1/f noise at 10-kHz offset.                                    | PLL1_CP_GAIN = 350 µA  |      | -117        |          |         |
| PN10kHz                               | Normalized to 1-GHz output<br>frequency                            | PLL1_CP_GAIN = 1550 μA   |      | -118        |          | dBc/Hz  |
| DN411-                                | Normalized phase noise   | PLL1_CP_GAIN = 350 µA  |      | -221.5      |          | dDa/Lla |
| PN1Hz                                 | contribution   | PLL1_CP_GAIN = 1550 μA   |      | -223        |          | dBc/Hz  |
| PLL2 REFEREN                          | CE INPUT (OSCin) SPECIFICATI                                       | ONS  |      |             | ·        |         |
| f <sub>OSCin</sub>                    | PLL2 reference input <sup>(5)</sup>                                |  |      |             | 500      | MHz     |
| SLEW <sub>OSCin</sub>                 | PLL2 reference clock minimum slew rate on OSCin (2)                | 20% to 80%   | 0.15 | 0.5         |          | V/ns    |
| V <sub>OSCin</sub>                    | Input voltage for OSCin or OSCin*                                  | AC-coupled; single-ended<br>(Unused pin AC-coupled to GND)                     | 0.2  |             | 2.4      | Vpp     |
| V <sub>ID</sub> OSCin                 | Differential voltage swing   | AQ   | 0.2  |             | 1.55     | V       |
| V <sub>SS</sub> OSCin                 | See Figure 2   | AC-coupled   | 0.4  |             | 3.1      | Vpp     |
| V <sub>OSCin-offset</sub>             | DC offset voltage between OSCin/OSCin* (OSCinX* - OSCinX)          | Each pin AC-coupled  |      | 20          |          | mV      |

<sup>(4)</sup> This parameter is programmable

<sup>(5)</sup> F<sub>OSCin</sub> maximum frequency assured by characterization. Production tested at 122.88 MHz.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40^{\circ}\text{C} < \text{T}_{A} < 85^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                                       | PARAMETER  | TEST CONDITIONS  | MIN TYP | MAX  | UNIT    |
|---------------------------------------|--|--|---------|------|---------|
| f <sub>doubler_max</sub>              | Doubler input frequency (6)  | EN_PLL2_REF_2X = 1 <sup>(7)</sup> ;<br>OSCin duty cycle 40% to 60%                           |         | 155  | MHz     |
| CRYSTAL OSC                           | ILLATOR MODE SPECIFICATION   | S  |         |      |         |
| F <sub>XTAL</sub>                     | Crystal frequency range  | Fundamental mode crystal ESR = $200 \Omega$ (10 to 30 MHz) ESR = $125 \Omega$ (30 to 40 MHz) | 10      | 40   | MHz     |
| C <sub>IN</sub>                       | Input capacitance of OSCin port  | -40°C to +85°C   | 1       |      | pF      |
| PLL2 PHASE D                          | ETECTOR AND CHARGE PUMP  | SPECIFICATIONS   |         |      |         |
| f <sub>PD2</sub>                      | Phase detector frequency (6)   |  |         | 155  | MHz     |
|                                       |  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 0                                    | 100     |      |         |
| I <sub>CPout</sub> SOURCE             | PLL2 charge pump source current <sup>(4)</sup>   | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 1                                    | 400     |      | μΑ      |
|                                       | Current  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 2                                    | 1600    |      |         |
|                                       |  | $V_{CPout2}=V_{CC}/2$ , PLL2_CP_GAIN = 0   | -100    |      |         |
| I <sub>CPout</sub> SINK               | PLL2 charge pump sink current  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 1                                    | -400    |      | μA      |
|                                       | , ,  | V <sub>CPout2</sub> =V <sub>CC</sub> /2, PLL2_CP_GAIN = 2                                    | -1600   |      | •       |
| I <sub>CPout2</sub> %MIS              | Charge pump sink/source mismatch   | V <sub>CPout2</sub> =V <sub>CC</sub> /2, T <sub>A</sub> = 25°C                               | 1%      | 10%  |         |
| I <sub>CPout2</sub> V <sub>TUNE</sub> | Magnitude of charge pump current vs. charge pump voltage variation                         | 0.5 V < V <sub>CPout2</sub> < V <sub>CC</sub> - 0.5 V<br>T <sub>A</sub> = 25°C               | 4%      |      |         |
| I <sub>CPout2</sub> %TEMP             | Charge pump current vs. temperature variation  |  | 4%      |      |         |
| I <sub>CPout2</sub> TRI               | Charge pump leakage  | 0.5 V < V <sub>CPout2</sub> < V <sub>CC</sub> - 0.5 V  |         | 10   | nA      |
| PN10kHz                               | PLL 1/f noise at 10-kHz<br>offset <sup>(8)</sup> . Normalized to<br>1-GHz output frequency | PLL2_CP_GAIN = 1600 μA   | -120    |      | dBc/Hz  |
| DNIII                                 | Normalized phase noise   | PLL2_CP_GAIN = 400 µA  | -222.5  |      | 15 // 1 |
| PN1Hz                                 | contribution (9)   | PLL2_CP_GAIN = 1600 µA   | -224    |      | dBc/Hz  |
| INTERNAL VCC                          | SPECIFICATIONS   |  |         |      |         |
| £                                     | VC00 2370  |  | 2370    | 2630 | N 41 1- |
| $f_{VCO}$                             | LMK04228 VCO tuning range  | VCO1   | 2920    | 3080 | MHz     |
|                                       |  | LMK04228 VCO0 at 2370 MHz <sup>(10)</sup>  | 17      |      |         |
| 17                                    | LMK04228 fine tuning   | LMK04228 VCO0 at 2630 MHz <sup>(10)</sup>  | 27      |      |         |
| K <sub>VCO</sub>                      | sensitivity  | LMK04228 VCO1 at 2920 MHz <sup>(10)</sup>  | 17      |      | MHz/V   |
|                                       |  | LMK04228 VCO1 at 3080 MHz <sup>(10)</sup>  | 23      |      | :       |
|                                       |  | I .  |         |      |         |

(7) The EN\_PLL2\_REF\_2X bit enables/disables a frequency doubler mode for the PLL2 OSCin path.

(10) For frequencies in between, linearly interpolate to compute the typical Kvco

<sup>(6)</sup> Assured by characterization. ATE tested at 122.88 MHz.

<sup>(8)</sup> A specification in modeling PLL in-band phase noise is the 1/f flicker noise, L<sub>PLL\_flicker</sub>(f), which is dominant close to the carrier. Flicker noise has a 10 dB/decade slope. PN10kHz is normalized to a 10-kHz offset and a 1-GHz carrier frequency. PN10kHz = L<sub>PLL\_flicker</sub>(10 kHz) – 20log(Fout / 1 GHz), where L<sub>PLL\_flicker</sub>(f) is the single-side band phase noise of only the flicker noise's contribution to total noise, L(f). To measure L<sub>PLL\_flicker</sub>(f) it is important to be on the 10 dB/decade slope close to the carrier. A high compare frequency and a clean crystal are important to isolating this noise source from the total phase noise, L(f). L<sub>PLL\_flicker</sub>(f) can be masked by the reference oscillator performance if a low power or noisy source is used. The total PLL in-band phase noise performance is the sum of L<sub>PLL\_flicker</sub>(f) and L<sub>PLL\_flat</sub>(f).

<sup>(9)</sup> A specification modeling PLL in-band phase noise. The normalized phase noise contribution of the PLL, L<sub>PLL\_flat</sub>(f), is defined as: PN1HZ=L<sub>PLL\_flat</sub>(f) - 20log(N) - 10log(f<sub>PDX</sub>). L<sub>PLL\_flat</sub>(f) is the single-side band phase noise measured at an offset frequency, f, in a 1-Hz bandwidth and f<sub>PDX</sub> is the phase detector frequency of the synthesizer. L<sub>PLL\_flat</sub>(f) contributes to the total noise, L(f).



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40^{\circ}\text{C} < \text{T}_{A} < 85^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                         | PARAMETER   | TES                            | T CONDITIONS   | MIN               | TYP    | MAX | UNIT    |
|-------------------------|---|--------------------------------|--|-------------------|--------|-----|---------|
| ΔT <sub>CL</sub>        | Allowable temperature drift for continuous lock <sup>(11)</sup>                             |                                | ning for lock, no changes<br>guration are permitted to<br>ous lock |                   |        | 125 | °C      |
| NOISE FLOO              | R   |                                |  |                   |        |     |         |
|                         |   |                                | LVDS   |                   | -156.3 |     |         |
| L(f) <sub>CLKout</sub>  | LMK04228, VCO0, noise floor<br>20-MHz offset <sup>(12)</sup>                                | 245.76 MHz                     | LVPECL16 with 240 $\Omega$   |                   | -161.6 |     | dBc/Hz  |
|                         |   |                                | LVPECL20 with 240 $\Omega$   |                   | -162.5 |     |         |
|                         | LMIKO 1000 MOO4 see to floor  |                                | LVDS   |                   | -155.7 |     |         |
| $L(f)_{CLKout}$         | LMK04228, VCO1, noise floor<br>20-MHz offset <sup>(12)</sup>                                | 245.76 MHz                     | LVPECL16 with 240 $\Omega$   |                   | -160.3 |     | dBc/Hz  |
|                         |   |                                | LVPECL20 with 240 $\Omega$   |                   | -161.1 |     |         |
| CLKout CLO              | SED-LOOP PHASE NOISE SPECIF   | ICATIONS A CO                  | MMERCIAL QUALITY VCX   | O <sup>(13)</sup> |        |     |         |
|                         |   | Offset = 1 kHz                 |  |                   | -115.2 |     |         |
|                         | LMK04228  | Offset = 10 kH                 | Z  |                   | -126.5 |     |         |
| L(f) <sub>CLKout</sub>  | VCO0  | Offset = 100 kH                | Hz   |                   | -128.3 |     | dBc/Hz  |
| L(I)CLKout              | SSB phase noise <sup>(12)</sup><br>245.76 MHz   | Offset = 1 MHz                 | 2  |                   | -150.0 |     | UDC/11Z |
|                         |   | Offset = 10                    | LVDS   |                   | -157.9 |     |         |
|                         |   | MHz                            | LVPECL20 with 240 $\Omega$   |                   | -163.1 |     |         |
|                         |   | Offset = 1 kHz                 |  |                   | -115.1 |     |         |
|                         | LMK04228  | Offset = 10 kH                 | Z  |                   | -126.3 |     |         |
| L(f) <sub>CL Kout</sub> | VCO1  | Offset = 100 kH                | Hz   |                   | -127.5 |     | dBc/Hz  |
| L(I)CLKout              | SSB phase noise (12)<br>245.76 MHz  | Offset = 1 MHz                 | 2  |                   | -154.4 |     | UDC/11Z |
|                         | 243.76 WIDZ   | Offset = 10                    | LVDS   |                   | -157.9 |     |         |
|                         |   | MHz                            | LVPECL20 with 240 $\Omega$   |                   | -162.3 |     |         |
| CLKout CLO              | SED-LOOP JITTER SPECIFICATION   | NS A COMMERC                   | CIAL QUALITY VCXO (13)   |                   |        |     |         |
|                         |   | LVDS, BW = 1                   | 00 Hz to 20 MHz  |                   | 256    |     |         |
|                         | LMK04228, VCO0  | LVDS, BW = 1                   | 2 kHz to 20 MHz  |                   | 183    |     |         |
|                         | f <sub>CLKout</sub> = 245.76 MHz<br>Integrated RMS jitter <sup>(12)</sup>                   | LVPECL20 /w<br>BW = 100 Hz t   | - ,  |                   | 254    |     |         |
| $J_{CLKout}$            | ,   | LVPECL20 /w<br>BW = 12 kHz t   | - ,  | 176               |        | fo  |         |
|                         |   | LVDS, BW = 1                   | 00 Hz to 20 MHz  |                   | 246    |     | fs rms  |
|                         | L MIZO 4000 - 1/004   | LVDS, BW = 1                   | 2 kHz to 20 MHz  |                   | 162    |     |         |
|                         | LMK04228, VCO1<br>f <sub>CLKout</sub> = 245.76 MHz<br>Integrated RMS jitter <sup>(12)</sup> | LVPECL16 with<br>BW = 100 Hz t | - ,  |                   | 245    |     |         |
|                         | integrated Rivis Julier V   |                                | h 240 Ω,<br>o 20 MHz   |                   | 156    |     |         |

<sup>(11)</sup> Maximum Allowable Temperature Drift for Continuous Lock is how far the temperature can drift in either direction from the value it was at the time that the 0x168 register was last programmed with PLL2\_FCAL\_DIS = 0, and still have the part stay in lock. The action of programming the 0x168 register, even to the same value, activates a frequency calibration routine. This implies the part will work over the entire frequency range, but if the temperature drifts more than the maximum allowable drift for continuous lock, then it will be necessary to reload the appropriate register to ensure it stays in lock. Regardless of what temperature the part was initially programmed at, the temperature can never drift outside the frequency range of -40°C to 85°C without violating specifications.

(13) VCXO used is a 30.72 MHz (TXC Bex05).

<sup>(12)</sup> Data collected using MACOM H-183-4 balun. Loop filter is C1 = 82 pF, C2 = 2.2 nF, R2 = 1800 Ω, C3 = 10 pF, R3 = 200 Ω, C4 = 10 pF, R4 = 200 Ω, PLL1\_CP = 650 μA, PLL2\_CP = 1600 μA. VCO0 loop filter bandwidth = 176 kHz, phase margin = 67 degrees. VCO1 Loop filter loop bandwidth = 169 kHz, phase margin = 66 degrees. CLKoutX\_Y\_IDL = 1, CLKoutX\_Y\_ODL = 0.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40^{\circ}\text{C} < \text{T}_{A} < 85^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                                      | PARAMETER   | TEST CONDITIONS   | MIN   | TYP  | MAX   | UNIT |
|--------------------------------------|---|---|-------|------|-------|------|
| DEFAULT PO                           | WER ON RESET CLOCK OUTPUT   | FREQUENCY   |       |      |       |      |
| f <sub>CLKout-startup</sub>          | Default output clock frequency at device power on (14)(15)  | LMK04228  |       | 315  |       | MHz  |
| foscout                              | OSCout frequency  | See <sup>(6)</sup>  | 500   |      |       | MHz  |
| CLOCK SKEW                           | AND DELAY   |   |       |      | "     |      |
|                                      | DCLKoutX to SDCLKoutY $F_{CLK}$ = 245.76 MHz, $R_L$ = 100 $\Omega$ AC-coupled $^{(16)}$   | Same pair, same format <sup>(17)</sup><br>SDCLKoutY_MUX = 0 (device clock)  |       |      | 25    |      |
| T <sub>SKEW</sub>                    | $\label{eq:maximum} \begin{array}{l} \text{Maximum DCLKoutX or} \\ \text{SDCLKoutY} \\ \text{to DCLKoutX or SDCLKoutY} \\ \text{$F_{\text{CLK}}$ = 245.76 MHz, $R_{\text{L}}$ = 100 $\Omega$} \\ \text{AC-coupled} \end{array}$ | Any pair, same format <sup>(17)</sup> SDCLKoutY_MUX = 0 (device clock)  |       | 50   |       | ps   |
| ts <sub>JESD204B</sub>               | SYSREF to device clock setup time base reference. See SYSREF to Device Clock Alignment to adjust SYSREF to device clock setup time as required.   | SDCLKoutY_MUX = 1 (SYSREF) SYSREF_DIV = 30 SYSREF_DDLY = 8 (global) SDCLKoutY_DDLY = 1 (2 cycles, local) DCLKoutX_MUX = 1 (Div+DCC+HS) DCLKoutX_DIV = 30 DCLKoutX_DDLY_CNTH = 7 DCLKoutX_DDLY_CNTL = 6 DCLKoutX_HS = 0 SDCLKoutY_HS = 0 |       | -80  |       | ps   |
| t <sub>PD</sub> CLKin0_<br>SDCLKout1 | Propagation delay from CLKin0 to SDCLKout1  | CLKin0_OUT_MUX = 0 (SYSREF Mux) SYSREF_CLKin0_MUX = 1 (CLKin0) SDCLKout1_PD = 0 SDCLKout1_DDLY = 0 (Bypass) SDCLKout1_MUX = 1 (SR) EN_SYNC = 1 LVPECL16 with 240 Ω  |       | 0.65 |       | ns   |
| f <sub>ADLY</sub> max                | Maximum analog delay frequency  | DCLKoutX_MUX = 4  | 1250  |      |       | MHz  |
| LVDS CLOCK                           | OUTPUTS (DCLKoutX, SDCLKout   | Y, AND OSCout)  |       |      |       |      |
| V <sub>OD</sub>                      | Differential output voltage   |   |       | 395  |       | mV   |
| $\Delta V_{OD}$                      | Change in magnitude of V <sub>OD</sub> for complementary output states  | T = 25°C, DC measurement AC-coupled to receiver input   | -60   |      | 60    | mV   |
| V <sub>OS</sub>                      | Output offset voltage   | $R_L = 100-\Omega$ differential termination   | 1.125 | 1.25 | 1.375 | V    |
| $\Delta V_{OS}$                      | Change in V <sub>OS</sub> for complementary output states   |   |       |      | 35    | mV   |
| T_ / T_                              | Output rise time  | 20% to 80%, $R_L$ = 100 Ω, 245.76 MHz   | 400   |      |       | ne   |
| T <sub>R</sub> / T <sub>F</sub>      | Output fall time  | 80% to 20%, $R_L$ = 100 $Ω$   |       | 180  |       | ps   |
| I <sub>SA</sub><br>I <sub>SB</sub>   | Output short-circuit current - single-ended   | Single-ended output shorted to GND T = 25°C   | -24   |      | 24    | mA   |
| I <sub>SAB</sub>                     | Output short-circuit current - differential   | Complementary outputs tied together   | -12   |      | 12    | mA   |
| LVPECL CLO                           | CK OUTPUTS (DCLKoutX AND SD   | CLKoutY)  |       |      |       |      |
| T <sub>R</sub> / T <sub>F</sub>      | 20% to 80% output rise 80% to 20% output fall time  | $R_L$ = 100 $\Omega$ , emitter resistors = 240 $\Omega$ to GND DCLKoutX_TYPE = 4 or 5   |       | 150  |       | ps   |
| 1600-mVpp L\                         | 80% to 20% output fail time (1600 or 2000 mVpp)  600-mVpp LVPECL CLOCK OUTPUTS (DCLKoutX AND SDCLKoutY)   |   |       |      |       |      |

<sup>(14)</sup> OSCout will oscillate at start-up at the frequency of the VCXO attached to OSCin port.

<sup>(15)</sup> Default outputs on DCLKout4, DCLKout6, DCLKout8, DCLKout10 and OSCout.

<sup>(16)</sup> Equal loading and identical clock output configuration on each clock output is required for specification to be valid. Specification not valid for delay mode.

<sup>(17)</sup> LVPECL uses 120- $\Omega$  emitter resistor, LVDS uses 560- $\Omega$  shunt.



(3.15 V <  $V_{CC}$  < 3.45 V,  $-40^{\circ}$ C <  $T_{A}$  < 85°C. Typical values at  $V_{CC}$  = 3.3 V,  $T_{A}$  = 25°C, at the Recommended Operating Conditions and are **not** assured.)

|                     | PARAMETER                         | TEST CONDITIONS   | MIN TYP                   | MAX      | UNIT |
|---------------------|-----------------------------------|---|---------------------------|----------|------|
| V <sub>OH</sub>     | Output high voltage               | DO Marriago   | V <sub>CC</sub> –<br>1.04 |          | V    |
| V <sub>OL</sub>     | Output low voltage                | DC Measurement Termination = $50 \Omega$ to $V_{CC} - 2 V$  | V <sub>CC</sub> - 1.80    |          | V    |
| $V_{OD}$            | Output voltage<br>See Figure 3    | 100 _ 1   | 760                       |          | mV   |
| 2000-mVpp L         | VPECL CLOCK OUTPUTS (DCLK         | outX AND SDCLKoutY)   |                           |          |      |
| $V_{OH}$            | Output high voltage               |   | V <sub>CC</sub> –<br>1.09 |          | V    |
| V <sub>OL</sub>     | Output low voltage                | DC Measurement Termination = 50 $\Omega$ to V <sub>CC</sub> – 2.3 V   | V <sub>CC</sub> – 2.05    |          | V    |
| V <sub>OD</sub>     | Output voltage<br>See Figure 3    |   | 960                       |          | mV   |
| LVCMOS CL           | OCK OUTPUTS (OSCout)              |   |                           |          |      |
| f <sub>CLKout</sub> | Maximum frequency (18)            | 5-pF Load   | 250                       |          | MHz  |
| V <sub>OH</sub>     | Output high voltage               | 1-mA Load   | V <sub>CC</sub> - 0.1     |          | V    |
| V <sub>OL</sub>     | Output low voltage                | 1-mA Load   |                           | 0.1      | V    |
| I <sub>OH</sub>     | Output high current (source)      | V <sub>CC</sub> = 3.3 V, V <sub>O</sub> = 1.65 V  | 28                        |          | mA   |
| I <sub>OL</sub>     | Output low current (sink)         | V <sub>CC</sub> = 3.3 V, V <sub>O</sub> = 1.65 V  | 28                        |          | mA   |
| DUTY <sub>CLK</sub> | Output duty cycle <sup>(19)</sup> | $V_{CC}/2$ to $V_{CC}/2$ ,<br>$F_{CLK} = 100$ MHz, $T = 25$ °C  | 50%                       |          |      |
| T <sub>R</sub>      | Output rise time                  | 20% to 80%, $R_L = 50 \Omega$ , $C_L = 5 pF$  | 400                       |          | ps   |
| T <sub>F</sub>      | Output fall time                  | 80% to 20%, $R_L = 50 \Omega$ , $C_L = 5 pF$  | 400                       |          | ps   |
| DIGITAL OU          | TPUTS (CLKin_SELX, Status_LDX     | , AND RESET/GPO)  |                           |          |      |
| V <sub>OH</sub>     | High-level output voltage         | I <sub>OH</sub> = -500 μA<br>CLKin_SELX_TYPE = 3 or 4<br>Status_LDX_TYPE = 3 or 4<br>RESET_TYPE = 3 or 4            | V <sub>CC</sub> - 0.4     |          | V    |
| V <sub>OL</sub>     | Low-level output voltage          | I <sub>OL</sub> = 500 μA<br>CLKin_SELX_TYPE = 3, 4, or 6<br>Status_LDX_TYPE = 3, 4, or 6<br>RESET_TYPE = 3, 4, or 6 |                           | 0.4      | V    |
| DIGITAL OU          | TPUT (SDIO)                       |   |                           | '        |      |
| V <sub>OH</sub>     | High-level output voltage         | I <sub>OH</sub> = -500 μA ; during SPI read.<br>SDIO_RDBK_TYPE = 0  | V <sub>CC</sub> - 0.4     |          | V    |
| V <sub>OL</sub>     | Low-level output voltage          | I <sub>OL</sub> = 500 μA ; during SPI read.<br>SDIO_RDBK_TYPE = 0 or 1  |                           | 0.4      | V    |
| DIGITAL INP         | UTS (CLKinX_SEL, RESET/GPO, S     | SYNC, SCK, SDIO, OR CS*)  |                           |          |      |
| $V_{IH}$            | High-level input voltage          |   | 1.2                       | $V_{CC}$ | V    |
| $V_{IL}$            | Low-level input voltage           |   |                           | 0.4      | V    |
| DIGITAL INP         | UTS (CLKinX_SEL)                  |   |                           |          |      |
|                     | High-level input current          | CLKin_SELX_TYPE = 0, (high impedance)   | -5                        | 5        |      |
| I <sub>IH</sub>     | V <sub>IH</sub> = V <sub>CC</sub> | CLKin_SELX_TYPE = 1 (pullup)  | <b>–</b> 5                | 5        | μΑ   |
|                     |                                   | CLKin_SELX_TYPE = 2 (pulldown)  | 10                        | 80       |      |
|                     | Low-level input current           | CLKin_SELX_TYPE = 0,<br>(High Impedance)  | -5                        | 5        |      |
| I <sub>IL</sub>     | $V_{IL} = 0 \text{ V}$            | CLKin_SELX_TYPE = 1 (pullup)  | -40                       | -5       | μA   |
|                     |                                   | CLKin_SELX_TYPE = 2 (pulldown)  | -5                        | 5        |      |

<sup>(18)</sup> Assured by characterization. ATE tested to 10 MHz.

<sup>(19)</sup> Assumes OSCin has 50% input duty cycle.



 $(3.15 \text{ V} < \text{V}_{CC} < 3.45 \text{ V}, -40^{\circ}\text{C} < \text{T}_{A} < 85^{\circ}\text{C}$ . Typical values at  $\text{V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C}$ , at the Recommended Operating Conditions and are **not** assured.)

|                   | PARAMETER   | TEST CONDITIONS                      | MIN        | TYP | MAX | UNIT |
|-------------------|---|--------------------------------------|------------|-----|-----|------|
| DIGITAL I         | NPUT (RESET/GPO)  |                                      |            |     |     |      |
| I <sub>IH</sub>   | High-level input current<br>V <sub>IH</sub> = V <sub>CC</sub> | RESET_TYPE = 2 (pulldown)            | 10         |     | 80  | μΑ   |
|                   |   | RESET_TYPE = 0 (high impedance)      | <b>-</b> 5 |     | 5   |      |
| I <sub>IL</sub>   | Low-level input current $V_{II} = 0 \text{ V}$                | RESET_TYPE = 1 (pullup)              | -40        |     | -5  | μΑ   |
|                   | VIL - 0 V   | RESET_TYPE = 2 (pulldown)            | -5         |     | 5   |      |
| DIGITAL I         | NPUTS (SYNC)  |                                      |            |     | •   |      |
| I <sub>IH</sub>   | High-level input current                                      | $V_{IH} = V_{CC}$                    |            |     | 25  | μΑ   |
| I <sub>IL</sub>   | Low-level input current                                       | V <sub>IL</sub> = 0 V                | <b>-</b> 5 |     | 5   |      |
| DIGITAL I         | NPUTS (SCK, SDIO, CS*)  |                                      |            |     |     |      |
| I <sub>IH</sub>   | High-level input current                                      | $V_{IH} = V_{CC}$                    | -5         |     | 5   | μΑ   |
| I <sub>IL</sub>   | Low-level input current                                       | V <sub>IL</sub> = 0                  | <b>-</b> 5 |     | 5   | μΑ   |
| DIGITAL I         | NPUT TIMING   |                                      | *          |     | *   |      |
| t <sub>HIGH</sub> |   | RESET pin held high for device reset | 25         |     |     | ns   |

## 7.6 SPI Interface Timing

|   | TEST CONDITIONS  | MIN   | TYP   | MAX  | UNIT   |
|---|--|---|---|--|--|
| Setup time for SDI edge to SCLK rising edge         | See Figure 1   | 10  |   |  | ns   |
| Hold time for SDI edge from SCLK rising edge        | See Figure 1   | 10  |   |  | ns   |
| Period of SCLK                                      | See Figure 1   | 50 <sup>(1)</sup>   |   |  | ns   |
| High width of SCLK                                  | See Figure 1   | 25  |   |  | ns   |
| Low width of SCLK                                   | See Figure 1   | 25  |   |  | ns   |
| Setup time for CS* falling edge to SCLK rising edge | See Figure 1   | 10  |   |  | ns   |
| Hold time for CS* rising edge from SCLK rising edge | See Figure 1   | 30  |   |  | ns   |
| SCLK falling edge to valid read back data           | See Figure 1   |   |   | 20   | ns   |
|   | Hold time for SDI edge from SCLK rising edge Period of SCLK High width of SCLK Low width of SCLK Setup time for CS* falling edge to SCLK rising edge Hold time for CS* rising edge from SCLK rising edge | Hold time for SDI edge from SCLK rising edge  Period of SCLK  See Figure 1  High width of SCLK  See Figure 1  Low width of SCLK  See Figure 1  Setup time for CS* falling edge to SCLK rising edge  Hold time for CS* rising edge from SCLK rising edge  See Figure 1  See Figure 1 | Hold time for SDI edge from SCLK rising edge  See Figure 1  Period of SCLK  See Figure 1  50 <sup>(1)</sup> High width of SCLK  See Figure 1  25  Low width of SCLK  See Figure 1  25  Setup time for CS* falling edge to SCLK rising edge  Hold time for CS* rising edge from SCLK rising edge  See Figure 1  10  30 | Hold time for SDI edge from SCLK rising edge  See Figure 1  Period of SCLK  See Figure 1  High width of SCLK  See Figure 1  The state of the st | Hold time for SDI edge from SCLK rising edge  See Figure 1  Period of SCLK  See Figure 1  To  See Figure 1  See Figure 1 |

<sup>(1) 20</sup> MHz

## 7.7 Timing Diagram

Register programming information on the SDIO pin is clocked into a shift register on each rising edge of the SCK signal. On the rising edge of the CS\* signal, the register is sent from the shift register to the register addressed. A slew rate of at least 30 V/µs is recommended for these signals. After programming is complete, the CS\* signal should be returned to a high state. If the SCK or SDIO lines are toggled while the VCO is in lock, as is sometimes the case when these lines are shared with other parts. The phase noise may be degraded during this programming.

Four-wire mode read back has same timing as SDIO pin.

R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.

W1 and W0 will be written as 0.



# **Timing Diagram (continued)**

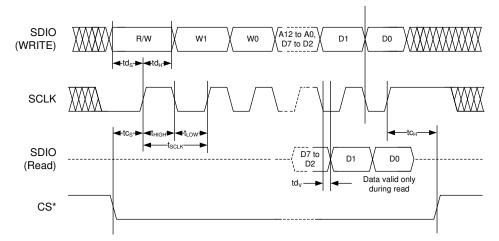
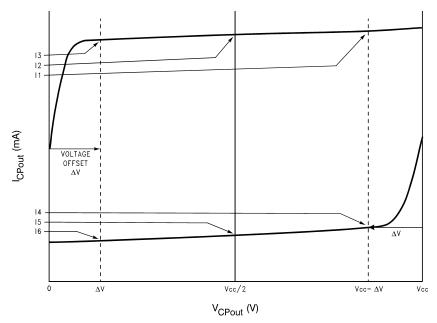


Figure 1. SPI Timing Diagram



## 8 Parameter Measurement Information

## 8.1 Charge Pump Current Specification Definitions



I1 = Charge Pump Sink Current at  $V_{CPout} = V_{CC} - \Delta V$ 

I2 = Charge Pump Sink Current at  $V_{CPout} = V_{CC}/2$ 

I3 = Charge Pump Sink Current at  $V_{CPout} = \Delta V$ 

I4 = Charge Pump Source Current at  $V_{CPout} = V_{CC} - \Delta V$ 

I5 = Charge Pump Source Current at  $V_{CPout} = V_{CC}/2$ 

I6 = Charge Pump Source Current at  $V_{CPout} = \Delta V$ 

 $\Delta V$  = Voltage offset from the positive and negative supply rails. Defined to be 0.5 V for this device.

## 8.1.1 Charge Pump Output Current Magnitude Variation vs. Charge Pump Output Voltage

$$I_{CPout} \ Vs \ V_{CPout} = \frac{||1| - ||3|}{||1| + ||3|} \times 100\%$$
$$= \frac{||4| - ||6|}{||4| + ||6|} \times 100\%$$

## 8.1.2 Charge Pump Sink Current vs. Charge Pump Output Source Current Mismatch

$$I_{CPout}$$
 Sink Vs  $I_{CPout}$  Source = 
$$\frac{||2| - ||5|}{||2| + ||5|} \times 100\%$$

## 8.1.3 Charge Pump Output Current Magnitude Variation vs. Ambient Temperature

$$I_{CPout} \ Vs \ T_{A} = \frac{|I_{2}|_{T_{A}} - |I_{2}|_{T_{A} = 25 \circ C}}{|I_{2}|_{T_{A} = 25 \circ C}} \times 100\%$$

$$= \frac{|I_{5}|_{T_{A}} - |I_{5}|_{T_{A} = 25 \circ C}}{|I_{5}|_{T_{A} = 25 \circ C}} \times 100\%$$

## 8.2 Differential Voltage Measurement Terminology

The differential voltage of a differential signal can be described by two different definitions causing confusion when reading data sheets or communicating with other engineers. This section will address the measurement and description of a differential signal so that the reader will be able to understand and distinguish between the two different definitions when used.

The first definition used to describe a differential signal is the absolute value of the voltage potential between the inverting and noninverting signal. The symbol for this first measurement is typically  $V_{ID}$  or  $V_{OD}$  depending on if an input or output voltage is being described.

The second definition used to describe a differential signal is to measure the potential of the noninverting signal with respect to the inverting signal. The symbol for this second measurement is  $V_{SS}$  and is a calculated parameter. Nowhere in the IC does this signal exist with respect to ground, it only exists in reference to its differential pair.  $V_{SS}$  can be measured directly by oscilloscopes with floating references, otherwise this value can be calculated as twice the value of  $V_{OD}$  as described in the first description.

Figure 2 illustrates the two different definitions side-by-side for inputs and Figure 3 illustrates the two different definitions side-by-side for outputs. The  $V_{ID}$  and  $V_{OD}$  definitions show  $V_A$  and  $V_B$  DC levels that the noninverting and inverting signals toggle between with respect to ground.  $V_{SS}$  input and output definitions show that if the inverting signal is considered the voltage potential reference, the noninverting signal voltage potential is now increasing and decreasing above and below the noninverting reference. Thus the peak-to-peak voltage of the differential signal can be measured.

V<sub>ID</sub> and V<sub>OD</sub> are often defined as volts (V) and V<sub>SS</sub> is often defined as volts peak-to-peak (V<sub>PP</sub>).

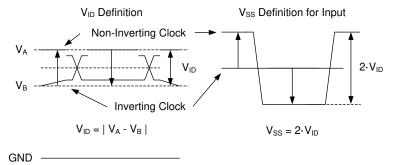


Figure 2. Two Different Definitions for Differential Input Signals

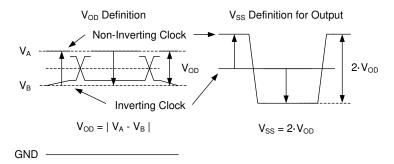


Figure 3. Two Different Definitions for Differential Output Signals

Refer to application note AN-912 Common Data Transmission Parameters and their Definitions (SNLA036) for more information.



# 9 Detailed Description

### 9.1 Overview

The LMK04228 is a highly flexible dual-PLL jitter cleaner and integrated VCO clock generator, providing up to 15 configurable outputs. The typical use case for LMK04228 is as a cascaded dual-loop jitter cleaner for JESD204B systems. However traditional (non-JESD204B) systems are possible with use of the large SYSREF divider to produce a low frequency. Device Clock outputs (DCLKoutX) provide configurable LVDS and LVPECL options, while the OSCout output may be used to provide a buffered copy of a VCXO/Crystal signal in LVDS, LVPECL, or LVCMOS formats.

The LMK04228 may be configured for single-loop mode by powering down unused blocks in PLL1.

## 9.1.1 Jitter Cleaning

The dual-loop PLL architecture of the LMK04228 provides the lowest jitter performance over a wide range of output frequencies and phase noise integration bandwidths. The first stage PLL (PLL1) is driven by an external reference clock and uses an external VCXO or tunable crystal to provide a frequency-accurate, low phase noise reference clock for the second stage frequency multiplication PLL (PLL2).

PLL1 typically uses a narrow loop bandwidth (typically between 10 Hz to 200 Hz) to retain the frequency accuracy of the reference clock input signal while at the same time suppressing the higher offset frequency phase noise that the reference clock may have accumulated along its path or from other circuits. This *cleaned* reference clock provides the reference input to PLL2.

The low phase noise reference provided to PLL2 allows PLL2 to operate with a wide loop bandwidth (typically between 50 kHz to 200 kHz). The loop bandwidth for PLL2 is chosen to take advantage of the superior high offset frequency phase noise profile of the internal VCO and the good low offset frequency phase noise of the reference VCXO or tunable crystal.

Ultra-low jitter is achieved by allowing the phase noise of the external VCXO or crystal to dominate the final output phase noise at low offset frequencies, and the phase noise of the internal VCO to dominate the final output phase noise at high offset frequencies. This results in best overall phase noise and jitter performance.

### 9.1.2 JEDEC JESD204B Support

The LMK04228 provides support for JEDEC JESD204B. The LMK04228 will clock up to 7 JESD204B targets using 7 device clocks (DCLKoutX) and 7 SYSREF clocks (SDCLKoutY). Each device clock is grouped with a SYSREF clock.

It is also possible to reprogram SYSREF clocks to behave as extra device clocks for applications which have non-JESD204B clock requirements.

## 9.1.3 Three PLL1 Redundant Reference Inputs (CLKin0/CLKin0\*, CLKin1/CLKin1\*, and CLKin2/CLKin2\*)

The LMK04228 has up to three reference clock inputs for PLL1 (CLKin0, CLKin1, and CLKin2). The active clock is chosen based on CLKin\_SEL\_MODE. Automatic or manual switching can occur between the inputs.

CLKin0, CLKin1, and CLKin2 each have their own PLL1 R dividers.

CLKin2 is shared for use as OSCout. To use as CLKin2, OSCout must be powered down. See VCO\_MUX, OSCout FMT for more details.

Fast manual switching between reference clocks is possible with a external pins CLKin\_SEL0 and CLKin\_SEL1.

### 9.1.4 VCXO- and Crystal-Buffered Output

The LMK04228 provides OSCout, which by default is a buffered copy of the PLL1 feedback/PLL2 reference input. This reference input is typically a low noise VCXO or crystal. When using a VCXO, this output can be used to clock external devices such as microcontrollers, FPGAs, CPLDs, and so forth, before the LMK04228 is programmed.

The OSCout buffer output type is programmable to LVDS, LVPECL, or LVCMOS.

Once PLL1 lock is established, the buffered output of VCXO/crystal has a deterministic phase relationship with the CLKin input used as the PLL1 reference.



## **Overview (continued)**

## 9.1.5 Frequency Holdover

The LMK04228 supports holdover operation to keep the clock outputs on frequency with minimum drift when the reference is lost until a valid reference clock signal is re-established.

## 9.1.6 PLL2 Integrated Loop Filter Poles

The LMK04228 features programmable 3rd- and 4th-order loop filter poles for PLL2. These internal resistors and capacitor values may be selected from a fixed range of values to achieve either a 3rd- or 4th-order loop filter response. The integrated programmable resistors and capacitors complement larger external components mounted near the chip.

These integrated components can be effectively disabled by programming the integrated resistors and capacitors to their minimum values.

## 9.1.7 Internal VCOs

The LMK04228 has two internal VCOs, selected by VCO\_MUX. The output of the selected VCO is routed to the Clock Distribution Path. This same selection is also fed back to the PLL2 phase detector through a prescaler and N-divider.

### 9.1.8 Clock Distribution

The LMK04228 features a total of 14 PLL2 clock outputs driven from the internal VCO.

All PLL2 clock outputs have programmable output types. They can be programmed to LVPECL or LVDS formats.

The total number of clock outputs the LMK04228 is able to distribute, including OSCout, is up to 15 differential clocks.

The following sections discuss specific features of the clock distribution channels that allow the user to control various aspects of the output clocks.

### 9.1.8.1 Device Clock Divider

Each device clock, DCLKoutX, has a single clock output divider. The divider supports a divide range of 1 to 32 (even and odd) with 50% output duty cycle using duty cycle correction mode. The output of this divider may also be directed to SDCLKoutY, where Y = X + 1.

#### 9.1.8.2 SYSREF Clock Divider

The SYSREF clocks, SDCLKoutY, all share a common divider. The divider supports a divide range of 8 to 8191 (even and odd).

#### 9.1.8.3 Device Clock Delay

The device clocks include both a analog and digital delay for phase adjustment of the clock outputs.

The analog delay allows a nominal 25-ps step size and range from 0 to 575 ps of granular delay. Enabling the device clock analog delay adds a nominal 500-ps delay in addition to the programmed value.

The digital delay allows an output to be delayed from 3.5 to 32 VCO cycles. The delay step can be as small as half the period of the clock distribution path. For example, 2-GHz VCO frequency results in 250-ps tuning steps. The digital delay value takes effect on the clock outputs after a SYNC event. Fixed digital delay allows all the outputs to have a known phase relationship upon a SYNC event and is typically performed at start-up.

#### 9.1.8.4 SYSREF Delay

The global SYSREF divider includes a digital delay block which allows a global phase shift with respect to the other clocks.

Each local SYSREF clock output includes both an analog and additional local digital delay for unique phase adjustment of each SYSREF clock.



## **Overview (continued)**

The local analog delay allows for 150-ps steps, ranging from 600 ps to 2700 ps of granular delay. Enabling the analog delay path adds a nominal 700 ps of delay in addition to the programmed value, and the first delay value adds 600 ps.

The local digital delay and SYSREF\_HS bit allows the each individual SYSREF output to be delayed from 1.5 to 11 VCO cycles. The delay step can be as small as half the period of the clock distribution path by using the DCLKoutX\_HS bit. For example, 2-GHz VCO frequency results in 250-ps coarse tuning steps.

## 9.1.8.5 Programmable Output Formats

For increased flexibility LMK04228 device and SYSREF clock outputs, DCLKoutX and SDCLKoutY, can be programmed to an LVDS or LVPECL output type. The OSCout can be programmed to an LVDS, LVPECL, or LVCMOS output type.

Any LVPECL output type can be programmed to 1600- or 2000-mVpp amplitude levels. The 2000-mVpp LVPECL output type is a Texas Instruments proprietary configuration that produces a 2000-mVpp differential swing for compatibility with many data converters and is also known as 2VPECL.

## 9.1.8.6 Clock Output Synchronization

Using the SYNC input causes all active clock outputs to share a rising edge as programmed by fixed digital delay.

The SYNC event must occur for digital delay values to take effect.

### 9.1.9 Status Pins

The LMK04228 provides status pins which can be monitored for feedback or in some cases used for input depending upon device programming. For example:

- The CLKin SEL0 pin may indicate the LOS (loss-of-signal) for CLKin0.
- The CLKin\_SEL1 pin may be an input for selecting the active clock input.
- The Status\_LD1 pin may indicate if the device is locked.
- The Status\_LD2 pin may indicate if PLL2 is locked.

The status pins can be programmed to a variety of other outputs including PLL divider outputs, combined PLL lock detect signals, PLL1 Vtune railing, readback, and other internal status signals. Refer to the *Programming* section of this data sheet for more information.



## 9.2 Functional Block Diagrams

Figure 4 illustrate the complete LMK04228 block diagram.

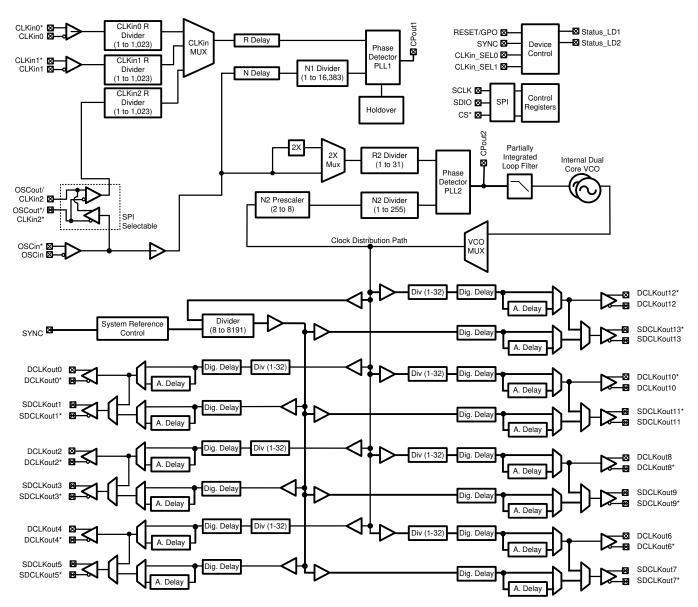


Figure 4. Detailed LMK04228 Block Diagram



## **Functional Block Diagrams (continued)**

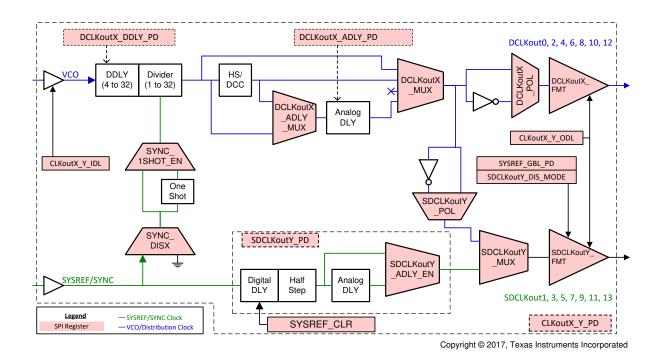


Figure 5. Device and SYSREF Clock Output Block



## **Functional Block Diagrams (continued)**

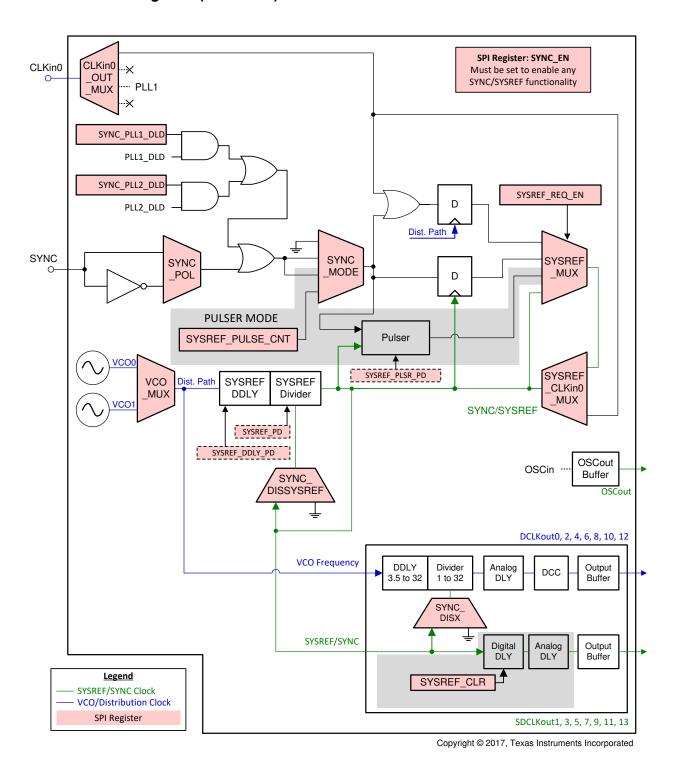


Figure 6. SYNC/SYSREF Clocking Paths



## 9.3 Feature Description

#### 9.3.1 SYNC/SYSREF

The SYNC and SYSREF signals share the same clocking path. To properly use SYNC and SYSREF for JESD204B, it is important to understand the SYNC/SYSREF system. Figure 5 illustrates the detailed diagram of a clock output block with SYNC circuitry included. Figure 6 illustrates the interconnects and highlights some important registers used in controlling the device for SYNC/SYSREF purposes.

To reset or synchronize a divider, the following conditions must be met:

- 1. SYNC\_EN must be set. This ensures proper operation of the SYNC circuitry.
- SYSREF\_MUX and SYNC\_MODE must be set to a proper combination to provide a valid SYNC/SYSREF signal.
  - If SYSREF block is being used, the SYSREF\_PD bit must be clear.
  - If the SYSREF Pulser is being used, the SYSREF\_PLSR\_PD bit must be clear.
- 3. For each SDCLKoutY being used for SYSREF, respective SDCLKoutY PD bits must be cleared.
- 4. SYSREF\_DDLY\_PD and DCLKoutX\_DDLY\_PD bits must be clear to power up the digital delay circuitry during SYNC as use requires.
- 5. The SYNC\_DISX bit must be clear to allow SYNC/SYSREF signal to divider circuit. The SYSREF\_MUX register selects the SYNC source which resets the SYSREF/CLKoutX dividers provided the corresponding SYNC DISX bit is clear.
- 6. Other bits which impact the operation of SYNC such as SYNC\_1SHOT\_EN may be set as desired.

Table 2 illustrates the some possible combinations of SYSREF\_MUX and SYNC\_MODE.

**Table 2. Some Possible SYNC Configurations** 

| rable 2. Joine 1 Jasible 01110 Joinigurations |           |            |  |  |  |  |
|---|-----------|------------|--|--|--|--|
| NAME  | SYNC_MODE | SYSREF_MUX | OTHER  | DESCRIPTION  |  |  |
| SYNC Disabled                                 | 0         | 0          | CLKin0_OUT_MUX ≠ 0   | No SYNC will occur.  |  |  |
| Pin or SPI SYNC                               | 1         | 0          | CLKin0_OUT_MUX ≠ 0   | Basic SYNC functionality, SYNC pin polarity is selected by SYNC_POL. To achieve SYNC through SPI, toggle the SYNC_POL bit.                                   |  |  |
| Differential input SYNC                       | 0 or 1    | 0 or 1     | CLKin0_OUT_MUX = 0   | Differential CLKin0 now operates as SYNC input.  |  |  |
| JESD204B Pulser on pin transition.            | 2         | 2          | SYSREF_PULSE_CNT sets pulse count  | Produce SYSREF_PULSE_CNT programmed number of pulses on pin transition. SYNC_POL can be used to cause SYNC through SPI.                                      |  |  |
| JESD204B Pulser on SPI programming.           | 3         | 2          | SYSREF_PULSE_CNT sets pulse count  | Programming SYSREF_PULSE_CNT register starts sending the number of pulses.   |  |  |
| Re-clocked SYNC                               | 1         | 1          | SYSREF operational,<br>SYSREF Divider as<br>required for training frame<br>size. | Allows precise SYNC for n-bit frame training patterns for non-JESD converters such as LM97600.   |  |  |
| External SYSREF request                       | 0         | 2          | SYSREF_REQ_EN = 1 Pulser powered up  | When SYNC pin is asserted, continuous SYSERF pulses occur. Turning on and off of the pulses is synchronized to prevent runt pulses from occurring on SYSREF. |  |  |
| Continuous<br>SYSREF                          | х         | 3          | SYSREF_PD = 0<br>SYSREF_DDLY_PD = 0<br>SYSREF_PLSR_PD = 1                        | Continuous SYSREF signal.  |  |  |

SDCLKoutY\_PD = 0 as required per SYSREF output. This applies to any SYNC or SYSREF output on SDCLKoutY when SDCLKoutY\_MUX = 1 (SYSREF output)



## **Feature Description (continued)**

## Table 2. Some Possible SYNC Configurations (continued)

| NAME                       | SYNC_MODE | SYSREF_MUX | OTHER   | DESCRIPTION   |
|----------------------------|-----------|------------|---|---|
| Direct SYSREF distribution | 0         | 0          | CLKin0_OUT_MUX = 0<br>SDCLKoutY_DDLY = 0<br>(Local sysref DDLY<br>bypassed)<br>SYSREF_DDLY_PD = 1<br>SYSREF_PLSR_PD = 1<br>SYSREF_PD = 1. | A direct fan-out of SYSREF with no reclocking to clock distribution path. |

#### 9.3.2 JEDEC JESD204B

#### 9.3.2.1 How to Enable SYSREF

Table 3 summarizes the bits needed to make SYSREF functionality operational.

#### Table 3. SYSREF Bits

| REGIS<br>TER | FIELD              | VALUE | DESCRIPTION   |
|--------------|--------------------|-------|---|
| 0x140        | SYSREF_PD          | 0     | Must be clear, power-up SYSREF circuitry.   |
| 0x140        | SYSREF_DDLY_<br>PD | 0     | Must be clear to power-up digital delay circuitry during initial SYNC to ensure deterministic timing.   |
| 0x143        | SYNC_EN            | 1     | Must be set, enable SYNC.   |
| 0x143        | SYSREF_CLR         | 1 → 0 | Do not hold local SYSREF DDLY block in reset except at start.  Anytime SYSREF_PD = 1 because of user programming or device RESET, it is necessary to set SYSREF_CLR for 15 VCO clock cycles to clear the local SYSREF digital delay. Once cleared, SYSREF_CLR must be cleared to allow SYSREF to operate. |

Enabling JESD204B operation involves synchronizing all the clock dividers with the SYSREF divider, then configuring the actual SYSREF functionality.

### 9.3.2.1.1 Setup of SYSREF Example

The following procedure is a programming example for a system which is to operate with a 3000-MHz VCO frequency. Use DCLKout0 and DCLKout2 to drive converters at 750 MHz. Use DCLKout4 to drive an FPGA at 150 MHz. Synchronize the converters and FPGA using a two SYSREF pulses at 10 MHz.

## 1. Program registers 0x000 to 0x1fff as desired. Key to prepare for SYSREF operations:

- a. Prepare for manual SYNC: SYNC\_POL = 0, SYNC\_MODE = 1, SYSREF\_MUX = 0
- b. Setup output dividers as per example: DCLKout0\_DIV and DCLKout2\_DIV = 4 for frequency of 750 MHz. DCLKout4\_DIV = 20 for frequency of 150 MHz.
- c. Setup output dividers as per example: SYSREF\_DIV = 300 for 10 MHz SYSREF
- d. Setup SYSREF: SYSREF\_PD = 0, SYSREF\_DDLY\_PD = 0, DCLKout0\_DDLY\_PD = 0, DCLKout2\_DDLY\_PD = 0, DCLKout4\_DDLY\_PD = 0, SYNC\_EN = 1, SYSREF\_PLSR\_PD = 0, SYSREF\_PULSE\_CNT = 1 (2 pulses). SDCLKout1\_PD = 0, SDCLKout3\_PD = 0"
- e. Clear Local SYSREF DDLY: SYSREF CLR = 1.

#### 2. Establish deterministic phase relationships between SYSREF and Device Clock for JESD204B:

- a. Set device clock and SYSREF divider digital delays: DCLKout0\_DDLY\_CNTH, DCLKout0\_DDLY\_CNTL, DCLKout2\_DDLY\_CNTH, DCLKout2\_DDLY\_CNTL, DCLKout4\_DDLY\_CNTH, DCLKout4\_DDLY\_CNTL, SYSREF\_DDLY.
- b. Set device clock digital delay half steps: DCLKout0 HS, DCLKout2 HS, DCLKout4 HS.
- c. Set SYSREF clock digital delay as required to achieve known phase relationships: SDCLKout1\_DDLY, SDCLKout3\_DDLY, SDCLKout5\_DDLY.
- d. To allow SYNC to effect dividers: SYNC\_DIS0 = 0, SYNC\_DIS2 = 0, SYNC\_DIS4 = 0, SYNC\_DISSYSREF = 0
- e. Perform SYNC by toggling SYNC\_POL = 1 then SYNC\_POL = 0.



- Now that dividers are synchronized, disable SYNC from resetting these dividers. It is not desired for SYSREF to reset its own divider or the dividers of the output clocks.
  - a. Prevent SYNC (SYSREF) from affecting dividers: SYNC\_DIS0 = 1, SYNC\_DIS2 = 1, SYNC\_DIS4 = 1, SYNC\_DISSYSREF = 1.
- 4. Release reset of local SYSREF digital delay.
  - a. SYSREF\_CLR = 0. Note this bit needs to be set for only 15 VCO clocks after SYSREF\_PD = 0.
- 5. Set SYSREF operation.
  - a. Allow pin SYNC event to start pulser: SYNC MODE = 2.
  - b. Select pulser as SYSREF signal: SYSREF MUX = 2.
- 6. Complete! Now asserting the SYNC pin, or toggling SYNC\_POL will result in a series of 2 SYSREF pulses.

### 9.3.2.1.2 SYSREF\_CLR

The local digital delay of the SDCLKout is implemented as a shift buffer. To ensure no unwanted pulses occur at this SYSREF output at start-up, when using SYSREF, requires clearing the buffers by setting SYSREF\_CLR = 1 for 15 VCO clock cycles. After a reset, this bit is set, so it must be cleared before SYSREF output is used.

### 9.3.2.2 SYSREF Modes

#### 9.3.2.2.1 SYSREF Pulser

This mode allows for the output of 1, 2, 4, or 8 SYSREF pulses for every SYNC pin event or SPI programming. This implements the gapped periodic functionality of the JEDEC JESD204B specification.

When in SYSREF Pulser mode, programming the field SYSREF\_PULSE\_CNT in register 0x13E will result in the pulser sending the programmed number of pulses.

#### 9.3.2.2.2 Continuous SYSREF

This mode allows for continuous output of the SYSREF clock.

Continuous operation of SYSREF is not recommended due to crosstalk from the SYSREF clock to device clock. JESD204B is designed to operate with a single burst of pulses to initialize the system at start-up, after which it is theoretically not required to send another SYSREF because the system will continue to operate with deterministic phases.

If continuous operation of SYSREF is required, consider using a SYSREF output from a non-adjacent output or SYSREF from the OSCout pin to minimize crosstalk.

## 9.3.2.2.3 SYSREF Request

This mode allows an external source to synchronously turn on or off a continuous stream of SYSREF pulses using the SYNC/SYSREF\_REQ pin.

Set up the mode by programming SYSREF\_REQ\_EN = 1 and SYSREF\_MUX = 2 (Pulser). The pulser does not need to be powered for this mode of operation.

When the SYSREF\_REQ pin is asserted, the SYSREF\_MUX will synchronously be set to continuous mode providing continuous pulses at the SYSREF frequency until the SYSREF\_REQ pin is unasserted and the final SYSREF pulse will complete sending synchronously.



#### 9.3.3 Digital Delay

Digital (coarse) delay allows a group of outputs to be delayed by 4 to 32 VCO cycles. The delay step can be as small as half the period of the VCO cycle by using the DCLKoutX\_HS bit. It is fixed digital delay.

The regular clock divider is substituted with an alternative divide value. The substitute divide value consists of two values, DCLKoutX\_DDLY\_CNTH and DCLKoutX\_DDLY\_CNTL. The minimum \_CNTH/\_CNTL value is 2 and the maximum \_CNTH/\_CNTL value is 16. This will result in a minimum alternative divide value of 4 and a maximum of 32.

## 9.3.3.1 Fixed Digital Delay

Fixed digital delay value takes effect on the clock outputs after a SYNC event. As such, the outputs will be LOW for a while during the SYNC event.

#### 9.3.3.1.1 Fixed Digital Delay Example

Assuming the device already has the following initial configurations, and the application should delay DCLKout2 by one VCO cycle compared to DCLKout0.

- VCO frequency = 2949.12 MHz
- DCLKout0 = 368.64 MHz (DCLKout0\_DIV = 8)
- DCLKout2 = 368.64 MHz (DCLKout2 DIV = 8)

The following steps should be followed

- 1. Set DCLKout0\_DDLY\_CNTH = 4 and DCLKout2\_DDLY\_CNTH = 4. First part of delay for each clock.
- 2. Set DCLKout0\_DDLY\_CNTL = 4 and DCLKout2\_DDLY\_CNTL = 5. Second part of delay for each clock.
- 3. Set DCLKout2 DDLY PD = 0 and DCLKout2 DDLY PD = 0. Power up the digital delay circuit.
- 4. Set SYNC\_DIS0 = 0 and SYNC\_DIS2 = 0. Allow the output to be synchronized.
- 5. Perform SYNC by asserting, then unasserting SYNC. Either by using SYNC POL bit or the SYNC pin.
- 6. Power down DCLKout2\_DDLY\_PD = 0 and/or DCLKout2\_DDLY\_PD = 1 to save power now that the SYNC is complete.
- 7. Set SYNC\_DIS0 = 1 and SYNC\_DIS2 = 1 to prevent the output from being synchronized; this step is very important for steady-state operation when using JESD204B.

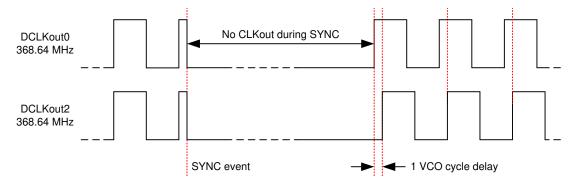


Figure 7. Fixed Digital Delay Example

Table 4 shows the recommended DCLKoutX\_DDLY\_CNTH and DCLKoutX\_DDLY\_CNTL alternate divide setting for delay by one VCO cycle. The clock will output high during the DCLKoutX\_DDLY\_CNTH time to permit a continuous output clock. The clock output will be low during the DCLKoutX\_DDLY\_CNTL time.



Table 4. Recommended DCLKoutX\_DDLY\_CNTH/\_CNTL Values for Delay by One VCO Cycle

| CLOCK DIVIDER | _CNTH | _CNTL | CLOCK DIVIDER | _CNTH             | _CNTL             |
|---------------|-------|-------|---------------|-------------------|-------------------|
| 2             | 2     | 3     | 17            | 9                 | 9                 |
| 3             | 3     | 4     | 18            | 9                 | 10                |
| 4             | 2     | 3     | 19            | 10                | 10                |
| 5             | 3     | 3     | 20            | 10                | 11                |
| 6             | 3     | 4     | 21            | 11                | 11                |
| 7             | 4     | 4     | 22            | 11                | 12                |
| 8             | 4     | 5     | 23            | 12                | 12                |
| 9             | 5     | 5     | 24            | 12                | 13                |
| 10            | 5     | 6     | 25            | 13                | 13                |
| 11            | 6     | 6     | 26            | 13                | 14                |
| 12            | 6     | 7     | 27            | 14                | 14                |
| 13            | 7     | 7     | 28            | 14                | 15                |
| 14            | 7     | 8     | 29            | 15                | 15                |
| 15            | 8     | 8     | 30            | 15                | 16 <sup>(1)</sup> |
| 16            | 8     | 9     | 31            | 16 <sup>(1)</sup> | 16 <sup>(1)</sup> |

<sup>(1)</sup> To achieve \_CNTH/\_CNTL value of 16, 0 must be programmed into the \_CNTH/\_CNTL field.

## 9.3.4 SYSREF to Device Clock Alignment

To ensure proper JESD204B operation, the timing relationship between the SYSREF and the Device clock must be adjusted for optimum setup and hold time. The ts<sub>JESD204B</sub> defines the time between SYSREF and Device Clock for a specific condition of SYSREF divider and Device Clock digital delay. From this point, the SYSREF\_DDLY. SDCLKoutY\_DDLY, DCLKoutX\_DDLY\_CNTH, DCLKoutDDLY\_CNTL, and DCLKoutX\_MUX, SDCKLoutX\_ADLY, and so forth, can be adjusted to provide the required setup and hold time between SYSREF and Device Clock.

It is possible to digitally adjust the SYSREF up to 20 VCO cycles before the SYSREF. So for example with a 2949.12-MHz VCO frequency,  $t_{S,IESD204B} + 20 \times (1/VCO \text{ Frequency}) = -80 \text{ ps} + 20 \times (1/2949.12 \text{ MHz}) = 6.7 \text{ ns}$ .

### 9.3.5 Input Clock Switching

Manual, pin select, and automatic are three different kinds clock input switching modes can be set with the CLKin\_SEL\_MODE register.

The following subsections have information about how the active input clock is selected and what causes a switching event in the various clock input selection modes.

#### 9.3.5.1 Input Clock Switching - Manual Mode

When CLKin\_SEL\_MODE is 0, 1, or 2 then CLKin0, CLKin1, or CLKin2, respectively, is always selected as the active input clock. Manual mode will also override the EN\_CLKinX bits such that the CLKinX buffer will operate even if CLKinX is disabled with EN CLKinX = 0.

If holdover is entered in this mode, then the device will relock to the selected CLKin upon holdover exit.

## 9.3.5.2 Input Clock Switching - Pin Select Mode

When CLKin\_SEL\_MODE is 3, the pins CLKin\_SEL0 and CLKin\_SEL1 select which clock input is active.

#### 9.3.5.2.1 Configuring Pin Select Mode

The CLKin\_SEL0\_TYPE must be programmed to an input value for the CLKin\_SEL0 pin to function as an input for pin select mode.

The CLKin\_SEL1\_TYPE must be programmed to an input value for the CLKin\_SEL1 pin to function as an input for pin select mode.

If the CLKin SELX TYPE is set as output, the pin input value is considered Low.



The polarity of CLKin\_SEL0 and CLKin\_SEL1 input pins can be inverted with the CLKin\_SEL\_INV bit.

Table 5 defines which input clock is active depending on CLKin SEL0 and CLKin SEL1 state.

Table 5. Active Clock Input - Pin Select Mode, CLKin\_SEL\_INV = 0

| PIN CLKin_SEL1 | PIN CLKin_SEL0 | ACTIVE CLOCK |
|----------------|----------------|--------------|
| Low            | Low            | CLKin0       |
| Low            | High           | CLKin1       |
| High           | Low            | CLKin2       |
| High           | High           | Holdover     |

The pin select mode will override the EN\_CLKinX bits such that the CLKinX buffer will operate even if CLKinX is disabled with EN\_CLKinX = 0. To switch as fast as possible, keep the clock input buffers enabled (EN\_CLKinX = 1) that could be switched to.

## 9.3.5.3 Input Clock Switching - Automatic Mode

When CLKin\_SEL\_MODE is 4, the active clock is selected in round-robin order of enabled clock inputs starting upon an input clock switch event. The switching order of the clocks is CLKin0  $\rightarrow$  CLKin1  $\rightarrow$  CLKin2  $\rightarrow$  CLKin0, and so forth.

For a clock input to be eligible to be switched through, it must be enabled using EN\_CLKinX.

### 9.3.5.3.1 Starting Active Clock

Upon programming this mode, the currently active clock remains active if PLL1 lock detect is high. To ensure a particular clock input is the active clock when starting this mode, program CLKin\_SEL\_MODE to the manual mode which selects the desired clock input (CLKin0, 1, or 2). Wait for PLL1 to lock PLL1\_DLD = 1, then select this mode with CLKin\_SEL\_MODE = 4.



## 9.3.6 Digital Lock Detect

Both PLL1 and PLL2 support digital lock detect. Digital lock detect compares the phase between the reference path (R) and the feedback path (N) of the PLL. When the time error (and therefore the phase error) between the two signals is less than a window size ( $\epsilon$ ) specified by PLL1\_WND\_SIZE and PLL2\_WND\_SIZE, a lock detect count increments. When the lock detect count reaches a user specified value, PLL1\_DLD\_CNT or PLL2\_DLD\_CNT, lock detect is asserted true. Once digital lock detect is true, a single phase comparison outside the specified window will cause digital lock detect to be asserted false. This is illustrated in Figure 8.

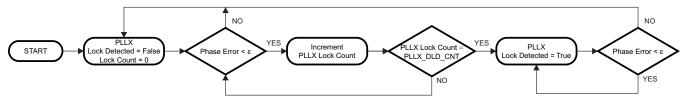


Figure 8. Digital Lock Detect Flowchart

This incremental lock detect count feature functions as a digital filter to ensure that lock detect isn't asserted for only a brief time when the phases of R and N are within the specified tolerance for only a brief time during initial phase lock.

See *Digital Lock Detect Frequency Accuracy* for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect signal can be monitored on the Status\_LD1 or Status\_LD2 pin. The pin may be programmed to output the status of lock detect for PLL1, PLL2, or both PLL1 and PLL2.

#### **NOTE**

In cases where the period of the phase detector frequency approaches the value of the default PLL1\_WND\_SIZE increment (40 ns), the lock detect circuit will not function with the default value of PLL1\_WND\_SIZE. For phase detector frequencies at or above 25 MHz, TI recommends setting PLL1\_WND\_SIZE to 0x02 (19 ns) or a smaller value.

## 9.3.6.1 Calculating Digital Lock Detect Frequency Accuracy

See *Digital Lock Detect Frequency Accuracy* for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect feature can also be used with holdover to automatically exit holdover mode. See *Exiting Holdover* for more information.

#### 9.3.7 Holdover

Holdover mode causes PLL2 to stay locked on frequency with minimal frequency drift when an input clock reference to PLL1 becomes invalid. While in holdover mode, the PLL1 charge pump is TRI-STATED and a fixed tuning voltage is set on CPout1 to operate PLL1 in open-loop.

### 9.3.7.1 Enable Holdover

Program HOLDOVER\_EN = 1 to enable holdover mode.

Holdover mode can be configured to set the CPout1 voltage upon holdover entry to a fixed user defined voltage or a tracked voltage.

## 9.3.7.1.1 Fixed (Manual) CPout1 Holdover Mode

By programming MAN\_DAC\_EN = 1, then the MAN\_DAC value will be set on the CPout1 pin during holdover.

The user can optionally enable CPout1 voltage tracking (TRACK\_EN = 1), read back the tracked DAC value, then reprogram MAN\_DAC value to a user desired value based on information from previous DAC read backs. This allows the most user control over the holdover CPout1 voltage, but also requires more user intervention.



#### 9.3.7.1.2 Tracked CPout1 Holdover Mode

By programming MAN\_DAC\_EN = 0 and TRACK\_EN = 1, the tracked voltage of CPout1 will be set on the CPout1 pin during holdover. When the DAC has acquired the current CPout1 voltage, the *DAC\_Locked* signal is set which may be observed on Status\_LD1 or Status\_LD2 pins by programming PLL1\_LD\_MUX or PLL2\_LD\_MUX respectively.

Updates to the DAC value for the Tracked CPout1 sub-mode occurs at the rate of the PLL1 phase detector frequency divided by (DAC\_CLK\_MULT x DAC\_CLK\_CNTR).

The DAC update rate should be programmed for ≤ 100 kHz to ensure DAC holdover accuracy.

The ability to program slow DAC update rates, for example one DAC update per 4.08 seconds when using 1024-kHz PLL1 phase detector frequency with DAC\_CLK\_MULT = 16,384 and DAC\_CLK\_CNTR = 255, allows the device to *look-back* and set CPout1 at the previous *good* CPout1 tuning voltage values before the event which caused holdover to occur.

The current voltage of DAC value can be read back using RB\_DAC\_VALUE, see RB\_DAC\_VALUE.

## 9.3.7.2 During Holdover

PLL1 is run in open-loop mode.

- PLL1 charge pump is set to TRI-STATE.
- PLL1 DLD will be unasserted.
- · The HOLDOVER status is asserted
- During holdover If PLL2 was locked prior to entry of holdover mode, PLL2 DLD will continue to be asserted.
- CPout1 voltage will be set to:
  - a voltage set in the MAN\_DAC register (MAN\_DAC\_EN = 1).
  - a voltage determined to be the last valid CPout1 voltage (MAN\_DAC\_EN = 0).
- · PLL1 will attempt to lock with the active clock input.

The HOLDOVER status signal can be monitored on the Status\_LD1 or Status\_LD2 pin by programming the PLL1\_DLD\_MUX or PLL2\_DLD\_MUX register to *Holdover Status*.

### 9.3.7.3 Exiting Holdover

Holdover mode can be exited in one of two ways.

- Manually by programming the device from the host.
- Automatically by a clock operating within a specified ppm of the current PLL1 frequency on the active clock input.

## 9.3.7.4 Holdover Frequency Accuracy and DAC Performance

When in holdover mode, PLL1 will run in open-loop and the DAC will set the CPout1 voltage. If Fixed CPout1 mode is used, then the output of the DAC will be a voltage dependant upon the MAN\_DAC register. If Tracked CPout1 mode is used, then the output of the DAC will be the voltage at the CPout1 pin before holdover mode was entered. When using Tracked mode and MAN\_DAC\_EN = 1, during holdover the DAC value is loaded with the programmed value in MAN\_DAC, not the tracked value.

When in Tracked CPout1 mode, the DAC has a worst-case tracking error of  $\pm 2$  LSBs once PLL1 tuning voltage is acquired. The step size is approximately 3.2 mV, therefore the VCXO frequency error during holdover mode caused by the DAC tracking accuracy is  $\pm 6.4$  mV  $\times$  Kv, where Kv is the tuning sensitivity of the VCXO in use. Therefore, the accuracy of the system when in holdover mode in ppm is:

Holdover accuracy (ppm) = 
$$\frac{\pm 6.4 \text{ mV} \times \text{Kv} \times 1e6}{\text{VCXO Frequency}}$$
 (1)

Example: consider a system with a 19.2-MHz clock input, a 153.6-MHz VCXO with a Kv of 17 kHz/V. The accuracy of the system in holdover in ppm is:

$$\pm 0.71 \text{ ppm} = \pm 6.4 \text{ mV} \times 17 \text{ kHz/V} \times 166 / 153.6 \text{ MHz}$$
 (2)

Take this frequency error into account when determining the allowable frequency error window to cause holdover mode to exit.



### 9.3.7.5 Holdover Mode - Automatic Exit of Holdover

The LMK048xx device can be programmed to automatically exit holdover mode when the accuracy of the frequency on the active clock input achieves a specified accuracy. The programmable variables include PLL1 WND SIZE and DLD HOLD CNT.

See *Digital Lock Detect Frequency Accuracy* to calculate the register values to cause holdover to automatically exit upon reference signal recovery to within a user specified ppm error of the holdover frequency.

It is possible for the time to exit holdover to vary because the condition for automatic holdover exit is for the reference and feedback signals to have a time and phase error less than a programmable value. Because it is possible for two clock signals to be very close in frequency but not close in phase, it may take a long time for the phases of the clocks to align themselves within the allowable time and phase error before holdover exits.



## 9.4 Programming

LMK04228 devices are programmed using 24-bit registers. Each register consists of a 1-bit command field (R/W), a 2-bit multi-byte field (W1, W0), a 13-bit address field (A12 to A0) and a 8-bit data field (D7 to D0). The contents of each register is clocked in MSB first (R/W), and the LSB (D0) last. During programming, the CS\* signal is held low. The serial data is clocked in on the rising edge of the SCK signal. After the LSB is clocked in, the CS\* signal goes *high* to latch the contents into the shift register. It is recommended to program registers in numeric order -- for example, 0x000 to 0x1FFF -- to achieve proper device operation. Each register consists of one or more fields which control the device functionality. See electrical characteristics and Figure 1 for timing details.

R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.

W1 and W0 shall be written as 0.

## 9.4.1 Recommended Programming Sequence

Registers are programmed in numeric order with 0x000 being the first and 0x1FFF being the last register programmed. TI recommends the following programming sequence:

- 1. Program register 0x000 with RESET = 1.
- 2. Program registers in ascending order from 0x000 to 0x165. Unused or unchanged registers can be skipped, and will remain at default POR values.
- 3. Program register 0x171 to 0xAA and 0x172 to 0x02.
- 4. Program registers 0x17C and 0x17D.
- 5. Program registers 0x166 to 0x1FFF.

Program register 0x17C (OPT\_REG\_1) and 0x17D (OPT\_REG\_2) before programming PLL2 in registers: 0x166, 0x167, and 0x168 to optimize VCO1 phase noise performance over temperature.

#### 9.4.1.1 SPI LOCK

When writing to SPI\_LOCK, registers 0x1FFD, 0x1FFE, and 0x1FFF should all always be written sequentially.

### 9.4.1.2 SYSREF CLR

When using SYSREF output, SYSREF local digital delay block should be cleared using SYSREF\_CLR bit. See SYSREF\_CLR for more information.



## 9.5 Register Maps

## 9.5.1 Register Map for Device Programming

Table 6 provides the register map for device programming. Any register can be read from the same data address it is written to.

Table 6. LMK04228 Register Map

| ADDRESS | DATA                  |                   |                   |                                       |                  |                       |             |                  |  |  |  |
|---------|-----------------------|-------------------|-------------------|---------------------------------------|------------------|-----------------------|-------------|------------------|--|--|--|
| [20:8]  | 7                     | 6                 | 5                 | 4                                     | 3                | 2                     | 1           | 0                |  |  |  |
| 0x000   | RESET                 | 0                 | 0                 | SPI_3WIRE<br>_DIS                     | 0                | 0                     | 0           | 0                |  |  |  |
| 0x002   | 0                     | 0                 | 0                 | 0                                     | 0                | 0                     | 0           | POWER<br>DOWN    |  |  |  |
| 0x003   |                       |                   |                   | ID_DEVICE_TYPE                        |                  |                       |             |                  |  |  |  |
| 0x004   | ID_PROD[15:8]         |                   |                   |                                       |                  |                       |             |                  |  |  |  |
| 0x005   | ID_PROD[7:0]          |                   |                   |                                       |                  |                       |             |                  |  |  |  |
| 0x006   | ID_MASKREV            |                   |                   |                                       |                  |                       |             |                  |  |  |  |
| 0x00C   |                       |                   |                   | ID_VNE                                | DR[15:8]         |                       |             |                  |  |  |  |
| 0x00D   |                       |                   |                   | ID_VN                                 | DR[7:0]          |                       |             |                  |  |  |  |
| 0x100   | 0                     | CLKout0_1<br>_ODL | CLKout0_1<br>_IDL |                                       |                  | DCLKout0_DIV          |             |                  |  |  |  |
| 0x101   |                       | DCLKout0_I        | DDLY_CNTH         |                                       |                  | DCLKout0_I            | DDLY_CNTL   |                  |  |  |  |
| 0x103   |                       |                   | DCLKout0_ADLY     |                                       |                  | DCLKout0_<br>ADLY_MUX | DCLKo       | ut0_MUX          |  |  |  |
| 0x104   | 0                     | DCLKout0<br>_HS   | SDCLKout1<br>_MUX |                                       | SDCLKo           | ut1_DDLY              |             | SDCLKout1<br>_HS |  |  |  |
| 0x105   | 0                     | 0                 | 0                 | SDCLKout1_<br>ADLY_EN                 |                  |                       |             |                  |  |  |  |
| 0x106   | DCLKout0<br>_ DDLY_PD | 1                 | 1                 | DCLKout0<br>_ADLY _PD                 |                  |                       |             |                  |  |  |  |
| 0x107   | SDCLKout1<br>_POL     |                   | CLKout1_FMT       | DCLKout0<br>_POL CLKout0_FMT          |                  |                       |             |                  |  |  |  |
| 0x108   | 0                     | CLKout2_3<br>_ODL | CLKout2_3<br>_IDL | DCLKout2_DIV                          |                  |                       |             |                  |  |  |  |
| 0x109   |                       | DCLKout2_I        | ODLY_CNTH         | DCLKout2_DDLY_CNTL                    |                  |                       |             |                  |  |  |  |
| 0x10B   |                       |                   | DCLKout2_ADLY     |                                       |                  | DCLKout2_<br>ADLY_MUX | DCLKo       | ut2_MUX          |  |  |  |
| 0x10C   | 0                     | DCLKout2<br>_HS   | SDCLKout3<br>_MUX |                                       | SDCLKo           | ut3_DDLY              |             | SDCLKout3<br>_HS |  |  |  |
| 0x10D   | 0                     | 0                 | 0                 | SDCLKout3<br>_ ADLY_EN                |                  | SDCLKo                | ut3_ADLY    |                  |  |  |  |
| 0x10E   | DCLKout2<br>_ DDLY_PD | 1                 | 1                 | DCLKout2<br>_ADLY _PD                 | CLKout2_3<br>_PD | SDCLKout3             | _DIS_MODE   | SDCLKout3<br>_PD |  |  |  |
| 0x10F   | SDCLKout3<br>_POL     |                   | CLKout3_FMT       |                                       | DCLKout2<br>_POL |                       | CLKout2_FMT |                  |  |  |  |
| 0x110   | 0                     | CLKout4_5<br>_ODL | CLKout4_5<br>_IDL |                                       |                  | DCLKout4_DIV          |             |                  |  |  |  |
| 0x111   |                       | DCLKout4_I        | ODLY_CNTH         |                                       |                  | DCLKout4_I            | DDLY_CNTL   |                  |  |  |  |
| 0x113   |                       |                   | DCLKout4_ADLY     | Y DCLKout4_<br>ADLY_MUX DCLKout4_MUX  |                  |                       |             |                  |  |  |  |
| 0x114   | 0                     | DCLKout4<br>_HS   | SDCLKout5<br>_MUX | SDCLKout5_DDLY SDCLKo                 |                  |                       |             |                  |  |  |  |
| 0x115   | 0                     | 0                 | 0                 | SDCLKout5<br>_ ADLY_EN SDCLKout5_ADLY |                  |                       |             |                  |  |  |  |
| 0x116   | DCLKout4<br>_ DDLY_PD | 1                 | 1                 |                                       |                  |                       |             | SDCLKout5<br>_PD |  |  |  |
| 0x117   | SDCLKout5<br>_POL     |                   | CLKout5_FMT       | DCLKout4 CLKout4_FMT                  |                  |                       |             |                  |  |  |  |
| 0x118   | 0                     | CLKout6_7<br>_ODL | CLKout6_7<br>_IDL | DCLKout6_DIV                          |                  |                       |             |                  |  |  |  |



# **Register Maps (continued)**

# Table 6. LMK04228 Register Map (continued)

| ADDRESS |                                       |                      | JIE O. LIVIRO4      |                         | TA TA                            | ,                       |              |                   |  |
|---------|---------------------------------------|----------------------|---------------------|-------------------------|----------------------------------|-------------------------|--------------|-------------------|--|
| [20:8]  | 7                                     | 6                    | 5                   | 4                       | 3                                | 2                       | 1            | 0                 |  |
| 0x119   |                                       | DCLKout6_I           | DDLY_CNTH           |                         |                                  | DCLKout6_I              | DDLY_CNTL    | II.               |  |
| 0x11B   |                                       |                      | DCLKout6_ADLY       |                         |                                  | DCLKout6_<br>ADLY_MUX   | DCLKou       | ut6_MUX           |  |
| 0x11C   | 0                                     | DCLKout6<br>_HS      | SDCLKout7<br>_MUX   |                         | SDCLKo                           | out7_DDLY SDCI          |              |                   |  |
| 0x11D   | 0                                     | 0                    | 0                   | SDCLKout7<br>_ ADLY_EN  |                                  |                         |              |                   |  |
| 0x11E   | DCLKout6<br>_ DDLY_PD                 | 1                    | 1                   | DCLKout6<br>_ADLY _PD   | CLKout6_7 SDCLKout7_DIS_MODE SDC |                         |              |                   |  |
| 0x11F   | SDCLKout7<br>_POL                     |                      | CLKout7<br>_FMT     |                         | DCLKout6 CLKout6_FMT             |                         |              |                   |  |
| 0x120   | 0                                     | CLKout8_9<br>_ODL    | CLKout8_9<br>_IDL   |                         |                                  | DCLKout8_DIV            |              |                   |  |
| 0x121   |                                       | DCLKout8_I           | DDLY_CNTH           |                         |                                  | DCLKout8_I              | ODLY_CNTL    |                   |  |
| 0x123   |                                       |                      | DCLKout8_ADLY       |                         | •                                | DCLKout8<br>_ ADLY_MUX  | DCLKou       | ut8_MUX           |  |
| 0x124   | 0                                     | DCLKout8<br>_HS      | SDCLKout9<br>_MUX   |                         | SDCLKo                           | ut9_DDLY                |              | SDCLKout9<br>_HS  |  |
| 0x125   | 0                                     | 0                    | 0                   | SDCLKout9<br>_ ADLY_EN  |                                  | SDCLKo                  | ut9_ADLY     |                   |  |
| 0x126   | DCLKout8<br>_ DDLY_PD                 | 1                    | 1                   | DCLKout8<br>_ADLY _PD   | CLKout8_9<br>_PD                 | SDCLKout9               | _DIS_MODE    | SDCLKout9<br>_PD  |  |
| 0x127   | SDCLKout9<br>_POL                     |                      | CLKout9_FMT         |                         | DCLKout8<br>_POL                 | CLKout8_FMT             |              |                   |  |
| 0x128   | 0                                     | CLKout10<br>_11 _ODL | CLKout10<br>_11_IDL |                         |                                  | DCLKout10_DIV           |              |                   |  |
| 0x129   | DCLKout10_DDLY_CNTH DCLKout10_DDLY_CN |                      |                     |                         |                                  |                         |              |                   |  |
| 0x12B   |                                       |                      | DCLKout10_ADLY      | ,                       |                                  | DCLKout10<br>_ ADLY_MUX | DCLKou       | t10_MUX           |  |
| 0x12C   | 0                                     | DCLKout10<br>_HS     | SDCLKout11<br>_MUX  |                         | SDCLKou                          | it11_DDLY               |              | SDCLKout11<br>_HS |  |
| 0x12D   | 0                                     | 0                    | 0                   | SDCKLout11<br>_ ADLY_EN |                                  | SDCLKou                 | t11_ADLY     |                   |  |
| 0x12E   | DCLKout10<br>_ DDLY_PD                | 1                    | 1                   | DCLKout10<br>_ ADLY_PD  | CLKout10<br>_11_PD               | SDCLKout11              | _DIS_MODE    | SDCLKout11<br>_PD |  |
| 0x12F   | SDCLKout11<br>_POL                    |                      | CLKout11_FMT        |                         | DCLKout10<br>_POL                |                         | CLKout10_FMT |                   |  |
| 0x130   | 0                                     | CLKout12<br>_13 _ODL | CLKout12<br>_13_IDL |                         |                                  | DCLKout12_DIV           |              |                   |  |
| 0x131   |                                       | DCLKout12_           | DDLY_CNTH           |                         |                                  | DCLKout12_              | DDLY_CNTL    |                   |  |
| 0x133   |                                       |                      | DCLKout12_ADLY      | ,                       |                                  | DCLKout12_<br>ADLY_MUX  | DCLKou       | t12_MUX           |  |
| 0x134   | 0                                     | DCLKout12<br>_HS     | SDCLKout13<br>_MUX  |                         | SDCLKou                          | it13_DDLY               |              | SDCLKout13<br>_HS |  |
| 0x135   | 0                                     | 0                    | 0                   | SDCLKout13<br>_ ADLY_EN |                                  | SDCLKou                 | t13_ADLY     |                   |  |
| 0x136   | DCLKout12<br>_ DDLY_PD                | 1                    | 1                   | DCLKout12<br>_ ADLY_PD  | CLKout12<br>_13_PD               | SDCLKout13              | 3_DIS_MODE   | SDCLKout13<br>_PD |  |
| 0x137   | SDCLKout13<br>_POL                    |                      | CLKout13_FMT        |                         | DCLKout12<br>_POL                |                         | CLKout12_FMT |                   |  |
| 0x138   | 0                                     | VCO                  | _MUX                | 0                       |                                  | OSCou                   | ut_FMT       |                   |  |
| 0x139   | 0                                     | 0                    | 0                   | 0                       | 0 SYSREF_ CLKin0_MUX SYSREF_MUX  |                         |              |                   |  |
| 0x13A   | 0                                     | 0                    | 0                   |                         |                                  | SYSREF_DIV[12:8         | 5]           |                   |  |
| 0x13B   |                                       |                      |                     | SYSREF                  | _DIV[7:0]                        |                         |              |                   |  |
| 0x13C   | 0                                     | 0                    | 0                   |                         | S                                | SYSREF_DDLY[12:         | 8]           |                   |  |
| 0x13D   | SYSREF_DDLY[7:0]                      |                      |                     |                         |                                  |                         |              |                   |  |



# **Register Maps (continued)**

# Table 6. LMK04228 Register Map (continued)

| ADDRESS |                            |                    |                 |  | ATA                   | •                      |                                 |                    |
|---------|----------------------------|--------------------|-----------------|--|-----------------------|------------------------|---------------------------------|--------------------|
| [20:8]  | 7                          | 6                  | 5               | 4  | 3                     | 2                      | 1                               | 0                  |
| 0x13E   | 0                          | 0                  | 0               | 0  | 0                     | 0                      | SYSREF_P                        | ULSE_CNT           |
| 0x140   | PLL1_PD                    | VCO_LDO_PD         | VCO_PD          | OSCin_PD                                   | SYSREF_GBL<br>_PD     | SYSREF_PD              | SYSREF<br>_DDLY_PD              | SYSREF<br>_PLSR_PD |
| 0x143   | SYSREF_DDLY<br>_CLR        | SYNC_1SHOT<br>_EN  | SYNC_POL        | SYNC_EN SYNC_PLL2 SYNC_PLL1 SYNC_MC        |                       |                        | MODE                            |                    |
| 0x144   | SYNC<br>_DISSYSREF         | SYNC_DIS12         | SYNC_DIS10      | SYNC_DIS8                                  | SYNC_DIS6             | SYNC_DIS4              | SYNC_DIS2                       | SYNC_DIS0          |
| 0x145   | 0                          | 1                  | 1               | 1  | 1                     | 1                      | 1                               | 1                  |
| 0x146   | 0                          | 0                  | CLKin2_EN       | CLKin1_EN                                  | CLKin0_EN             | CLKin2_TYPE            | CLKin1_TYPE                     | CLKin0_TYPE        |
| 0x147   | CLKin_SEL<br>_POL          | (                  | CLKin_SEL_MODE  | Ξ  | CLKin1_C              | DUT_MUX                | CLKin0_C                        | DUT_MUX            |
| 0x148   | 0                          | 0                  |                 | CLKin_SEL0_MU                              | Κ                     |                        | CLKin_SEL0_TYPE                 |                    |
| 0x149   | 0                          | SDIO_RDBK<br>_TYPE |                 | CLKin_SEL1_MU                              | <                     |                        | CLKin_SEL1_TYP                  | Ξ                  |
| 0x14A   | 0                          | 0                  |                 | RESET_MUX                                  |                       |                        | RESET_TYPE                      |                    |
| 0x14B   | LOS_TI                     | MEOUT              | LOS_EN          | TRACK_EN                                   | HOLDOVER<br>_ FORCE   | MAN_DAC<br>_EN         | MAN_D                           | AC[9:8]            |
| 0x14C   |                            |                    |                 | MAN_D                                      | DAC[7:0]              |                        |                                 |                    |
| 0x14D   | 0                          | 0                  |                 |  | DAC_TR                | RIP_LOW                |                                 |                    |
| 0x14E   | DAC_CL                     | K_MULT             |                 |  | DAC_TR                | IP_HIGH                |                                 |                    |
| 0x14F   |                            |                    |                 | DAC_CL                                     | K_CNTR                |                        |                                 |                    |
| 0x150   | 0                          | CLKin<br>_OVERRIDE | 0               | HOLDOVER<br>_ PLL1_DET                     | HOLDOVER<br>_LOS _DET | HOLDOVER<br>_VTUNE_DET | HOLDOVER<br>_HITLESS<br>_SWITCH | HOLDOVER<br>_EN    |
| 0x151   | 0 0 HOLDOVER_DLD_CNT[13:8] |                    |                 |  |                       |                        |                                 |                    |
| 0x152   |                            |                    |                 | HOLDOVER_                                  | DLD_CNT[7:0]          |                        |                                 |                    |
| 0x153   | 0                          | 0                  | 0               | 0  | 0                     | 0                      | CLKin0                          | _R[9:8]            |
| 0x154   |                            |                    |                 | CLKin(                                     | D_R[7:0]              | 1                      | 1                               |                    |
| 0x155   | 0                          | 0                  | 0               | 0  | 0 0 CLKin1_R[9:8]     |                        |                                 |                    |
| 0x156   |                            |                    |                 | CLKin1                                     | I_R[7:0]              |                        |                                 |                    |
| 0x157   | 0                          | 0                  | 0               | 0  | 0                     | 0                      | CLKin2                          | _R[9:8]            |
| 0x158   |                            |                    |                 | CLKin2                                     | 2_R[7:0]              |                        |                                 |                    |
| 0x159   | 0                          | 0                  | 0               | 0  |                       | PLL1_                  | N[11:8]                         |                    |
| 0x15A   |                            |                    |                 | PLL1_                                      | _N[7:0]               |                        |                                 |                    |
| 0x15B   | PLL1_WI                    | ND_SIZE            | PLL1<br>_CP_TRI | PLL1<br>_CP_POL                            |                       | PLL1_C                 | P_GAIN                          |                    |
| 0x15C   | 0                          | 0                  |                 |  | PLL1_DLD              | _CNT[13:8]             |                                 |                    |
| 0x15D   |                            |                    |                 | PLL1_DL                                    | D_CNT[7:0]            |                        |                                 |                    |
| 0x15F   |                            |                    | PLL1_LD_MUX     |  |                       |                        | PLL1_LD_TYPE                    |                    |
| 0x161   | 0                          | 0                  | 0               |  |                       | PLL2_R[4:0]            |                                 |                    |
| 0x162   |                            | PLL2_P             |                 |  | OSCin_FREQ            |                        | PLL2<br>_XTAL_EN                | PLL2<br>_REF_2X_EN |
| 0x166   | 0                          | 0                  | 0               | 0  | 0                     | PLL2_FCAL<br>_DIS      | 0                               | 0                  |
| 0x168   |                            |                    |                 | PLL2_                                      | _N[7:0]               |                        |                                 |                    |
| 0x169   | 0                          | PLL2_WI            | ND_SIZE         | PLL2_CP_GAIN PLL2 PLL 1 _CP_POL 2_CP_TRI 1 |                       |                        |                                 |                    |
| 0x16A   | 0                          | SYSREF_REQ_<br>EN  |                 |  |                       |                        |                                 |                    |
| 0x16B   | PLL2_DLD_CNT[7:0]          |                    |                 |  |                       |                        |                                 |                    |
| 0x16C   | 0 0 PLL2_LF_R4 PLL2_LF_R3  |                    |                 |  |                       |                        |                                 |                    |
| 0x16D   | PLL2_LF_C4 PLL2_LF_C3      |                    |                 |  |                       | LF_C3                  |                                 |                    |
| 0x16E   | PLL2_LD_MUX                |                    |                 |  |                       |                        | PLL2_LD_TYPE                    | -                  |



# **Register Maps (continued)**

# Table 6. LMK04228 Register Map (continued)

| ADDRESS | DATA            |               |         |                 |            |                     |                   |                      |  |  |
|---------|-----------------|---------------|---------|-----------------|------------|---------------------|-------------------|----------------------|--|--|
| [20:8]  | 7               | 6             | 5       | 4               | 3          | 2                   | 1                 | 0                    |  |  |
| 0x171   | 1               | 0             | 1       | 0               | 1          | 0                   | 1                 | 0                    |  |  |
| 0x172   | 0               | 0             | 0       | 0               | 0          | 0                   | 1                 | 0                    |  |  |
| 0x173   | 0               | PLL2_PRE_PD   | PLL2_PD | 0               | 0          | 0                   | 0                 | 0                    |  |  |
| 0x17C   |                 | OPT_REG_1     |         |                 |            |                     |                   |                      |  |  |
| 0x17D   |                 | OPT_REG_2     |         |                 |            |                     |                   |                      |  |  |
| 0x182   | 0               | 0             | 0       | 0               | 0          | RB_PLL1_<br>LD_LOST | RB_PLL1_LD        | CLR_PLL1_<br>LD_LOST |  |  |
| 0x183   | 0               | 0             | 0       | 0               | 0          | RB_PLL2_<br>LD_LOST | RB_PLL2_LD        | CLR_PLL2_<br>LD_LOST |  |  |
| 0x184   |                 |               |         |                 |            |                     | RB_CLKin0_<br>LOS |                      |  |  |
| 0x185   |                 |               |         | RB_DAC_\        | /ALUE[7:0] |                     |                   |                      |  |  |
| 0x188   | 0               | 0             | 0       | RB_<br>HOLDOVER | X          | X                   | x                 | х                    |  |  |
| 0x1FFD  | SPI_LOCK[23:16] |               |         |                 |            |                     |                   |                      |  |  |
| 0x1FFE  | SPI_LOCK[15:8]  |               |         |                 |            |                     |                   |                      |  |  |
| 0x1FFF  |                 | SPI_LOCK[7:0] |         |                 |            |                     |                   |                      |  |  |



#### 9.5.2 Device Register Descriptions

The following section details the fields of each register, the poweron-reset (POR) defaults, and specific descriptions of each bit.

In some cases similar fields are located in multiple registers. In this case specific outputs may be designated as X or Y. In these cases the X will represent even numbers from 0 to 12 and the Y will represent odd numbers from 1 to 13. In the case where X and Y are both used in a bit name, then Y = X + 1.

#### 9.5.2.1 System Functions

#### 9.5.2.1.1 RESET, SPI\_3WIRE\_DIS

This register contains the RESET function.

Table 7. Register 0x000

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION  |
|-----|---------------|----------------|--|
| 7   | RESET         | 0              | Normal Operation     Reset (automatically cleared)   |
| 6:5 | NA            | 0              | Reserved   |
| 4   | SPI_3WIRE_DIS | 0              | Disable 3 wire SPI mode. 4 Wire SPI mode is enabled by selecting SPI Read back in one of the output MUX settings. For example CLKin0_SEL_MUX.  0: 3 Wire Mode enabled  1: 3 Wire Mode disabled |
| 3:0 | NA            | NA             | Reserved   |

#### 9.5.2.1.2 POWERDOWN

This register contains the POWERDOWN function.

Table 8. Register 0x002

| BIT | NAME      | POR<br>DEFAULT | DESCRIPTION                         |
|-----|-----------|----------------|-------------------------------------|
| 7:1 | NA        | 0              | Reserved                            |
| 0   | POWERDOWN | 0              | 0: Normal Operation<br>1: Powerdown |

#### 9.5.2.1.3 ID\_DEVICE\_TYPE

This register contains the product device type. This is read only register.

#### Table 9. Register 0x003

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION              |  |
|-----|----------------|----------------|--------------------------|--|
| 7:0 | ID_DEVICE_TYPE | 6              | PLL product device type. |  |



## 9.5.2.1.4 ID\_PROD[15:8], ID\_PROD

These registers contain the product identifier. This is read only register.

## Table 10. ID\_PROD Register Configuration, ID\_PROD[15:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x004[7:0] | 0x005[7:0] |  |

## Table 11. Registers 0x004, 0x005

| BIT | REGISTERS | FIELD NAME    | POR<br>DEFAULT | DESCRIPTION                    |
|-----|-----------|---------------|----------------|--------------------------------|
| 7:0 | 0x004     | ID_PROD[15:8] | 208            | MSB of the product identifier. |
| 7:0 | 0x005     | ID_PROD       | 91             | LSB of the product identifier. |

## 9.5.2.1.5 ID\_MASKREV

This register contains the IC version identifier. This is read only register.

#### Table 12. Register 0x006

| віт | NAME       | POR<br>DEFAULT | DESCRIPTION                        |
|-----|------------|----------------|------------------------------------|
| 7:0 | ID_MASKREV | 32             | IC version identifier for LMK04228 |

## 9.5.2.1.6 ID\_VNDR[15:8], ID\_VNDR

These registers contain the vendor identifier. This is read only register.

## Table 13. ID\_VNDR Register Configuration, ID\_VNDR[15:0]

| MSB        | LSB        |
|------------|------------|
| 0x00C[7:0] | 0x00D[7:0] |

## Table 14. Registers 0x00C, 0x00D

| ВІТ | REGISTERS | NAME          | POR<br>DEFAULT | DESCRIPTION                   |
|-----|-----------|---------------|----------------|-------------------------------|
| 7:0 | 0x00C     | ID_VNDR[15:8] | 81             | MSB of the vendor identifier. |
| 7:0 | 0x00D     | ID_VNDR       | 4              | LSB of the vendor identifier. |



### 9.5.2.2 (0x100 - 0x138) Device Clock and SYSREF Clock Output Controls

## 9.5.2.2.1 CLKoutX\_Y\_ODL, CLKoutX\_Y\_IDL, DCLKoutX\_DIV

These registers control the input and output drive level as well as the device clock out divider values.

Table 15. Registers 0x100, 0x108, 0x110, 0x118, 0x120, 0x128, and 0x130

| BIT | NAME          | POR<br>DEFAULT  | DESCRIPTION   |               |  |
|-----|---------------|---|---|---------------|--|
| 7   | NA            | 0   | Reserved  |               |  |
| 6   | CLKoutX_Y_ODL | 0   | Output drive level.   |               |  |
| 5   | CLKoutX_Y_IDL | 0   | Input drive level.  |               |  |
|     | DCLKoutX_DIV  | $X = 0 \rightarrow 2$ $X = 2 \rightarrow 4$ $X = 4 \rightarrow 8$ $X = 6 \rightarrow 8$ $X = 8 \rightarrow 8$ $X = 10 \rightarrow 8$ $X = 12 \rightarrow 2$ | Both even or odd divides output a 50% selected. Divider is unused if DCLKoutX_MUX = Field Value | Divider Value |  |
| 4:0 |               |   | 0 (0x00)<br>1 (0x01)  | 32            |  |
|     |               |   | 2 (0x02)  | 2             |  |
|     |               |   |   |               |  |
|     |               |   | 30 (0x1E)   | 30            |  |
|     |               |   | 31 (0x1F)   | 31            |  |

<sup>(1)</sup> Not valid if DCLKoutX\_MUX = 0, Divider only. Not valid if DCLKoutX\_MUX = 3 (Analog Delay + Divider) and DCLKoutX\_ADLY\_MUX = 0 (without duty cycle correction/halfstep).

#### 9.5.2.2.2 DCLKoutX\_DDLY\_CNTH, DCLKoutX\_DDLY\_CNTL

This register controls the digital delay high and low count values for the device clock outputs.

Table 16. Registers 0x101, 0x109, 0x111, 0x119, 0x121, 0x129, 0x131

| BIT | NAME                   | POR<br>DEFAULT | DESCRIPTION   |              |
|-----|------------------------|----------------|---|--------------|
|     |                        |                | Number of clock cycles the output will be high when digital delay is engaged. |              |
|     |                        |                | Field Value   | Delay Values |
|     |                        |                | 0 (0x00)  | 16           |
| 7:4 | DCLKoutX<br>_DDLY_CNTH | 5              | 1 (0x01)  | Reserved     |
|     | _5521_6((())           |                | 2 (0x02)  | 2            |
|     |                        |                |   |              |
|     |                        |                | 15 (0x0F)   | 15           |
|     |                        | 5              | Number of clock cycles the output will be low when digital delay is engaged.  |              |
|     |                        |                | Field Value   | Delay Values |
|     |                        |                | 0 (0x00)  | 16           |
| 3:0 | DCLKoutX<br>_DDLY_CNTL |                | 1 (0x01)  | Reserved     |
|     | _DDE1_ONTE             |                | 2 (0x02)  | 2            |
|     |                        |                |   |              |
|     |                        |                | 15 (0x0F)   | 15           |



## 9.5.2.2.3 DCLKoutX\_ADLY, DCLKoutX\_ADLY\_MUX, DCLKout\_MUX

These registers control the analog delay properties for the device clocks.

Table 17. Registers 0x103, 0x10B, 0x113, 0x11B, 0x123, 0x12B, 0x133

| BIT | NAME                  | POR<br>DEFAULT | DESCRIPTION   |  |  |
|-----|-----------------------|----------------|---|--|--|
|     |                       |                | Device clock analog delay value. Setting this additional to the delay of each 25 ps step. Effe  |  |  |
|     |                       |                | Field Value   | Delay Value                                      |  |
|     |                       |                | 0 (0x00)  | 0 ps   |  |
| 7:3 | DCLKoutX_ALDY         | 0              | 1 (0x01)  | 25 ps  |  |
|     |                       |                | 2 (0x02)  | 50 ps  |  |
|     |                       |                |   |  |  |
|     |                       |                | 23 (0x17)   | 575 ps   |  |
| 2   | DCLKoutX_ADLY<br>_MUX | 0              | This register selects the input to the analog delay for the device clock. Used when DCLKoutX_MUX = 3.  0: Divided without duty cycle correction or half step. (1)  1: Divided with duty cycle correction and half step. |  |  |
|     |                       |                | This selects the input to the device clock buffe  | er.  |  |
|     |                       | CLKoutX_MUX 0  | Field Value   | Mux Output                                       |  |
|     |                       |                | 0 (0x0)   | Divider only (1)                                 |  |
| 1:0 | DCLKoutX_MUX          |                | 1 (0x1)   | Divider with Duty Cycle Correction and Half Step |  |
|     |                       |                | 2 (0x2)   | Reserved   |  |
|     |                       |                | 3 (0x3)   | Analog Delay + Divider                           |  |

<sup>(1)</sup> DCLKoutX\_DIV = 1 is not valid.

#### 9.5.2.2.4 DCLKoutX\_HS, SDCLKoutY\_MUX, SDCLKoutY\_DDLY, SDCLKoutY\_HS

These registers set the half step for the device clock, the SYSREF output MUX, the SYSREF clock digital delay, and half step.

Table 18. Registers 0x104, 0x10C, 0x114, 0x11C, 0x124, 0x12C, 0x134

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION   |              |  |  |
|-----|----------------|----------------|---|--------------|--|--|
| 7   | NA             | 0              | Reserved  |              |  |  |
| 6   | DCLKoutX_HS    | 0              | Sets the device clock half step value. Half ste 0: 0 cycles 1: -0.5 cycles        | ,            |  |  |
| 5   | SDCLKoutY_MUX  | 0              | Sets the input the the SDCLKoutY outputs. 0: Device clock output 1: SYSREF output |              |  |  |
|     |                |                | Sets the number of VCO cycles to delay the SDCLKout by.                           |              |  |  |
|     |                | 0              | Field Value   | Delay Cycles |  |  |
|     |                |                | 0 (0x00)  | Bypass       |  |  |
| 4:1 | SDCLKoutY_DDLY |                | 1 (0x01)  | 2            |  |  |
| 4.1 |                | 0              | 2 (0x02)  | 3            |  |  |
|     |                |                |   |              |  |  |
|     |                |                | 10 (0x0A)   | 11           |  |  |
|     |                |                | 11 to 15 (0x0B to 0x0F)   | Reserved     |  |  |
| 0   | SDCLKoutY_HS   | 0              | Sets the SYSREF clock half step value. 0: 0 cycles 1: -0.5 cycles                 |              |  |  |



## 9.5.2.2.5 SDCLKoutY\_ADLY\_EN, SDCLKoutY\_ADLY

These registers set the analog delay parameters for the SYSREF outputs.

Table 19. Registers 0x105, 0x10D, 0x115, 0x11D, 0x125, 0x12D, 0x135

| BIT | NAME                  | POR<br>DEFAULT       | DESCRIPTION   |                            |  |
|-----|-----------------------|----------------------|---|----------------------------|--|
| 7:5 | NA                    | 0                    | Reserved  |                            |  |
| 4   | SDCLKoutY<br>_ADLY_EN | 0                    | Enables analog delay for the SYSREF output. 0: Disabled 1: Enabled                        |                            |  |
|     |                       | SDCLKoutY<br>_ADLY 0 | Sets the analog delay value for the SYSREF additional 700 ps in propagation delay. Effect |                            |  |
|     |                       |                      | Field Value   | Delay Value                |  |
|     |                       |                      | 0 (0x0)   | 0 ps                       |  |
|     | SDCI KoutY            |                      | 1 (0x1)   | 600 ps                     |  |
| 3:0 |                       |                      | 2 (0x2)   | 750 ps (+150 ps from 0x1)  |  |
|     |                       |                      | 3 (0x3)   | 900 ps (+150 ps from 0x2)  |  |
|     |                       |                      |   |                            |  |
|     |                       |                      | 14 (0xE)  | 2550 ps (+150 ps from 0xD) |  |
|     |                       |                      | 15 (0xF)  | 2700 ps (+150 ps from 0xE) |  |



## 9.5.2.2.6 DCLKoutX\_DDLY\_PD, DCLKout\_ADLY\_PD, DCLKoutX\_Y\_PD, SDCLKoutY\_DIS\_MODE, SDCLKoutY\_PD

This register controls the power down functions for the digital delay, analog delay, outputs, and SYSREF disable modes.

Table 20. Registers 0x106, 0x10E, 0x116, 0x11E, 0x126, 0x12E, 0x136

| BIT | NAME                   | POR DEFAULT   | DESCR   | RIPTION  |  |  |
|-----|------------------------|---|---|--|--|--|
| 7   | DCLKoutX<br>_DDLY_PD   | 0   | Powerdown the device clock digital delay circuitry. 0: Enabled 1: Powerdown |  |  |  |
| 6:5 | NA                     | 3   | These bits should always be programmed to                                   | o 1 (Bit 6 = 1, Bit 5 = 1).  |  |  |
| 4   | DCLKoutX<br>_ADLY_PD   | 1   | Powerdown the device clock analog delay f 0: Enabled 1: Powerdown           | eature.  |  |  |
| 3   | CLKoutX_Y_PD           | $X_{-}Y = 0_{-}1 \rightarrow 1$<br>$X_{-}Y = 2_{-}3 \rightarrow 1$<br>$X_{-}Y = 4_{-}5 \rightarrow 0$<br>$X_{-}Y = 6_{-}7 \rightarrow 0$<br>$X_{-}Y = 8_{-}9 \rightarrow 0$<br>$X_{-}Y = 10_{-}11 \rightarrow 0$<br>$X_{-}Y = 12_{-}13 \rightarrow 1$ | Powerdown the clock group defined by X and Y. 0: Enabled 1: Powerdown       |  |  |  |
|     |                        |   | Configures the output state of the SYSREF                                   |  |  |  |
|     |                        |   | Field Value   | Disable Mode   |  |  |
|     |                        | SDCLKoutY<br>_DIS_MODE 0  | 0 (0x00)  | Active in normal operation   |  |  |
| 2:1 | SDCLKoutY<br>_DIS_MODE |   | 1 (0x01)  | If SYSREF_GBL_PD = 1, the output is a logic low, otherwise it is active.                           |  |  |
|     |                        |   | 2 (0x02)  | If SYSREF_GBL_PD = 1, the output is a nominal Vcm voltage <sup>(1)</sup> , otherwise it is active. |  |  |
|     |                        |   | 3 (0x03)  | Output is a nominal Vcm voltage <sup>(1)</sup>   |  |  |
| 0   | SDCLKoutY_PD           | 1   | Powerdown SDCLKoutY and set to the state defined by SDCLKoutY_DIS_MODE      |  |  |  |

<sup>(1)</sup> If LVPECL mode is used with emitter resistors to ground, the output Vcm will be  $\sim$ 0 V, each pin will be  $\sim$ 0 V.



# 9.5.2.2.7 SDCLKoutY\_POL, SDCLKoutY\_FMT, DCLKoutX\_POL, DCLKoutX\_FMT

These registers configure the output polarity, and format.

Table 21. Registers 0x107, 0x10F, 0x117, 0x11F, 0x127, 0x12F, 0x137

| ВІТ | NAME           | POR<br>DEFAULT                                 | DESCRIPTION  |                |  |
|-----|----------------|--|--|----------------|--|
| 7   | SDCLKoutY_POL  | 0  | Sets the polarity of clock on SDCLKoutY when device clock output is selected with SDCLKoutY_MUX.  0: Normal  1: Inverted |                |  |
|     |                |  | Sets the output format of the SYSREF clocks  |                |  |
|     |                |  | Field Value  | Output Format  |  |
|     |                |  | 0 (0x00)   | Powerdown      |  |
|     |                |  | 1 (0x01)   | LVDS           |  |
| 6:4 | CDCL KoutV FMT | 0  | 2 (0x02)   | Reserved       |  |
| 0.4 | SDCLKoutY_FMT  | 0  | 3 (0x03)   | Reserved       |  |
|     |                |  | 4 (0x04)   | Reserved       |  |
|     |                |  | 5 (0x05)   | LVPECL 1600 mV |  |
|     |                |  | 6 (0x06)   | LVPECL 2000 mV |  |
|     |                |  | 7 (0x07)   | Reserved       |  |
| 3   | DCLKoutX_POL   | 0  | Sets the polarity of the device clocks from the DCLKoutX outputs 0: Normal 1: Inverted                                   |                |  |
|     |                |  | Sets the output format of the device clocks.   |                |  |
|     |                |  | Field Value  | Output Format  |  |
|     |                | LMK04228:                                      | 0 (0x00)   | Powerdown      |  |
|     |                | $X = 0 \rightarrow 0$ $X = 2 \rightarrow 0$    | 1 (0x01)   | LVDS           |  |
| 2:0 | DCL Kouty FMT  | $X = 2 \rightarrow 0$<br>$X = 4 \rightarrow 1$ | 2 (0x02)   | Reserved       |  |
| 2.0 | DCLKoutX_FMT   | $X = 6 \rightarrow 1$                          | 3 (0x03)   | Reserved       |  |
|     |                | $X = 8 \rightarrow 1$ $X = 10 \rightarrow 1$   | 4 (0x04)   | Reserved       |  |
|     |                | X = 12 → 0                                     | 5 (0x05)   | LVPECL 1600 mV |  |
|     |                |  | 6 (0x06)   | LVPECL 2000 mV |  |
|     |                |  | 7 (0x07)   | Reserved       |  |



# 9.5.2.3 SYSREF, SYNC, and Device Config

# 9.5.2.3.1 VCO\_MUX, OSCout\_FMT

This register selects the clock distribution source, and OSCout parameters.

Table 22. Register 0x138

| ВІТ | NAME       | POR<br>DEFAULT | <b>DESCRIPTION</b> Reserved                      |   |
|-----|------------|----------------|--|---|
| 7   | NA         | 0              |  |   |
|     |            |                | Selects clock distribution path source from      | VCO0, VCO1                                |
|     |            |                | Field Value                                      | VCO Selected                              |
| 6:5 | VCO_MUX    | 0              | 0 (0x00)   | VCO 0                                     |
| 0.5 | VCO_IVIOX  | U              | 1 (0x01)   | VCO 1                                     |
|     |            |                | 2 (0x02)   | Reserved                                  |
|     |            |                | 3 (0x03)   | Reserved                                  |
| 4   | NA         | 0              | Reserved   |   |
|     | OSCout_FMT |                | Selects the output format of OSCout. Whe CLKin2. | n powered down, these pins may be used as |
|     |            | OSCout_FMT 4   | Field Value                                      | OSCout Format                             |
|     |            |                | 0 (0x00)   | Powerdown (CLKin2)                        |
|     |            |                | 1 (0x01)   | LVDS                                      |
|     |            |                | 2 (0x02)   | Reserved                                  |
|     |            |                | 3 (0x03)   | Reserved                                  |
|     |            |                | 4 (0x04)   | LVPECL 1600 mVpp                          |
|     |            |                | 5 (0x05)   | LVPECL 2000 mVpp                          |
| 3:0 |            |                | 6 (0x06)   | LVCMOS (Norm / Inv)                       |
|     |            |                | 7 (0x07)   | LVCMOS (Inv / Norm)                       |
|     |            |                | 8 (0x08)   | LVCMOS (Norm / Norm)                      |
|     |            |                | 9 (0x09)   | LVCMOS (Inv / Inv)                        |
|     |            |                | 10 (0x0A)  | LVCMOS (Off / Norm)                       |
|     |            |                | 11 (0x0B)  | LVCMOS (Off / Inv)                        |
|     |            |                | 12 (0x0C)  | LVCMOS (Norm / Off)                       |
|     |            |                | 13 (0x0D)  | LVCMOS (Inv / Off)                        |
|     |            |                | 14 (0x0E)  | LVCMOS (Off / Off)                        |



# 9.5.2.3.2 SYSREF\_CLKin0\_MUX, SYSREF\_MUX

This register sets the source for the SYSREF outputs. Refer to Figure 6 and SYNC/SYSREF.

Table 23. Register 0x139

| BIT | NAME       | POR<br>DEFAULT | DESCRIPTION                           |                                     |  |
|-----|------------|----------------|---------------------------------------|-------------------------------------|--|
| 7:3 | NA         | 0              | Reserved                              |                                     |  |
|     |            |                | Selects the SYSREF output from SYSREF | _MUX or CLKin0 direct               |  |
|     | SYSREF_    | 0              | Field Value                           | SYSREF Source                       |  |
| 2   | CLKin0_MUX |                | 0                                     | SYSREF Mux                          |  |
|     |            |                | 1                                     | CLKin0 Direct (from CLKin0_OUT_MUX) |  |
|     |            | SYSREF_MUX 0   | Selects the SYSREF source.            |                                     |  |
|     |            |                | Field Value                           | SYSREF Source                       |  |
| 1.0 | SYSREF_MUX |                | 0 (0x00)                              | Normal SYNC                         |  |
| 1:0 |            |                | 1 (0x01)                              | Re-clocked                          |  |
|     |            |                | 2 (0x02)                              | SYSREF Pulser                       |  |
|     |            |                | 3 (0x03)                              | SYSREF Continuous                   |  |



## 9.5.2.3.3 SYSREF\_DIV[12:8], SYSREF\_DIV[7:0]

These registers set the value of the SYSREF output divider.

# Table 24. SYSREF\_DIV Register Configuration, SYSREF\_DIV[12:0]

| MSB        | LSB        |
|------------|------------|
| 0x13A[4:0] | 0x13B[7:0] |

## Table 25. Registers 0x13A, 0x13B

| BIT | REGISTERS | NAME              | POR<br>DEFAULT | DESCRIPTION                          |              |
|-----|-----------|-------------------|----------------|--------------------------------------|--------------|
| 7:5 | 0x13A     | NA                | 0              | Reserved                             |              |
|     |           |                   |                | Divide value for the SYSREF outputs. |              |
| 4.0 | 0.424     | 0)/0055 01/140 01 | 12             | Field Value                          | Divide Value |
| 4:0 | 0x13A     | SYSREF_DIV[12:8]  |                | 0x00 to 0x07                         | Reserved     |
|     |           |                   |                | 8 (0x08)                             | 8            |
|     |           |                   | 0              | 9 (0x09)                             | 9            |
| 7.0 | 0v42D     |                   |                |                                      |              |
| 7:0 | 0x13B     | SYSREF_DIV[7:0]   |                | 8190 (0x1FFE)                        | 8190         |
|     |           |                   |                | 8191 (0X1FFF)                        | 8191         |

## 9.5.2.3.4 SYSREF\_DDLY[12:8], SYSREF\_DDLY[7:0]

These registers set the delay of the SYSREF digital delay value.

## Table 26. SYSREF Digital Delay Register Configuration, SYSREF\_DDLY[12:0]

| MSB        | LSB        |
|------------|------------|
| 0x13C[4:0] | 0x13D[7:0] |

## Table 27. Registers 0x13C, 0x13D

| BIT    | REGISTERS | NAME                   | POR<br>DEFAULT | DESCRIPTION                            |             |
|--------|-----------|------------------------|----------------|--|-------------|
| 7:5    | 0x13C     | NA                     | 0              | Reserved                               |             |
|        |           |                        |                | Sets the value of the SYSREF digital d | lelay.      |
| 4:0    | 0x13C     | SYSREF_DDLY[12:8]      | 0              | Field Value                            | Delay Value |
| 4.0    | UXTSC     |                        |                | 0x00 to 0x07                           | Reserved    |
|        |           |                        |                | 8 (0x08)                               | 8           |
|        |           | 0x13D SYSREF_DDLY[7:0] | 8              | 9 (0x09)                               | 9           |
| 7.0    | 0.420     |                        |                |  |             |
| 7:0 0: | UXT3D     |                        |                | 8190 (0x1FFE)                          | 8190        |
|        |           |                        |                | 8191 (0X1FFF)                          | 8191        |



## 9.5.2.3.5 SYSREF\_PULSE\_CNT

This register sets the number of SYSREF pulses if SYSREF is not in continuous mode. See SYSREF\_CLKin0\_MUX, SYSREF\_MUX for further description of SYSREF's outputs.

Programming the register causes the specified number of pulses to be output if "SYSREF Pulses" is selected by SYSREF\_MUX and SYSREF functionality is powered up.

Table 28. Register 0x13E

| BIT | NAME                 | POR<br>DEFAULT | DESCRIPTION  |                  |  |  |
|-----|----------------------|----------------|--|------------------|--|--|
| 7:2 | NA                   | 0              | Reserved   |                  |  |  |
|     |                      |                | Sets the number of SYSREF pulses generated when not in continuous mode.  See SYSREF_CLKin0_MUX, SYSREF_MUX for more information on SYSREF modes. |                  |  |  |
|     |                      | _CNT 3         | Field Value  | Number of Pulses |  |  |
| 1:0 | 1:0 SYSREF PULSE CNT |                | 0 (0x00)   | 1 pulse          |  |  |
|     |                      |                | 1 (0x01)   | 2 pulses         |  |  |
|     |                      |                | 2 (0x02)   | 4 pulses         |  |  |
|     |                      |                | 3 (0x03)   | 8 pulses         |  |  |



# $9.5.2.3.6 \quad PLL1\_PD, \ VCO\_LDO\_PD, \ VCO\_PD, \ OSCin\_PD, \ SYSREF\_GBL\_PD, \ SYSREF\_PD, \ SYSREF\_DDLY\_PD, \ SYSREF\_PLSR\_PD$

This register contains powerdown controls for OSCin and SYSREF functions.

## Table 29. Register 0x140

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION   |
|-----|----------------|----------------|---|
| 7   | PLL1_PD        | 0              | Powerdown PLL1 0: Normal operation 1: Powerdown   |
| 6   | VCO_LDO_PD     | 0              | Powerdown VCO_LDO 0: Normal operation 1: Powerdown  |
| 5   | VCO_PD         | 0              | Powerdown VCO 0: Normal operation 1: Powerdown  |
| 4   | OSCin_PD       | 0              | Powerdown the OSCin port. 0: Normal operation 1: Powerdown  |
| 3   | SYSREF_GBL_PD  | 0              | Powerdown individual SYSREF outputs depending on the setting of SDCLKoutY_DIS_MODE for each SYSREF output. SYSREF_GBL_PD allows many SYSREF outputs to be controlled through a single bit.  0: Normal operation  1: Activate Powerdown Mode |
| 2   | SYSREF_PD      | 1              | Powerdown the SYSREF circuitry and divider. If powered down, SYSREF output mode cannot be used. SYNC cannot be provided either.  0: SYSREF can be used as programmed by individual SYSREF output registers.  1: Powerdown                   |
| 1   | SYSREF_DDLY_PD | 1              | Powerdown the SYSREF digital delay circuitry. 0: Normal operation, SYSREF digital delay may be used. Must be powered up during SYNC for deterministic phase relationship with other clocks. 1: Powerdown                                    |
| 0   | SYSREF_PLSR_PD | 1              | Powerdown the SYSREF pulse generator. 0: Normal operation 1: Powerdown  |



# $9.5.2.3.7 \quad {\tt SYSREF\_CLR, SYNC\_1SHOT\_EN, SYNC\_POL, SYNC\_EN, SYNC\_PLL2\_DLD, SYNC\_PLL1\_DLD, SYNC\_MODE}$

This register sets general SYNC parameters such as polarization, and mode. Refer to Figure 6 for block diagram. Refer to Table 2 for using SYNC\_MODE for specific SYNC use cases.

Table 30. Register 0x143

| BIT | NAME          | POR<br>DEFAULT |   | DESCRIPTION  |  |  |
|-----|---------------|----------------|---|--|--|--|
| 7   | SYSREF_CLR    | 1              |   | Setup Procedure (see SYNC/SYSREF), this bit should always be this bit is set, extra current is used. Refer to Table 82.  |  |  |
| 6   | SYNC_1SHOT_EN | 0              | 0: SYNC is level sensitive 1: SYNC is edge sensitive    | SYNC one shot enables edge sensitive SYNC.  0: SYNC is level sensitive and outputs will be held in SYNC as long as SYNC is asserted.  1: SYNC is edge sensitive, outputs will be SYNCed on rising edge of SYNC. This results in the clock being held in SYNC for a minimum amount of time. |  |  |
| 5   | SYNC_POL      | 0              | Sets the polarity of the S'<br>0: Normal<br>1: Inverted | YNC pin.   |  |  |
| 4   | SYNC_EN       | 1              | Enables the SYNC functionality. 0: Disabled 1: Enabled  |  |  |  |
| 3   | SYNC_PLL2_DLD | 0              | 0: Off<br>1: Assert SYNC until PLL2 DLD = 1             |  |  |  |
| 2   | SYNC_PLL1_DLD | 0              | 0: Off<br>1: Assert SYNC until PLL1 DLD = 1             |  |  |  |
|     |               |                | Sets the method of generating a SYNC event.             |  |  |  |
|     |               |                | Field Value   | SYNC Generation  |  |  |
|     |               | SYNC_MODE 1    | 0 (0x00)  | Prevent SYNC Pin, SYNC_PLL1_DLD flag, or SYNC_PLL2_DLD flag from generating a SYNC event.  |  |  |
| 4.0 | CVNC MODE     |                | 1 (0x01)  | SYNC event generated from SYNC pin or if enabled the SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag.   |  |  |
| 1:0 | SYNC_WODE     |                | 2 (0x02)  | For use with pulser - SYNC/SYSREF pulses are generated by pulser block via SYNC Pin or if enabled SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag.  |  |  |
|     |               |                | 3 (0x03)  | For use with pulser - SYNC/SYSREF pulses are generated by pulser block when programming register 0x13E (SYSREF_PULSE_CNT) is written to (see SYSREF_PULSE_CNT).  |  |  |



## 9.5.2.3.8 SYNC\_DISSYSREF, SYNC\_DISX

SYNC\_DISX will prevent a clock output from being synchronized or interrupted by a SYNC event or when outputting SYSREF.

Table 31. Register 0x144

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION  |  |
|-----|----------------|----------------|--|--|
| 7   | SYNC_DISSYSREF | 0              | Prevent the SYSREF clocks from becoming synchronized during a SYNC event. If SYNC_DISSYSREF is enabled it will continue to operate normally during a SYNC event. |  |
| 6   | SYNC_DIS12     | 0              |  |  |
| 5   | SYNC_DIS10     | 0              |  |  |
| 4   | SYNC_DIS8      | 0              | Prevent the device clock output from becoming synchronized during a SYNC event or  |  |
| 3   | SYNC_DIS6      | 0              | SYSREF clock. If SYNC_DIS bit for a particular output is enabled then it will continue to  |  |
| 2   | SYNC_DIS4      | 0              | operate normally during a SYNC event or SYSREF clock.  |  |
| 1   | SYNC_DIS2      | 0              |  |  |
| 0   | SYNC_DIS0      | 0              |  |  |

## 9.5.2.3.9 Fixed Register

Always program this register to value 127.

Table 32. Register 0x145

| ВІТ | NAME           | POR<br>DEFAULT | DESCRIPTION           |
|-----|----------------|----------------|-----------------------|
| 7:0 | Fixed Register | 0              | Always program to 127 |

#### 9.5.2.4 (0x146 - 0x149) CLKin Control

## 9.5.2.4.1 CLKin2\_EN, CLKin1\_EN, CLKin0\_EN, CLKin2\_TYPE, CLKin1\_TYPE, CLKin0\_TYPE

This register has CLKin enable and type controls.

Table 33. Register 0x146

| BIT | NAME        | POR<br>DEFAULT |  | DESCRIPTION   |  |
|-----|-------------|----------------|--|---|--|
| 7:6 | NA          | 0              | Reserved   |   |  |
| 5   | CLKin2_EN   | 0              | Enable CLKin2 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode  |   |  |
| 4   | CLKin1_EN   | 1              | Enable CLKin1 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode  |   |  |
| 3   | CLKin0_EN   | 1              | Enable CLKin0 to be used during auto-switching of CLKin_SEL_MODE.  0: Not enabled for auto mode  1: Enabled for auto mode  |   |  |
| 2   | CLKin2_TYPE | 0              |  | There are two buffer types for CLKin0, 1, and 2: bipolar and CMOS.  |  |
| 1   | CLKin1_TYPE | 0              |  | Bipolar is recommended for differential inputs like LVDS or LVPECL. |  |
| 0   | CLKin0_TYPE | 0              | O: Bipolar  1: MOS  O: Bipolar  O: Bipolar |   |  |



# 9.5.2.4.2 CLKin\_SEL\_POL, CLKin\_SEL\_MODE, CLKin1\_OUT\_MUX, CLKin0\_OUT\_MUX

# Table 34. Register 0x147

| ВІТ | NAME              | POR<br>DEFAULT | DESCR   | IPTION             |
|-----|-------------------|----------------|---|--------------------|
| 7   | CLKin_SEL_POL     | 0              | Inverts the CLKin polarity for use in pin select mode. 0: Active High 1: Active Low |                    |
|     |                   |                | Sets the mode used in determining the reference                                     | ce for PLL1.       |
|     |                   |                | Field Value   | CLKin Mode         |
|     |                   |                | 0 (0x00)  | CLKin0 Manual      |
|     |                   |                | 1 (0x01)  | CLKin1 Manual      |
| 6:4 | CLKin SEL MODE    | 3              | 2 (0x02)  | CLKin2 Manual      |
| 0.4 | CLKIN_SEL_INIODE  | 3              | 3 (0x03)  | Pin Select Mode    |
|     |                   |                | 4 (0x04)  | Auto Mode          |
|     |                   |                | 5 (0x05)  | Reserved           |
|     |                   |                | 6 (0x06)  | Reserved           |
|     |                   |                | 7 (0x07)  | Reserved           |
|     |                   | 2              | Selects where the output of the CLKin1 buffer i                                     | s directed.        |
|     |                   |                | Field Value   | CLKin1 Destination |
| 3:2 | CLIC's 1 OLIT MUV |                | 0 (0x00)  | Reserved           |
| 3.2 | CLKin1_OUT_MUX    |                | 1 (0x01)  | Reserved           |
|     |                   |                | 2 (0x02)  | PLL1               |
|     |                   |                | 3 (0x03)  | Off                |
|     |                   |                | Selects where the output of the CLKin0 buffer is directed.                          |                    |
|     |                   |                | Field Value   | CLKin0 Destination |
| 4.0 | CLICIA OLIT MUV   | 0              | 0 (0x00)  | SYSREF Mux         |
| 1:0 | CLKin0_OUT_MUX    | 2              | 1 (0x01)  | Reserved           |
|     |                   |                | 2 (0x02)  | PLL1               |
|     |                   |                | 3 (0x03)  | Off                |



# 9.5.2.4.3 CLKin\_SEL0\_MUX, CLKin\_SEL0\_TYPE

This register has CLKin\_SEL0 controls.

# Table 35. Register 0x148

| BIT | NAME            | POR<br>DEFAULT | DESCRIPTION   |                             |  |  |
|-----|-----------------|----------------|---|-----------------------------|--|--|
| 7:6 | NA              | 0              | Reserved  |                             |  |  |
|     |                 |                | This set the output value of the CLKin_SEL0 pin. This register only applies if CLKin_SEL0_TYPE is set to an output mode |                             |  |  |
|     |                 |                | Field Value   | Output For                  | mat  |  |
|     |                 |                | 0 (0x00)  | Logic Lo                    | W  |  |
|     |                 |                | 1 (0x01)  | CLKin0 LC                   | OS   |  |
| 5:3 | CLKin_SEL0_MUX  | 0              | 2 (0x02)  | CLKin0 Sele                 | ected  |  |
|     |                 |                | 3 (0x03)  | DAC Locked                  |  |  |
|     |                 |                | 4 (0x04)  | DAC Low                     |  |  |
|     |                 |                | 5 (0x05)  | DAC High                    |  |  |
|     |                 |                | 6 (0x06)  | SPI Readback                |  |  |
|     |                 |                | 7 (0x07)  | Reserve                     | d  |  |
|     |                 |                | This sets the IO type of the CLKin_SEL0 pin.  |                             |  |  |
|     |                 |                | Field Value   | Configuration               | Function   |  |
|     |                 |                | 0 (0x00)  | Input                       | Input mode, see Input  |  |
|     |                 |                | 1 (0x01)  | Input /w pull-up resistor   | Clock Switching - Pin<br>Select Mode for                           |  |
| 2:0 | CLKin_SEL0_TYPE | 2              | 2 (0x02)  | Input /w pull-down resistor | description of input mode.   |  |
|     |                 |                | 3 (0x03)  | Output (push-pull)          | Output modes: the  |  |
|     |                 |                | 4 (0x04)  | Output inverted (push-pull) | Output modes; the<br>CLKin_SEL0_MUX<br>register for description of |  |
|     |                 |                | 5 (0x05)  | Reserved                    |  |  |
|     |                 |                | 6 (0x06)  | Output (open drain)         | outputs.   |  |



# 9.5.2.4.4 SDIO\_RDBK\_TYPE, CLKin\_SEL1\_MUX, CLKin\_SEL1\_TYPE

This register has CLKin\_SEL1 controls and register readback SDIO pin type.

Table 36. Register 0x149

| віт | NAME            | POR<br>DEFAULT | DESCRIPTION  |   |  |  |
|-----|-----------------|----------------|--|---|--|--|
| 7   | NA              | 0              | Reserved   | Reserved  |  |  |
| 6   | SDIO_RDBK_TYPE  | 1              | Sets the SDIO pin to open drain when during SPI readback in 3 wire mode. 0: Output, push-pull 1: Output, open drain. |   |  |  |
|     |                 |                | This set the output valu   | re of the CLKin_SEL1 pin. This reset to an output mode. | egister only applies if                              |  |
|     |                 |                | Field Value  | Outp  | out Format   |  |
|     |                 |                | 0 (0x00)   | Lo  | ogic Low   |  |
|     |                 |                | 1 (0x01)   | CLI   | Kin1 LOS   |  |
| 5:3 | CLKin_SEL1_MUX  | 0              | 2 (0x02)   | CLKin1 Selected   |  |  |
|     |                 |                | 3 (0x03)   | DAC Locked  |  |  |
|     |                 |                | 4 (0x04)   | DAC Low   |  |  |
|     |                 |                | 5 (0x05)   | D.  | AC High  |  |
|     |                 |                | 6 (0x06)   | SPI Readback  |  |  |
|     |                 |                | 7 (0x07) Reserved  |   | eserved  |  |
|     |                 |                | This sets the IO type of   | the CLKin_SEL1 pin.                                     |  |  |
|     |                 | 2              | Field Value  | Configuration   | Function   |  |
|     |                 |                | 0 (0x00)   | Input   | Input mode, see Input Clock                          |  |
|     |                 |                | 1 (0x01)   | Input /w pull-up resistor                               | Switching - Pin Select Mode for                      |  |
| 2:0 | CLKin_SEL1_TYPE |                | 2 (0x02)   | Input /w pull-down resistor                             | description of input mode.                           |  |
|     |                 |                | 3 (0x03)   | Output (push-pull)                                      |  |  |
|     |                 |                | 4 (0x04)   | Output inverted (push-pull)                             | Output modes; see the<br>CLKin_SEL1_MUX register for |  |
|     |                 |                | 5 (0x05)   | Reserved  | description of outputs.                              |  |
|     |                 |                | 6 (0x06)   | Output (open drain)                                     |  |  |



# 9.5.2.5 RESET\_MUX, RESET\_TYPE

This register contains control of the RESET pin.

Table 37. Register 0x14A

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION                                    |   |   |  |
|-----|------------|----------------|--|---|---|--|
| 7:6 | NA         | 0              | Reserved                                       |   |   |  |
|     |            |                | This sets the output value of the output mode. | This sets the output value of the RESET pin. This register only applies if RESET_TYPE is set to an output mode. |   |  |
|     |            |                | Field Value                                    | Outpu   | t Format  |  |
|     |            |                | 0 (0x00)                                       | Log   | ic Low  |  |
|     | 55655 1400 | _              | 1 (0x01)                                       | Res   | served  |  |
| 5:3 | RESET_MUX  | 0              | 2 (0x02)                                       | CLKin2 Selected   |   |  |
|     |            |                | 3 (0x03)                                       | 3 (0x03) DAC Locked   |   |  |
|     |            |                | 4 (0x04)                                       | 4 (0x04) DAC Low  |   |  |
|     |            |                | 5 (0x05)                                       | 5 (0x05) DAC High   |   |  |
|     |            |                | 6 (0x06)                                       | SPI R   | eadback   |  |
|     |            |                | This sets the IO type of the RE                | ESET pin.   |   |  |
|     |            |                | Field Value                                    | Configuration   | Function  |  |
|     |            |                | 0 (0x00)                                       | Input   |   |  |
|     |            |                | 1 (0x01)                                       | Input /w pull-up resistor   | Reset Mode<br>Reset pin high = Reset            |  |
| 2:0 | RESET_TYPE | 2              | 2 (0x02)                                       | Input /w pull-down resistor   | rteest p riigir rteest                          |  |
|     |            |                | 3 (0x03)                                       | Output (push-pull)  |   |  |
|     |            |                | 4 (0x04)                                       | Output inverted (push-pull)   | Output modes; see the<br>RESET_MUX register for |  |
|     |            |                | 5 (0x05)                                       | Reserved  | description of outputs.                         |  |
|     |            |                | 6 (0x06)                                       | Output (open drain)   |   |  |



## 9.5.2.6 (0x14B - 0x152) Holdover

# 9.5.2.6.1 LOS\_TIMEOUT, LOS\_EN, TRACK\_EN, HOLDOVER\_FORCE, MAN\_DAC\_EN, MAN\_DAC[9:8]

This register contains the holdover functions.

Table 38. Register 0x14B

| BIT | NAME               | POR<br>DEFAULT | DESCR  | IPTION                               |  |
|-----|--------------------|----------------|--|--------------------------------------|--|
|     |                    |                | This controls the amount of time in which no activity on a CLKin forces a clock switch event.  |                                      |  |
|     |                    |                | Field Value  | Timeout                              |  |
| 7:6 | LOS_TIMEOUT        | 0              | 0 (0x00)   | 370 kHz                              |  |
|     |                    |                | 1 (0x01)   | 2.1 MHz                              |  |
|     |                    |                | 2 (0x02)   | 8.8 MHz                              |  |
|     |                    |                | 3 (0x03)   | 22 MHz                               |  |
| 5   | LOS_EN             | 0              | Enables the LOS (Loss-of-Signal) timeout control. Valid for MOS clock inputs.  0: Disabled  1: Enabled   |                                      |  |
| 4   | TRACK_EN           | 1              | Enable the DAC to track the PLL1 tuning voltage, optionally for use in holdover mode. After device reset, tracking starts at DAC code = 512.  Tracking can be used to monitor PLL1 voltage in any mode.  0: Disabled  1: Enabled, will only track when PLL1 is locked. |                                      |  |
| 3   | HOLDOVER<br>_FORCE | 0              | This bit forces holdover mode. When holdover mode is forced, if MAN_DAC_EN = 1, then the DAC will set the programmed MAN_DAC value. Otherwise the tracked DAC value will set the DAC voltage.  0: Disabled 1: Enabled.   |                                      |  |
| 2   | MAN_DAC_EN         | 1              | This bit enables the manual DAC mode. 0: Automatic 1: Manual   |                                      |  |
| 1:0 | MAN_DAC[9:8]       | 2              | See MAN_DAC[9:8], MAN_DAC[7:0] for more  | information on the MAN_DAC settings. |  |



## 9.5.2.6.2 MAN\_DAC[9:8], MAN\_DAC[7:0]

These registers set the value of the DAC in holdover mode when used manually.

# Table 39. MAN\_DAC Register Configuration, MAN\_DAC[9:0]

| MSB        | LSB        |
|------------|------------|
| 0x14B[1:0] | 0x14C[7:0] |

## Table 40. Registers 0x14B, 0x14C

| BIT | REGISTERS | NAME         | POR<br>DEFAULT | DESCRIPTION  |                     |
|-----|-----------|--------------|----------------|--|---------------------|
| 7:2 | 0x14B     |              |                | See LOS_TIMEOUT, LOS_EN, TRACK_EN, HOLDOVER_FORCE, MAN_DAC_EN, MAN_DAC[9:8] for information on these bits. |                     |
|     |           |              |                | Sets the value of the manual DAC when  | in manual DAC mode. |
| 1.0 | 0x14B     | MAN_DAC[9:8] | 2              | Field Value  | DAC Value           |
| 1:0 | UX 146    |              |                | 0 (0x00)   | 0                   |
|     |           |              |                | 1 (0x01)   | 1                   |
|     |           |              |                | 2 (0x02)   | 2                   |
| 7.0 | 0.440     | MANI DACIZIO | 0              |  |                     |
| 7:0 | 0x14C     | MAN_DAC[7:0] |                | 1022 (0x3FE)   | 1022                |
|     |           |              |                | 1023 (0x3FF)   | 1023                |

## 9.5.2.6.3 DAC\_TRIP\_LOW

This register contains the high value at which holdover mode is entered.

Table 41. Register 0x14D

| BIT   | NAME         | POR<br>DEFAULT | DESCRIPTION                                 |  |
|-------|--------------|----------------|---|--|
| 7:6   | NA           | 0              | Reserved                                    |  |
|       |              |                | Voltage from GND at which holdover is enter | ered if HOLDOVER_VTUNE_DET is enabled. |
|       |              |                | Field Value                                 | DAC Trip Value                         |
|       |              |                | 0 (0x00)                                    | 1 x Vcc / 64                           |
|       | DAG TRIP LOW | 0              | 1 (0x01)                                    | 2 x Vcc / 64                           |
| 5:0 D |              |                | 2 (0x02)                                    | 3 x Vcc / 64                           |
|       | DAC_TRIP_LOW |                | 3 (0x03)                                    | 4 x Vcc / 64                           |
|       |              |                |   |  |
|       |              |                | 61 (0x17)                                   | 62 x Vcc / 64                          |
|       |              |                | 62 (0x18)                                   | 63 x Vcc / 64                          |
|       |              |                | 63 (0x19)                                   | 64 x Vcc / 64                          |



## 9.5.2.6.4 DAC\_CLK\_MULT, DAC\_TRIP\_HIGH

This register contains the multiplier for the DAC clock counter and the low value at which holdover mode is entered.

Table 42. Register 0x14E

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION   |  |  |
|-----|---------------|----------------|---|--|--|
|     |               |                | This is the multiplier for the DAC_CLK_CN tracked.                              | TR which sets the rate at which the DAC value is |  |
|     |               |                | Field Value   | DAC Multiplier Value                             |  |
| 7:6 | DAC_CLK_MULT  | 0              | 0 (0x00)  | 4  |  |
|     |               |                | 1 (0x01)  | 64   |  |
|     |               |                | 2 (0x02)  | 1024   |  |
|     |               |                | 3 (0x03)  | 16384  |  |
|     |               | P_HIGH 0       | Voltage from Vcc at which holdover is entered if HOLDOVER_VTUNE_DET is enabled. |  |  |
|     |               |                | Field Value   | DAC Trip Value                                   |  |
|     |               |                | 0 (0x00)  | 1 x Vcc / 64                                     |  |
|     |               |                | 1 (0x01)  | 2 x Vcc / 64                                     |  |
| 5:0 | DAC TRIB HIGH |                | 2 (0x02)  | 3 x Vcc / 64                                     |  |
| 5.0 | DAC_TRIP_HIGH |                | 3 (0x03)  | 4 x Vcc / 64                                     |  |
|     |               |                |   |  |  |
|     |               |                | 61 (0x17)   | 62 x Vcc / 64                                    |  |
|     |               |                | 62 (0x18)   | 63 x Vcc / 64                                    |  |
|     |               |                | 63 (0x19)   | 64 x Vcc / 64                                    |  |

## 9.5.2.6.5 DAC\_CLK\_CNTR

This register contains the value of the DAC when in tracked mode.

Table 43. Register 0x14F

| BIT | NAME         | POR<br>DEFAULT | DESCRIPTION  |           |  |
|-----|--------------|----------------|--|-----------|--|
|     |              |                | This with DAC_CLK_MULT set the rate at which the DAC is updated. The update rate is DAC_CLK_MULT * DAC_CLK_CNTR / PLL1 PDF |           |  |
|     |              |                | Field Value  | DAC Value |  |
|     | DAC_CLK_CNTR | 127            | 0 (0x00)   | 0         |  |
|     |              |                | 1 (0x01)   | 1         |  |
| 7:0 |              |                | 2 (0x02)   | 2         |  |
|     |              |                | 3 (0x03)   | 3         |  |
|     |              |                |  |           |  |
|     |              |                | 253 (0xFD)   | 253       |  |
|     |              |                | 254 (0xFE)   | 254       |  |
|     |              |                | 255 (0xFF)   | 255       |  |



# $9.5.2.6.6 \quad \textbf{CLKin\_OVERRIDE}, \\ \textbf{HOLDOVER\_PLL1\_DET}, \\ \textbf{HOLDOVER\_HITLESS\_SWITCH}, \\ \textbf{HOLDOVER\_EN} \\$

This register has controls for enabling clock in switch events.

#### Table 44. Register 0x150

|     | 3 *** * * * *                   |                |   |  |  |  |
|-----|---------------------------------|----------------|---|--|--|--|
| BIT | NAME                            | POR<br>DEFAULT | DESCRIPTION   |  |  |  |
| 7   | NA                              | 0              | Reserved  |  |  |  |
| 6   | CLKin<br>_OVERRIDE              | 0              | When CLKin_SEL_MODE = 0/1/2 to select a manual clock input, CLKin_OVERRIDE = 1 will force that clock input. Used with clock distribution mode for best performance.  0: Normal, no override.  1: Force select of only CLKin0/1/2 as specified by CLKin_SEL_MODE in manual mode. |  |  |  |
| 5   | NA                              | 0              | Reserved  |  |  |  |
| 4   | HOLDOVER<br>_PLL1_DET           | 0              | This enables the HOLDOVER when PLL1 lock detect signal transitions from high to low. 0: PLL1 DLD does not cause a clock switch event 1: PLL1 DLD causes a clock switch event  |  |  |  |
| 3   | HOLDOVER<br>_LOS_DET            | 0              | This enables HOLDOVER when PLL1 LOS signal is detected. 0: Disabled 1: Enabled  |  |  |  |
| 2   | HOLDOVER<br>_VTUNE_DET          | 0              | Enables the DAC Vtune rail detections. When the DAC achieves a specified Vtune, if this bit is enabled, the current clock input is considered invalid and an input clock switch event is generated.  0: Disabled 1: Enabled   |  |  |  |
| 1   | HOLDOVER<br>_HITLESS<br>_SWITCH | 1              | Determines whether a clock switch event will enter holdover use hitless switching.  0: Hard Switch  1: Hitless switching (has an undefined switch time)   |  |  |  |
| 0   | HOLDOVER_EN                     | 1              | Sets whether holdover mode is active or not. 0: Disabled 1: Enabled   |  |  |  |

## 9.5.2.6.7 HOLDOVER\_DLD\_CNT[13:8], HOLDOVER\_DLD\_CNT[7:0]

## Table 45. HOLDOVER\_DLD\_CNT Register Configuration, HOLDOVER\_DLD\_CNT[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x151[5:0] | 0x152[7:0] |  |

This register has the number of valid clocks of PLL1 PDF before holdover is exited.

## Table 46. Registers 0x151 and 0x152

| ВІТ | REGISTERS | NAME                            | POR<br>DEFAULT | DESCRIPTION                            |                                 |
|-----|-----------|---------------------------------|----------------|--|---------------------------------|
| 7:6 | 0x151     | NA                              | 0              | Reserved                               |                                 |
|     |           |                                 |                | The number of valid clocks of PLL1 PDF | before holdover mode is exited. |
| 5:0 | 0x151     | HOLDOVER<br>_DLD_CNT[13:8]      | 2              | Field Value                            | Count Value                     |
|     |           |                                 |                | 0 (0x00)                               | 0                               |
|     |           |                                 |                | 1 (0x01)                               | 1                               |
|     |           | 0x152 HOLDOVER<br>_DLD_CNT[7:0] | 0              | 2 (0x02)                               | 2                               |
| 7:0 | 0x152     |                                 |                |  |                                 |
| 7.0 |           |                                 |                | 16382 (0x3FFE)                         | 16382                           |
|     |           |                                 |                | 16383 (0x3FFF)                         | 16383                           |



## 9.5.2.7 (0x153 - 0x15F) PLL1 Configuration

#### 9.5.2.7.1 CLKin0\_R[9:8], CLKin0\_R[7:0]

## Table 47. CLKin0\_R Register Configuration, CLKin0\_R[9:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x153[1:0] | 0x154[7:0] |  |

These registers contain the value of the CLKin0 divider.

## Table 48. Registers 0x153, 0x154

| ВІТ | REGISTERS | NAME                | POR<br>DEFAULT | DESCRIPTION                           |                 |   |
|-----|-----------|---------------------|----------------|---------------------------------------|-----------------|---|
| 7:2 | 0x153     | NA                  | 0              | Reserved                              |                 |   |
|     |           |                     |                | The value of PLL1 N counter when CLKi | n0 is selected. |   |
| 1:0 | 0x153     | CLKin0_R[9:8]       | 0              | Field Value                           | Divide Value    |   |
| 1.0 |           |                     |                | 0 (0x00)                              | Reserved        |   |
|     |           |                     |                | 1 (0x01)                              | 1               |   |
|     |           | 0x154 CLKin0_R[7:0] |                |                                       | 2 (0x02)        | 2 |
| 7:0 | 0x154     |                     | 120            |                                       |                 |   |
| 7.0 |           |                     |                | 1022 (0x3FE)                          | 1022            |   |
|     |           |                     |                | 1023 (0x3FF)                          | 1023            |   |

## 9.5.2.7.2 CLKin1\_R[9:8], CLKin1\_R[7:0]

# Table 49. CLKin1\_R Register Configuration, CLKin1\_R[9:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x155[1:0] | 0x156[7:0] |  |

These registers contain the value of the CLKin1 R divider.

## Table 50. Registers 0x155 and 0x156

| BIT | REGISTERS | NAME                | POR<br>DEFAULT | DESCRIPTION                           |                 |
|-----|-----------|---------------------|----------------|---------------------------------------|-----------------|
| 7:2 | 0x155     | NA                  | 0              | Reserved                              |                 |
|     |           |                     |                | The value of PLL1 N counter when CLKi | n1 is selected. |
| 4.0 | 0x155     | CLKin1_R[9:8]       | 0              | Field Value                           | Divide Value    |
| 1:0 |           |                     |                | 0 (0x00)                              | Reserved        |
|     |           |                     |                | 1 (0x01)                              | 1               |
|     |           | 0x156 CLKin1_R[7:0] | 150            | 2 (0x02)                              | 2               |
| 7:0 | 0x156     |                     |                |                                       |                 |
| 7.0 |           |                     |                | 1022 (0x3FE)                          | 1022            |
|     |           |                     |                | 1023 (0x3FF)                          | 1023            |



#### 9.5.2.7.3 CLKin2\_R[9:8], CLKin2\_R[7:0]

# Table 51. CLKin2\_R Register Configuration, CLKin2\_R[9:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x157[1:0] | 0x158[7:0] |  |

## Table 52. Registers 0x157 and 0x158

| BIT | REGISTERS | NAME                | POR<br>DEFAULT | DESCRIPTION                           |                 |
|-----|-----------|---------------------|----------------|---------------------------------------|-----------------|
| 7:2 | 0x157     | NA                  | 0              | Reserved                              |                 |
|     |           |                     |                | The value of PLL1 N counter when CLKi | n2 is selected. |
| 4.0 | 0x157     | CLKin2_R[9:8]       | 0              | Field Value                           | Divide Value    |
| 1:0 |           |                     |                | 0 (0x00)                              | Reserved        |
|     |           |                     |                | 1 (0x01)                              | 1               |
|     |           | 0x158 CLKin2_R[7:0] |                | 2 (0x02)                              | 2               |
| 7.0 | 0x158     |                     | 150            |                                       |                 |
| 7:0 |           |                     |                | 1022 (0x3FE)                          | 1022            |
|     |           |                     |                | 1023 (0x3FF)                          | 1023            |

#### 9.5.2.7.4 PLL1\_N

# Table 53. PLL1\_N Register Configuration, PLL1\_N[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x159[5:0] | 0x15A[7:0] |  |

These registers contain the N divider value for PLL1.

## Table 54. Registers 0x159 and 0x15A

| BIT | REGISTERS | NAME           | POR<br>DEFAULT | DESCRIPTION                  |              |
|-----|-----------|----------------|----------------|------------------------------|--------------|
| 7:4 | 0x159     | NA             | 0              | Reserved                     |              |
|     |           | PLL1_N[11:8]   |                | The value of PLL1 N counter. |              |
|     | 0x159     |                | 0              | Field Value                  | Divide Value |
| 3:0 |           |                |                | 0 (0x00)                     | Not Valid    |
|     |           |                |                | 1 (0x01)                     | 1            |
|     | 7:0 0x15A | 5A PLL1_N[7:0] | ] 120          | 2 (0x02)                     | 2            |
| 7:0 |           |                |                |                              |              |
|     |           |                |                | 4,095 (0xFFF)                | 4,095        |



# 9.5.2.7.5 PLL1\_WND\_SIZE, PLL1\_CP\_TRI, PLL1\_CP\_POL, PLL1\_CP\_GAIN

This register controls the PLL1 phase detector.

Table 55. Register 0x15B

| ВІТ | NAME          | POR<br>DEFAULT | DESCRIPTION  |                    |  |
|-----|---------------|----------------|--|--------------------|--|
|     |               |                | PLL1_WND_SIZE sets the window size used error between the reference and feedback of PLL1 lock counter increments.  |                    |  |
|     |               |                | Field Value  | Definition         |  |
| 7:6 | PLL1_WND_SIZE | 3              | 0 (0x00)   | 4 ns               |  |
|     |               |                | 1 (0x01)   | 9 ns               |  |
|     |               |                | 2 (0x02)   | 19 ns              |  |
|     |               |                | 3 (0x03)   | 43 ns              |  |
| 5   | PLL1_CP_TRI   | 0              | This bit allows for the PLL1 charge pump output pin, CPout1, to be placed into TRI-STATE.  0: PLL1 CPout1 is active 1: PLL1 CPout1 is at TRI-STATE   |                    |  |
| 4   | PLL1_CP_POL   | 1              | PLL1_CP_POL sets the charge pump polarity for PLL1. Many VCXOs use positive slope. A positive slope VCXO increases output frequency with increasing voltage. A negative slope VCXO decreases output frequency with increasing voltage.  0: Negative Slope VCO/VCXO  1: Positive Slope VCO/VCXO |                    |  |
|     |               |                | This bit programs the PLL1 charge pump out   | put current level. |  |
|     |               |                | Field Value  | Gain               |  |
|     |               |                | 0 (0x00)   | 50 μΑ              |  |
|     |               |                | 1 (0x01)   | 150 μΑ             |  |
| 3:0 | DITT CD CAIN  | 4              | 2 (0x02)   | 250 μΑ             |  |
| 3.0 | PLL1_CP_GAIN  | 4              | 3 (0x03)   | 350 μΑ             |  |
|     |               |                | 4 (0x04)   | 450 μA             |  |
|     |               |                |  |                    |  |
|     |               |                | 14 (0x0E)  | 1450 μΑ            |  |
|     |               |                | 15 (0x0F)  | 1550 μΑ            |  |



# 9.5.2.7.6 PLL1\_DLD\_CNT[13:8], PLL1\_DLD\_CNT[7:0]

# Table 56. PLL1\_DLD\_CNT Register Configuration, PLL1\_DLD\_CNT[13:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x15C[5:0] | 0x15D[7:0] |  |

This register contains the value of the PLL1 DLD counter.

## Table 57. Registers 0x15C and 0x15D

| BIT       | REGISTERS | NAME                     | POR DEFAULT | DESCRIPTION   |                              |
|-----------|-----------|--------------------------|-------------|---|------------------------------|
| 7:6       | 0x15C     | NA                       | 0           | Reserved  |                              |
| 5:0 0x15C |           |                          | 32          | The reference and feedback of PLL1 merror as specified by PLL1_WND_SIZE cycles before PLL1 digital lock detect is | for this many phase detector |
|           | 0x15C     | PLL1_DLD<br>_CNT[13:8]   |             | Field Value   | Delay Value                  |
|           |           |                          |             | 0 (0x00)  | Reserved                     |
|           |           |                          |             | 1 (0x01)  | 1                            |
|           |           | 0x15D PLL1_DLD _CNT[7:0] | 0           | 2 (0x02)  | 2                            |
|           | 0x15D     |                          |             | 3 (0x03)  | 3                            |
| 7:0       |           |                          |             |   |                              |
|           |           | _0.11[1.0]               |             | 16,382 (0x3FFE)   | 16,382                       |
|           |           |                          |             | 16,383 (0x3FFF)   | 16,383                       |



# 9.5.2.7.7 PLL1\_LD\_MUX, PLL1\_LD\_TYPE

This register configures the PLL1 LD pin.

Table 58. Register 0x15F

| ВІТ | NAME         | POR<br>DEFAULT | DESCR   | RIPTION                     |  |
|-----|--------------|----------------|---|-----------------------------|--|
|     |              |                | This sets the output value of the Status_LD1 pin. |                             |  |
|     |              |                | Field Value                                       | MUX Value                   |  |
|     |              |                | 0 (0x00)  | Logic Low                   |  |
|     |              |                | 1 (0x01)  | PLL1 DLD                    |  |
|     |              |                | 2 (0x02)  | PLL2 DLD                    |  |
|     |              |                | 3 (0x03)  | PLL1 & PLL2 DLD             |  |
|     |              |                | 4 (0x04)  | Holdover Status             |  |
|     |              |                | 5 (0x05)  | DAC Locked                  |  |
|     |              |                | 6 (0x06)  | Reserved                    |  |
|     |              |                | 7 (0x07)  | SPI Readback                |  |
| 7:3 | PLL1_LD_MUX  | 1              | 8 (0x08)  | DAC Rail                    |  |
|     |              |                | 9 (0x09)  | DAC Low                     |  |
|     |              |                | 10 (0x0A)   | DAC High                    |  |
|     |              |                | 11 (0x0B)   | PLL1_N                      |  |
|     |              |                | 12 (0x0C)   | PLL1_N/2                    |  |
|     |              |                | 13 (0x0D)   | PLL2_N                      |  |
|     |              |                | 14 (0x0E)   | PLL2_N/2                    |  |
|     |              |                | 15 (0x0F)   | PLL1_R                      |  |
|     |              |                | 16 (0x10)   | PLL1_R/2                    |  |
|     |              |                | 17 (0x11)   | PLL2_R <sup>(1)</sup>       |  |
|     |              |                | 18 (0x12)   | PLL2_R/2 <sup>(1)</sup>     |  |
|     |              |                | Sets the IO type of the Status_LD1 pin.           |                             |  |
|     |              |                | Field Value                                       | TYPE                        |  |
|     |              |                | 0 (0x00)  | Reserved                    |  |
|     |              |                | 1 (0x01)  | Reserved                    |  |
| 2:0 | PLL1_LD_TYPE | 6              | 2 (0x02)  | Reserved                    |  |
|     |              |                | 3 (0x03)  | Output (push-pull)          |  |
|     |              |                | 4 (0x04)  | Output inverted (push-pull) |  |
|     |              |                | 5 (0x05)  | Reserved                    |  |
|     |              |                | 6 (0x06)  | Output (open drain)         |  |
|     |              | 1              | <u> </u>  | ,                           |  |

<sup>(1)</sup> Only valid when PLL2\_LD\_MUX is not set to 2 (PLL2\_DLD) or 3 (PLL1 & PLL2 DLD).



# 9.5.2.8 (0x160 - 0x16E) PLL2 Configuration

# 9.5.2.8.1 PLL2\_R[4:0]

This register contains the value of the PLL2 R divider.

# Table 59. Register 0x161

| BIT | REGISTERS | NAME        | POR DEFAULT | DESCR                                | RIPTION      |
|-----|-----------|-------------|-------------|--------------------------------------|--------------|
| 7:5 | 0x161     | NA          | 0           | Reserved                             |              |
|     |           |             |             | Valid values for the PLL2 R divider. |              |
|     |           |             |             | Field Value                          | Divide Value |
|     |           |             |             | 0 (0x00)                             | Not Valid    |
|     |           |             |             | 1 (0x01)                             | 1            |
| 4:0 | 0x161     | PLL2_R[4:0] | 2           | 2 (0x02)                             | 2            |
|     |           |             |             | 3 (0x03)                             | 3            |
|     |           |             |             |                                      |              |
|     |           |             |             | 30 (0x1E)                            | 30           |
|     |           |             |             | 31 (0x1F)                            | 31           |



## 9.5.2.8.2 PLL2\_P, OSCin\_FREQ, PLL2\_XTAL\_EN, PLL2\_REF\_2X\_EN

This register sets other PLL2 functions.

Table 60. Register 0x162

| ВІТ | NAME           | POR<br>DEFAULT | DESCRIPTION   |                     |  |
|-----|----------------|----------------|---|---------------------|--|
|     |                |                | The PLL2 N Prescaler divides the output of the VCO as selected by Mode_MUX1 and is connected to the PLL2 N divider.   |                     |  |
|     |                |                | Field Value   | Value               |  |
|     |                |                | 0 (0x00)  | 8                   |  |
|     |                |                | 1 (0x01)  | 2                   |  |
| 7:5 | PLL2_P         | 2              | 2 (0x02)  | 2                   |  |
|     | _              |                | 3 (0x03)  | 3                   |  |
|     |                |                | 4 (0x04)  | 4                   |  |
|     |                |                | 5 (0x05)  | 5                   |  |
|     |                |                | 6 (0x06)  | 6                   |  |
|     |                |                | 7 (0x07)  | 7                   |  |
|     |                | REQ 7          | The frequency of the PLL2 reference input to the PLL2 Phase Detector (OSCin/OSCin* port) must be programmed in order to support proper operation of the frequency calibration routine which locks the internal VCO to the target frequency.   |                     |  |
|     |                |                | Field Value   | OSCin Frequency     |  |
|     |                |                | 0 (0x00)  | 0 to 63 MHz         |  |
| 4:2 | OSCin_FREQ     |                | 1 (0x01)  | >63 MHz to 127 MHz  |  |
|     |                |                | 2 (0x02)  | >127 MHz to 255 MHz |  |
|     |                |                | 3 (0x03)  | Reserved            |  |
|     |                |                | 4 (0x04)  | >255 MHz to 500 MHz |  |
|     |                |                | 5 (0x05) to 7(0x07)   | Reserved            |  |
| 1   | PLL2_XTAL_EN   | 0              | If an external crystal is being used to implement a discrete VCXO, the internal feedback amplifier must be enabled with this bit in order to complete the oscillator circuit.  0: Oscillator Amplifier Disabled  1: Oscillator Amplifier Enabled  |                     |  |
| 0   | PLL2_REF_2X_EN | 1              | Enabling the PLL2 reference frequency doubler allows for higher phase detector frequencies on PLL2 than would normally be allowed with the given VCXO or Crystal frequency.  Higher phase detector frequencies reduces the PLL N values which makes the design of wider loop bandwidth filters possible.  0: Doubler Disabled  1: Doubler Enabled |                     |  |



## 9.5.2.8.3 PLL2\_FCAL\_DIS

This register disables frequency calibration.

## Table 61. Register 0x166

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION   |
|-----|---------------|----------------|---|
| 7:3 | NA            | 0              | Reserved  |
| 2   | PLL2_FCAL_DIS | 0              | This disables the PLL2 frequency calibration on programming register 0x168.  0: Frequency calibration enabled 1: Frequency calibration disabled |
| 1:0 | NA            | 0              | Reserved  |

#### 9.5.2.8.4 PLL2\_N

This register sets the PLL2 N divider value. Programming register 0x168 starts a VCO calibration routine if  $PLL2\_FCAL\_DIS = 0$ .

Table 62. Register 0x168

| BIT | NAME        | POR DEFAULT | DESCRIPTION |              |
|-----|-------------|-------------|-------------|--------------|
|     |             | 12          | Field Value | Divide Value |
|     | PLL2_N[7:0] |             | 0 (0x00)    | Not Valid    |
| 7.0 |             |             | 1 (0x01)    | 1            |
| 7:0 |             |             | 2 (0x02)    | 2            |
|     |             |             |             |              |
|     |             |             | 255 (0xFF)  | 255          |

## 9.5.2.8.5 PLL2\_WND\_SIZE, PLL2\_CP\_GAIN, PLL2\_CP\_POL, PLL2\_CP\_TRI

This register controls the PLL2 phase detector.

Table 63. Register 0x169

| BIT | NAME          | POR<br>DEFAULT | DESCRIPTION  |            |  |
|-----|---------------|----------------|--|------------|--|
| 7   | NA            | 0              | Reserved   |            |  |
|     |               |                | PLL2_WND_SIZE sets the window size used for digital lock detect for PLL2. If the phase error between the reference and feedback of PLL2 is less than specified time, then the PLL2 lock counter increments. This value must be programmed to 2 (3.7 ns). |            |  |
|     |               |                | Field Value  | Definition |  |
| 6:5 | PLL2_WND_SIZE | 2              | 0 (0x00)   | Reserved   |  |
|     |               |                | 1 (0x01)   | Reserved   |  |
|     |               |                | 2 (0x02)   | 3.7 ns     |  |
|     |               |                | 3 (0x03)   | Reserved   |  |
|     |               | CP_GAIN 3      | This bit programs the PLL2 charge pump outpillustrates the impact of the PLL2 TRISTATE by  |            |  |
|     |               |                | Field Value  | Definition |  |
| 4:3 | PLL2_CP_GAIN  |                | 0 (0x00)   | 100 μΑ     |  |
|     |               |                | 1 (0x01)   | 400 μA     |  |
|     |               |                | 2 (0x02)   | 1600 μΑ    |  |
|     |               |                | 3 (0x03)   | Reserved   |  |



# Table 63. Register 0x169 (continued)

| ВІТ | NAME          | POR<br>DEFAULT | DESCRIPTION   |  |  |
|-----|---------------|----------------|---|--|--|
| 2   | PLL2 CP POL   | 0              | PLL2_CP_POL sets the charge pump polarity negative charge pump polarity to be selected. A positive slope VCO increases output frequency WCO decreases output frequency with increas | Many VCOs use positive slope.  ncy with increasing voltage. A negative slope |  |
|     | Z FLLZ_OF_FOL | O              | Field Value   | Description  |  |
|     |               |                | 0   | Negative Slope VCO/VCXO  |  |
|     |               |                | 1   | Positive Slope VCO/VCXO  |  |
| 1   | PLL2_CP_TRI   | 0              | PLL2_CP_TRI TRI-STATEs the output of the PLL2 charge pump. 0: Disabled 1: TRI-STATE   |  |  |
| 0   | Fixed Value   | 1              | When programming register 0x169, this field must be set to 1.   |  |  |



## 9.5.2.8.6 SYSREF\_REQ\_EN, PLL2\_DLD\_CNT

# Table 64. PLL2\_DLD\_CNT Register Configuration, PLL2\_DLD\_CNT[15:0]

| MSB        | LSB        |  |
|------------|------------|--|
| 0x16A[5:0] | 0x16B[7:0] |  |

This register has the value of the PLL2 DLD counter.

## Table 65. Registers 0x16A and 0x16B

| ВІТ | REGISTERS | NAME                   | POR<br>DEFAULT | DESCRIPTION   |              |  |
|-----|-----------|------------------------|----------------|---|--------------|--|
| 7   | 0x16A     | NA                     | 0              | Reserved  |              |  |
| 6   | 0x16A     | SYSREF_REQ_EN          | 0              | Enables the SYNC/SYSREF_REQ pin to force the SYSREF_MUX = 3 for continuous pulses. When using this feature enable pulser and set SYSREF_MUX = 2 (Pulser). |              |  |
|     | 5:0 0x16A | PLL2_DLD<br>_CNT[13:8] |                | The reference and feedback of PLL2 mu as specified by PLL2_WND_SIZE for PL lock detect is asserted.   |              |  |
| 5:0 |           |                        | 32             | Field Value   | Divide Value |  |
|     |           |                        |                | 0 (0x00)  | Not Valid    |  |
|     |           |                        |                | 1 (0x01)  | 1            |  |
|     |           | PLL2_DLD_CNT           |                | 2 (0x02)  | 2            |  |
|     |           |                        | 0              | 3 (0x03)  | 3            |  |
| 7:0 | 0x16B     |                        |                |   |              |  |
|     |           |                        |                | 16,382 (0x3FFE)   | 16,382       |  |
|     |           |                        |                | 16,383 (0x3FFF)   | 16,383       |  |



## 9.5.2.8.7 PLL2\_LF\_R4, PLL2\_LF\_R3

This register controls the integrated loop filter resistors.

Table 66. Register 0x16C

| BIT | NAME       | POR<br>DEFAULT | DESCR   | RIPTION    |
|-----|------------|----------------|---|------------|
| 7:6 | NA         | 0              | Reserved  |            |
|     |            |                | Internal loop filter components are available for filters without requiring external components. Internal loop filter resistor R4 can be set acco |            |
|     |            |                | Field Value   | Resistance |
|     |            |                | 0 (0x00)  | 200 Ω      |
|     |            |                | 1 (0x01)  | 1 kΩ       |
| 5:3 | PLL2_LF_R4 | 0              | 2 (0x02)  | 2 kΩ       |
|     |            |                | 3 (0x03)  | 4 kΩ       |
|     |            |                | 4 (0x04)  | 16 kΩ      |
|     |            |                | 5 (0x05)  | Reserved   |
|     |            |                | 6 (0x06)  | Reserved   |
|     |            |                | 7 (0x07)  | Reserved   |
|     |            |                | Internal loop filter components are available for filters without requiring external components. Internal loop filter resistor R3 can be set acco |            |
|     |            |                | Field Value   | Resistance |
|     | PLL2_LF_R3 | _LF_R3 0       | 0 (0x00)  | 200 Ω      |
|     |            |                | 1 (0x01)  | 1 kΩ       |
| 2:0 |            |                | 2 (0x02)  | 2 kΩ       |
|     |            |                | 3 (0x03)  | 4 kΩ       |
|     |            |                | 4 (0x04)  | 16 kΩ      |
|     |            |                | 5 (0x05)  | Reserved   |
|     |            |                | 6 (0x06)  | Reserved   |
|     |            |                | 7 (0x07)  | Reserved   |



# 9.5.2.8.8 PLL2\_LF\_C4, PLL2\_LF\_C3

This register controls the integrated loop filter capacitors.

Table 67. Register 0x16D

| ВІТ | NAME       | POR<br>DEFAULT | DESCRIPTION  |   |  |
|-----|------------|----------------|--|---|--|
|     |            |                | Internal loop filter components are available for PLL2, enabling either 3rd or 4th order loop filters without requiring external components.  Internal loop filter capacitor C4 can be set according to the following table. |   |  |
|     |            |                | Field Value  | Capacitance   |  |
|     |            |                | 0 (0x00)   | 10 pF   |  |
|     |            |                | 1 (0x01)   | 15 pF   |  |
|     |            |                | 2 (0x02)   | 29 pF   |  |
|     |            |                | 3 (0x03)   | 34 pF   |  |
|     |            |                | 4 (0x04)   | 47 pF   |  |
|     |            |                | 5 (0x05)   | 52 pF   |  |
| 7:4 | PLL2_LF_C4 | 0              | 6 (0x06)   | 66 pF   |  |
|     |            |                | 7 (0x07)   | 71 pF   |  |
|     |            |                | 8 (0x08)   | 103 pF  |  |
|     |            |                | 9 (0x09)   | 108 pF  |  |
|     |            |                | 10 (0x0A)  | 122 pF  |  |
|     |            |                | 11 (0x0B)  | 126 pF  |  |
|     |            |                | 12 (0x0C)  | 141 pF  |  |
|     |            |                | 13 (0x0D)  | 146 pF  |  |
|     |            |                | 14 (0x0E)  | Reserved  |  |
|     |            |                | 15 (0x0F)  | Reserved  |  |
|     |            |                | Internal loop filter components are available for PLL2, enabling either 3rd or 4th order loop filters without requiring external components.  Internal loop filter capacitor C3 can be set according to the following table. |   |  |
|     |            |                | Field Value  | Capacitance   |  |
|     |            |                | 0 (0x00)   | 10 pF   |  |
| Ī   |            |                | 1 (0x01)   | 11 pF   |  |
|     |            |                |  | ·   |  |
|     |            |                | 2 (UXU2)   | 15 pF   |  |
|     |            |                | 2 (0x02)<br>3 (0x03)   | 15 pF<br>16 pF  |  |
|     |            |                | 3 (0x03)   | 16 pF   |  |
|     |            |                | 3 (0x03)<br>4 (0x04)   | 16 pF<br>19 pF  |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)   | 16 pF   |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)<br>4 (0x04)<br>5 (0x05)   | 16 pF<br>19 pF<br>20 pF   |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)<br>4 (0x04)<br>5 (0x05)<br>6 (0x06)   | 16 pF<br>19 pF<br>20 pF<br>24 pF  |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)<br>4 (0x04)<br>5 (0x05)<br>6 (0x06)<br>7 (0x07)   | 16 pF<br>19 pF<br>20 pF<br>24 pF<br>25 pF                                     |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)<br>4 (0x04)<br>5 (0x05)<br>6 (0x06)<br>7 (0x07)<br>8 (0x08)   | 16 pF<br>19 pF<br>20 pF<br>24 pF<br>25 pF<br>29 pF                            |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03)<br>4 (0x04)<br>5 (0x05)<br>6 (0x06)<br>7 (0x07)<br>8 (0x08)<br>9 (0x09)   | 16 pF<br>19 pF<br>20 pF<br>24 pF<br>25 pF<br>29 pF<br>30 pF                   |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03) 4 (0x04) 5 (0x05) 6 (0x06) 7 (0x07) 8 (0x08) 9 (0x09) 10 (0x0A) 11 (0x0B)   | 16 pF<br>19 pF<br>20 pF<br>24 pF<br>25 pF<br>29 pF<br>30 pF<br>33 pF<br>34 pF |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03) 4 (0x04) 5 (0x05) 6 (0x06) 7 (0x07) 8 (0x08) 9 (0x09) 10 (0x0A) 11 (0x0B) 12 (0x0C)   | 16 pF 19 pF 20 pF 24 pF 25 pF 29 pF 30 pF 33 pF 34 pF                         |  |
| 3:0 | PLL2_LF_C3 | 0              | 3 (0x03) 4 (0x04) 5 (0x05) 6 (0x06) 7 (0x07) 8 (0x08) 9 (0x09) 10 (0x0A) 11 (0x0B)   | 16 pF<br>19 pF<br>20 pF<br>24 pF<br>25 pF<br>29 pF<br>30 pF<br>33 pF<br>34 pF |  |



## 9.5.2.8.9 PLL2\_LD\_MUX, PLL2\_LD\_TYPE

This register sets the output value of the Status\_LD2 pin.

Table 68. Register 0x16E

| Tris sets the output value of the Status_LD2 pin.           Field Value         MUX Value           0 (0x00)         Logic Low           1 (0x01)         PLL1 DLD           2 (0x02)         PLL2 DLD           3 (0x03)         PLL1 & PLL2 DLD           4 (0x04)         Holdover Status           5 (0x05)         DAC Locked           6 (0x06)         Reserved           7 (0x07)         SPI Readback           9 (0x09)         DAC Rail           9 (0x09)         DAC Low           10 (0x0A)         DAC High           11 (0x0B)         PLL1_N |
|---|
| 7:3 PLL2_LD_MUX 2   |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Rail PLL2_LD_MUX 2 8 (0x09) DAC Low DAC High DAC High DAC High DAC High DAC High PLL1_N  |
| 7:3 PLL2_LD_MUX  2 (0x02) PLL2 DLD  3 (0x03) PLL1 & PLL2 DLD  4 (0x04) Holdover Status  5 (0x05) DAC Locked  6 (0x06) Reserved  7 (0x07) SPI Readback  7 (0x07) SPI Readback  9 (0x08) DAC Rail  9 (0x09) DAC Low  10 (0x0A) DAC High  11 (0x0B) PLL1_N   |
| 7:3 PLL2_LD_MUX  2 8 (0x08)  PLL1 & PLL2 DLD  Holdover Status  5 (0x05)  DAC Locked  6 (0x06)  Reserved  7 (0x07)  SPI Readback  PLL2_LD_MUX  2 8 (0x08)  DAC Rail  9 (0x09)  DAC Low  10 (0x0A)  DAC High  11 (0x0B)  PLL1_N   |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Low  9 (0x09) DAC Rail  9 (0x09) DAC Rail  10 (0x0A) DAC High  11 (0x0B) PLL1_N  |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Locked  8 (0x08) Reserved  7 (0x07) SPI Readback  9 (0x08) DAC Rail  10 (0x0A) DAC High  11 (0x0B) PLL1_N  |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Rail 9 (0x09) DAC Low 10 (0x0A) DAC High 11 (0x0B) PLL1_N  |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Rail 9 (0x09) DAC Low 10 (0x0A) DAC High 11 (0x0B) PLL1_N  |
| 7:3 PLL2_LD_MUX 2 8 (0x08) DAC Rail 9 (0x09) DAC Low 10 (0x0A) DAC High 11 (0x0B) PLL1_N  |
| 9 (0x09) DAC Low 10 (0x0A) DAC High 11 (0x0B) PLL1_N  |
| 10 (0x0A) DAC High 11 (0x0B) PLL1_N   |
| 11 (0x0B) PLL1_N  |
|   |
|   |
| 12 (0x0C) PLL1_N/2  |
| 13 (0x0D) PLL2_N  |
| 14 (0x0E) PLL2_N/2  |
| 15 (0x0F) PLL1_R  |
| 16 (0x10) PLL1_R/2  |
| 17 (0x11) PLL2_R <sup>(1)</sup>   |
| 18 (0x12) PLL2_R/2 <sup>(1)</sup>   |
| Sets the IO type of the Status_LD2 pin.   |
| Field Value TYPE  |
| 0 (0x00) Reserved   |
| 1 (0x01) Reserved   |
| 2:0 PLL2_LD_TYPE 6 2 (0x02) Reserved  |
| 3 (0x03) Output (push-pull)   |
| 4 (0x04) Output inverted (push-pull)  |
| 5 (0x05) Reserved   |
| 6 (0x06) Output (open drain)  |

<sup>(1)</sup> Only valid when PLL1\_LD\_MUX is not set to 2 (PLL2\_DLD) or 3 (PLL1 & PLL2 DLD).



#### 9.5.2.9 (0x16F - 0x1FFF) Misc Registers

#### 9.5.2.9.1 Fixed Register

Always program this register to 0xAA.

# Table 69. Register 0x171

| BIT | NAME           | POR<br>DEFAULT | DESCRIPTION                  |
|-----|----------------|----------------|------------------------------|
| 7:0 | Fixed Register | 10 (0x0A)      | Always program to 170 (0xAA) |

#### 9.5.2.9.2 Fixed Register

Always program this register to 0x02.

#### Table 70. Register 0x172

| ВІТ | NAME           | POR<br>DEFAULT | DESCRIPTION                |
|-----|----------------|----------------|----------------------------|
| 7:0 | Fixed Register | 0              | Always program to 2 (0x02) |

#### 9.5.2.9.3 PLL2\_PRE\_PD, PLL2\_PD

#### Table 71. Register 0x173

| BIT | NAME        | DESCRIPTION   |  |  |
|-----|-------------|---|--|--|
| 7   | N/A         | Reserved  |  |  |
| 6   | PLL2_PRE_PD | Powerdown PLL2 prescaler 0: Normal Operation 1: Powerdown |  |  |
| 5   | PLL2_PD     | Powerdown PLL2 0: Normal Operation 1: Powerdown           |  |  |
| 4:0 | N/A         | Reserved  |  |  |

# 9.5.2.9.4 OPT\_REG\_1

This register must be written with the following value depending on which LMK04228 is used to optimize VCO1 phase noise performance over temperature. This register must be written before writing register 0x168 when using VCO1.

#### Table 72. Register 0x17C

| BIT | NAME      | DESCRIPTION  |
|-----|-----------|--------------|
| 7:0 | OPT_REG_1 | 21: LMK04228 |

#### 9.5.2.9.5 OPT\_REG\_2

This register must be written with the following value depending on which LMK04228 is used to optimize VCO1 phase noise performance over temperature. This register must be written before writing register 0x168 when using VCO1.

Table 73. Register 0x17D

| BIT | NAME      | DESCRIPTION  |
|-----|-----------|--------------|
| 7:0 | OPT_REG_2 | 51: LMK04228 |



# 9.5.2.9.6 RB\_PLL1\_LD\_LOST, RB\_PLL1\_LD, CLR\_PLL1\_LD\_LOST

# Table 74. Register 0x182

| BIT | NAME             | DESCRIPTION  |
|-----|------------------|--|
| 7:3 | N/A              | Reserved   |
| 2   | RB_PLL1_LD_LOST  | This is set when PLL1 DLD edge falls. Does not set if cleared while PLL1 DLD is low.   |
| 1   | RB_PLL1_LD       | Read back 0: PLL1 DLD is low. Read back 1: PLL1 DLD is high.   |
| 0   | CLR_PLL1_LD_LOST | To reset RB_PLL1_LD_LOST, write CLR_PLL1_LD_LOST with 1 and then 0.  0: RB_PLL1_LD_LOST will be set on next falling PLL1 DLD edge.  1: RB_PLL1_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL1_LD_LOST to become set again. |

# 9.5.2.9.7 RB\_PLL2\_LD\_LOST, RB\_PLL2\_LD, CLR\_PLL2\_LD\_LOST

## Table 75. Register 0x0x183

| BIT | NAME             | DESCRIPTION  |
|-----|------------------|--|
| 7:3 | N/A              | Reserved   |
| 2   | RB_PLL2_LD_LOST  | This is set when PLL2 DLD edge falls. Does not set if cleared while PLL2 DLD is low.   |
| 1   | RB_PLL2_LD       | Read back 0: PLL2 DLD is low. Read back 1: PLL2 DLD is high.   |
| 0   | CLR_PLL2_LD_LOST | To reset RB_PLL2_LD_LOST, write CLR_PLL2_LD_LOST with 1 and then 0.  0: RB_PLL2_LD_LOST will be set on next falling PLL2 DLD edge.  1: RB_PLL2_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL2_LD_LOST to become set again. |

# 9.5.2.9.8 RB\_DAC\_VALUE(MSB), RB\_CLKinX\_SEL, RB\_CLKinX\_LOS

This register provides read back access to CLKinX selection indicator and CLKinX LOS indicator. The 2 MSBs are shared with the RB\_DAC\_VALUE. See RB\_DAC\_VALUE section.

# Table 76. Register 0x184

| BIT | NAME              | DESCRIPTION   |
|-----|-------------------|---|
| 7:6 | RB_DAC_VALUE[9:8] | See RB_DAC_VALUE section.   |
| 5   | RB_CLKin2_SEL     | Read back 0: CLKin2 is not selected for input to PLL1. Read back 1: CLKin2 is selected for input to PLL1. |
| 4   | RB_CLKin1_SEL     | Read back 0: CLKin1 is not selected for input to PLL1. Read back 1: CLKin1 is selected for input to PLL1. |
| 3   | RB_CLKin0_SEL     | Read back 0: CLKin0 is not selected for input to PLL1. Read back 1: CLKin0 is selected for input to PLL1. |
| 2   | N/A               |   |
| 1   | RB_CLKin1_LOS     | Read back 1: CLKin1 LOS is active. Read back 0: CLKin1 LOS is not active.                                 |
| 0   | RB_CLKin0_LOS     | Read back 1: CLKin0 LOS is active. Read back 0: CLKin0 LOS is not active.                                 |



# 9.5.2.9.9 RB\_DAC\_VALUE

Contains the value of the DAC for user readback.

# Table 77. RB\_DAC\_VALUE Register Configuration, RB\_DAC\_VALUE[7:0]

| Field Name   | MSB         | LSB         |  |  |
|--------------|-------------|-------------|--|--|
| RB_DAC_VALUE | 0x184 [7:6] | 0x185 [7:0] |  |  |

# Table 78. Registers 0x184 and 0x185

| ВІТ | REGISTERS | SISTERS NAME POR DEFAULT |   | DESCRIPTION  |
|-----|-----------|--------------------------|---|--|
| 7:6 | 0x184     | RB_DAC_<br>VALUE[9:8]    | 2 | DAC value is 512 on power on reset, if PLL1 locks upon power-up the DAC value will change. |
| 7:0 | 0x185     | RB_DAC_<br>VALUE[7:0]    | 0 |  |

# 9.5.2.9.10 RB\_HOLDOVER

# Table 79. Register 0x188

| BIT | NAME        | DESCRIPTION   |
|-----|-------------|---|
| 7:5 | N/A         | Reserved  |
| 4   | RB_HOLDOVER | Read back 0: Not in HOLDOVER. Read back 1: In HOLDOVER. |
| 3:0 | N/A         | Reserved  |

# 9.5.2.9.11 SPI\_LOCK

Prevents SPI registers from being written to, except for 0x1FFD, 0x1FFE, 0x1FFF. These registers must be written to sequentially and in order: 0x1FFD, 0x1FFE, 0x1FFF.

These registers cannot be read back.

# Table 80. SPI\_LOCK Register Configuration, SPI\_LOCK[7:0]

| MSB          | _            | LSB          |  |  |
|--------------|--------------|--------------|--|--|
| 0x1FFD [7:0] | 0x1FFE [7:0] | 0x1FFF [7:0] |  |  |

# Table 81. Registers 0x1FFD, 0x1FFE, and 0x1FFF

| ВІТ | REGISTERS | NAME            | POR<br>DEFAULT | DESCRIPTION  |  |  |  |
|-----|-----------|-----------------|----------------|--|--|--|--|
| 7:0 | 0x1FFD    | SPI_LOCK[23:16] | 0              | 0: Registers unlocked.<br>1 to 255: Registers locked                               |  |  |  |
| 7:0 | 0x1FFE    | SPI_LOCK[15:8]  | 0              | 0: Registers unlocked.<br>1 to 255: Registers locked                               |  |  |  |
| 7:0 | 0x1FFF    | SPI_LOCK[7:0]   | 83             | 0 to 82: Registers locked<br>83: Registers unlocked<br>84 to 256: Registers locked |  |  |  |



# 10 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

# 10.1 Application Information

To assist customers in frequency planning and design of loop filters, Texas Instrument's provides the Clock Design Tool (www.ti.com/tool/clockdesigntool) and Clock Architect (www.ti.com/clockarchitect).

## 10.1.1 Digital Lock Detect Frequency Accuracy

The digital lock detect circuit is used to determine PLL1 locked, PLL2 locked, and holdover exit events. A window size and lock count register are programmed to set a ppm frequency accuracy of reference to feedback signals of the PLL for each event to occur. When a PLL digital lock event occurs, the corresponding PLL digital lock detect is asserted true. When the holdover exit event occurs, the device will exit holdover mode.

| EVENT         | PLL  | WINDOW SIZE   | LOCK COUNT       |  |
|---------------|------|---------------|------------------|--|
| PLL1 Locked   | PLL1 | PLL1_WND_SIZE | PLL1_DLD_CNT     |  |
| PLL2 Locked   | PLL2 | PLL2_WND_SIZE | PLL2_DLD_CNT     |  |
| Holdover Exit | PLL1 | PLL1_WND_SIZE | HOLDOVER_DLD_CNT |  |

For a digital lock detect event to occur there must be a *lock count* number of phase detector cycles of PLLX during which the time/phase error of the PLLX\_R reference and PLLX\_N feedback signal edges are within the user programmable *window size*. Because there must be at least *lock count* phase detector events before a lock event occurs, a minimum digital lock event time can be calculated as *lock count* / f<sub>PDX</sub> where X = 1 for PLL1 or 2 for PLL2.

By using Equation 3, values for a *lock count* and *window size* can be chosen to set the frequency accuracy required by the system in ppm before the digital lock detect event occurs:

$$ppm = \frac{1e6 \times PLLX\_WND\_SIZE \times f_{PDX}}{PLLX\_DLD\_CNT}$$
(3)

The effect of the *lock count* value is that it shortens the effective lock window size by dividing the *window size* by *lock count*.

If at any time the PLLX\_R reference and PLLX\_N feedback signals are outside the time window set by window size, then the lock count value is reset to 0.

#### **NOTE**

In cases where the period of the phase detector frequency approaches the value of the default PLL1\_WND\_SIZE increment (40 ns), the lock detect circuit will not function with the default value of PLL1\_WND\_SIZE. For phase detector frequencies at or above 25 MHz, TI recommends setting PLL1\_WND\_SIZE to 0x02 (19 ns) or a smaller value.

## 10.1.1.1 Minimum Lock Time Calculation Example

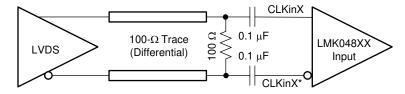
To calculate the minimum PLL2 digital lock time given a PLL2 phase detector frequency of 40 MHz and PLL2 DLD CNT = 10,000. Then the minimum lock time of PLL2 will be 10,000 / 40 MHz =  $250 \mu s$ .



# 10.1.2 Driving CLKin AND OSCin Inputs

# 10.1.2.1 Driving CLKin PINS With a Differential Source

Both CLKin ports can be driven by differential signals. TI recommends setting the input mode to bipolar (CLKinX\_BUF\_TYPE = 0) when using differential reference clocks. The LMK04228 internally biases the input pins so the differential interface should be AC coupled. The recommended circuits for driving the CLKin pins with either LVDS or LVPECL are shown in Figure 9 and Figure 10.



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Figure 9. CLKinX/X\* Termination for an LVDS Reference Clock Source

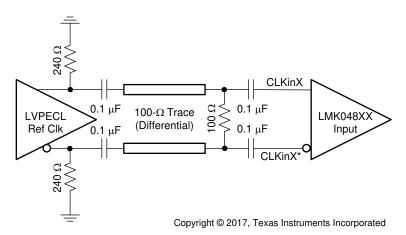


Figure 10. CLKinX/X\* Termination for an LVPECL Reference Clock Source

Finally, a reference clock source that produces a differential sine wave output can drive the CLKin pins using the following circuit. Note: the signal level must conform to the requirements for the CLKin pins listed in *Electrical Characteristics*.

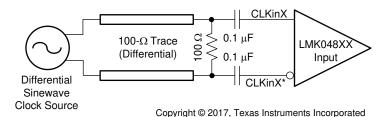


Figure 11. CLKinX/X\* Termination for a Differential Sinewave Reference Clock Source

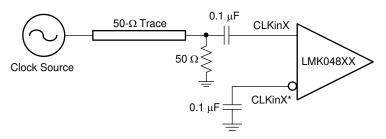


# 10.1.2.2 Driving CLKin Pins With a Single-Ended Source

The CLKin pins of the LMK04228 can be driven using a single-ended reference clock source, for example, either a sine wave source or an LVCMOS/LVTTL source. Either AC coupling or DC coupling may be used. In the case of the sine wave source that is expecting a  $50-\Omega$  load, TI recommends that AC coupling be used as shown in the circuit below with a  $50-\Omega$  termination.

#### NOTE

The signal level must conform to the requirements for the CLKin pins listed in *Electrical Characteristics*. CLKinX\_BUF\_TYPE is recommended to be set to bipolar mode (CLKinX\_BUF\_TYPE = 0).



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Figure 12. CLKinX/X\* Single-Ended Termination

If the CLKin pins are being driven with a single-ended LVCMOS/LVTTL source, either DC coupling or AC coupling may be used. If DC coupling is used, the CLKinX\_BUF\_TYPE should be set to MOS buffer mode (CLKinX\_BUF\_TYPE = 1) and the voltage swing of the source must meet the specifications for DC-coupled, MOS-mode clock inputs given in *Electrical Characteristics*. If AC coupling is used, the CLKinX\_BUF\_TYPE should be set to the bipolar buffer mode (CLKinX\_BUF\_TYPE = 0). The voltage swing at the input pins must meet the specifications for AC-coupled, bipolar mode clock inputs given in *Electrical Characteristics*. In this case, some attenuation of the clock input level may be required. A simple resistive divider circuit before the AC-coupling capacitor is sufficient.

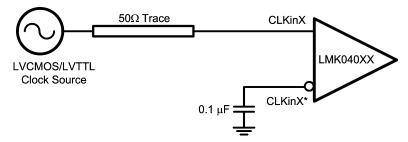
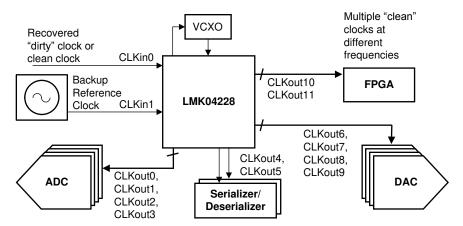


Figure 13. DC-Coupled LVCMOS/LVTTL Reference Clock

# 10.2 Typical Application

This design example highlights using the available tools to design loop filters and create programming map for LMK04228.



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Figure 14. Typical Application

## 10.2.1 Design Requirements

Clocks outputs:

- 1x 245.76-MHz clock for JESD204B ADC, LVPECL.
  - This clock requires the best performance in this example.
- 2x 983.04-MHz clock for JESD204B DAC, LVPECL.
- 1x 122.88-MHz clock for JESD204B FPGA block, LVDS
- 3x 10.24-MHz SYSREF for ADC (LVPECL), DAC (LVPECL), FPGA (LVDS).
- 2x 122.88-MHz clock for FPGA, LVDS

For best performance, the highest possible phase detector frequency is used at PLL2. As such, a 122.88-MHz VCXO is used.

#### 10.2.2 Detailed Design Procedure

#### 10.2.2.1 Device Programming

TICS Pro register programming tool exposes the registers for the LMK04228 (and many other TI products) using block diagrams to demonstrate the purpose and location of register settings. By connecting a USB2ANY programmer to the SPI inputs of the device, TICS Pro can update register configurations in real time for rapidly validating desired configurations.

Frequency planning for assignment of outputs:

- To minimize crosstalk perform frequency planning / CLKout assignments to keep common frequencies on outputs close together.
- It is best to place common device clock output frequencies on outputs sharing the same V<sub>CC</sub> group, for example, these outputs share Vcc4\_CG2. Refer to *Pin Configuration and Functions* to see the V<sub>CC</sub> groupings the clock outputs.

In this example, the 245.76-MHz ADC output needs the best performance. DCLKout2 on the LMK04228 provides the best noise floor / performance. The 245.76 MHz will be placed on DCLKout2 with 10.24-MHz SYSREF on SDCLKout3.

 For best performance the input and output drive level bits may be set. Best noise floor performance is achieved with DCLKout2\_IDL = 1 and DCLKout2\_ODL = 1.

In this example, the 983.04-MHz DAC output is placed on DCLKout4 and DCLKout6 with 10.24-MHz SYSREF on paired SDCLKout5 and SDCLKout7 outputs.



# **Typical Application (continued)**

These outputs share Vcc4 CG2.

In this example, the 122.88-MHz FPGA JESD204B output is placed on DCLKout10 with 10.24-MHz SYSREF on paired SDCLKout11 output.

Additionally, the 122.88-MHz FPGA non-JESD204B outputs are placed on DCLKout8 and SDCLKout9.

• When frequency planning, consider PLL2 as a clock output at the phase detector frequency. As such, these 122.88-MHz outputs have been placed on the outputs close to the PLL2 and Charge Pump power supplies.

Once the device programming is completed as desired in TICS Pro, the register settings can be exported for use with other programming controllers.

# 10.3 Do's and Don'ts

#### 10.3.1 Pin Connection Recommendations

- V<sub>CC</sub> Pins and Decoupling: all V<sub>CC</sub> pins must always be connected, including for unused clock output groups.
- **Unused Clock Outputs:** leave unused clock outputs floating and powered down. Use the appropriate registers to power down unused clock outputs.
- Unused Clock Inputs: unused clock inputs can be left floating.



# 11 Power Supply Recommendations

# 11.1 Current Consumption / Power Dissipation Calculations

From Table 82 the current consumption can be calculated for any configuration. Data below is typical and not assured.

Table 82. Typical Current Consumption for Selected Functional Blocks ( $T_A$  = 25°C,  $V_{CC}$  = 3.3 V)

| BLOCK                               | TEST                           | TEST CONDITION                  |       |        |  |
|-------------------------------------|--------------------------------|---------------------------------|-------|--------|--|
| CORE and FUNCTIONAL BI              | LOCKS                          |                                 |       |        |  |
| Core                                | Dual-loop, internal VCO0       | PLL1 and PLL2 locked            | 131.5 | 433.95 |  |
| VCO                                 | VCO1 is selected               | LMK04228                        | 13.5  | 44.55  |  |
| OSCin Doubler                       | Doubler is enabled             | EN_PLL2_REF_2X = 1              | 3     | 9.9    |  |
| CLKin                               | Any one of the CLKinX is e     | nabled                          | 4.9   | 16.17  |  |
|                                     | Holdover is enabled            | HOLDOVER_EN = 1                 | 1.3   | 4.29   |  |
| Holdover                            | Hitless switch is enabled      | HOLDOVER_HITLESS_SWI<br>TCH = 1 | 0.9   | 2.97   |  |
|                                     | Track mode                     | TRACK_EN = 1                    | 2.5   | 8.25   |  |
| SYNC_EN = 1                         | Required for SYNC and SY       | SREF functionality              | 7.6   | 25.08  |  |
|                                     | Enabled                        | SYSREF_PD = 0                   | 27.2  | 89.76  |  |
| 0)/0055                             | Pulser is enabled              | SYSREF_PLSR_PD = 0              | 4.1   | 13.53  |  |
| SYSREF                              | SYSREF pulses mode             | SYSREF_MUX = 2                  | 3     | 9.9    |  |
|                                     | SYSREF continuous mode         | SYSREF_MUX = 3                  | 3     | 9.9    |  |
| CLOCK GROUP                         | ,                              |                                 |       | 1      |  |
| Enabled                             | Any one of the CLKoutX_Y       | _PD = 0                         | 20.1  | 66.33  |  |
| IDL                                 | Any one of the CLKoutX_Y       | _IDL = 1                        | 2.2   | 7.26   |  |
| ODL                                 | Andy one of the CLKoutX_`      | Y_ODL = 1                       | 3.2   | 10.56  |  |
|                                     | Divider only                   | DCLKoutX_MUX = 0                | 13.6  | 44.88  |  |
| Clock Divider                       | Divider + DCC + HS             | DCLKoutX_MUX = 1                | 17.7  | 58.41  |  |
|                                     | Analog Delay + Divider         | DCLKoutX_MUX = 3                | 13.6  | 44.88  |  |
| CLOCK OUTPUT BUFFERS                | •                              | ,                               |       | 1      |  |
| LVDS 100-Ω differential termination |                                | on                              | 6     | 19.8   |  |
| OSCout BUFFERS                      |                                |                                 |       |        |  |
| LVDS                                | 100-Ω differential termination | on                              | 18.5  | 61.05  |  |
| 11/01/02                            | LVCMOS pair                    | 150 MHz                         | 42.6  | 140.58 |  |
| LVCMOS                              | LVCMOS single                  | 150 MHz                         | 27    | 89.1   |  |



# 12 Layout

# 12.1 Layout Guidelines

# 12.1.1 Thermal Management

Power consumption of the LMK04228 of devices can be high enough to require attention to thermal management. For reliability and performance reasons the die temperature should be limited to a maximum of 125°C. That is, as an estimate,  $T_A$  (ambient temperature) plus device power consumption times  $R_{\theta JA}$  should not exceed 125°C.

The package of the device has an exposed pad that provides the primary heat removal path as well as excellent electrical grounding to a printed-circuit board. To maximize the removal of heat from the package, a thermal land pattern including multiple vias to a ground plane must be incorporated on the PCB within the footprint of the package. The exposed pad must be soldered down to ensure adequate heat conduction out of the package.

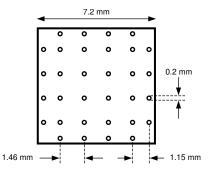
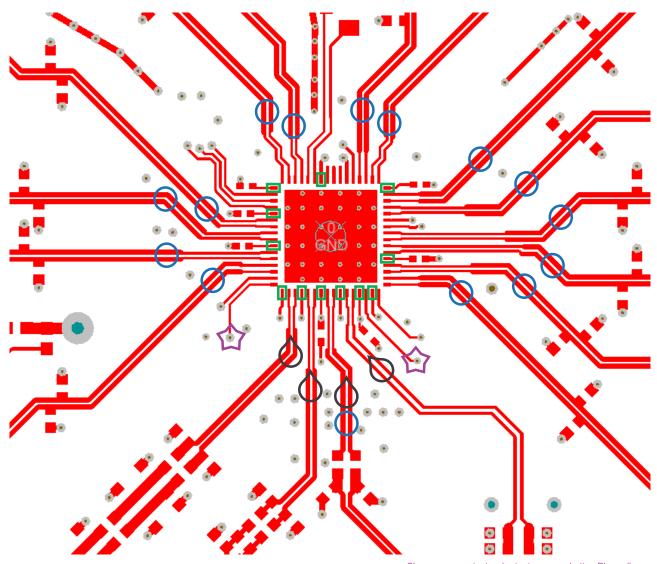


Figure 15. Recommended Land and Via Pattern

# TEXAS INSTRUMENTS

# 12.2 Layout Example



δ

CLKin and OSCin path – if differential input (preferred) route traces tightly coupled. If single ended, have at least 3 trace width (of CLKin/OSCin trace) separation from other RF traces. When using CLKin1 for high frequency input for external VCO or distribution, a 3 dB pi pad is suggested for termination.

Place terminations close to IC.

CLKin2 and OSCout share pins and is programmable for input or output.



For CLKout Vccs in JESD204B application, place ferrite beads then 1  $\mu F$  capacitor. The 1  $\mu F$  capacitor supports low frequency SYSREF switching/turn on. For CLKout Vccs in traditional application place ferrite bead on top layer close to pins to choke high frequency noise from via.

Charge pump output – shorter traces are better. Place all resistors and caps closer to IC except for a single capacitor and associated resistor, if any, next to VCXO. In a 2<sup>nd</sup> order filter place C1 close to VCXO Vtune pin. In a 3<sup>rd</sup> and 4<sup>th</sup> order filter place R3/C3 or R4/C4 respectively close to VCXO.

CLKouts/OSCouts – Normally differential signals, should be routed tightly coupled to minimize PCB crosstalk. Trace impedance and terminations should be designed according to output type being used (i.e. LVDS, LVPECL, LVCMOS). For LVPECL/LCPECL place emitter resistors close to IC. OSCout shares pins with CLKin2 and is programmable for input or output

Figure 16. LMK04228 Layout Example



# 13 器件和文档支持

# 13.1 器件支持

#### 13.1.1 TICS Pro

免费 EVM 编程软件。还可用于生成寄存器映射,以便为特定的 应用进行编程。

要下载 TICS Pro, 请转到 www.ti.com.cn/tool/cn/ticspro-sw。

# 13.2 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use

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# 13.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 14 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更,恕不另行通知,且不会对此文档进行修订。如需获取此数据表的浏览器版本,请查阅左侧的导航栏。

www.ti.com 10-Nov-2025

#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins  | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/         | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|-----------------|-----------------------|------|---------------|---------------------|--------------|--------------|
|                       | (1)    | (2)           |                 |                       | (3)  | Ball material | Peak reflow         |              | (6)          |
|                       |        |               |                 |                       |      | (4)           | (5)                 |              |              |
| LMK04228NKDR          | Active | Production    | WQFN (NKD)   64 | 2000   LARGE T&R      | Yes  | SN            | Level-3-260C-168 HR | -40 to 85    | K04228NKD    |
| LMK04228NKDR.A        | Active | Production    | WQFN (NKD)   64 | 2000   LARGE T&R      | Yes  | SN            | Level-3-260C-168 HR | -40 to 85    | K04228NKD    |
| LMK04228NKDT          | Active | Production    | WQFN (NKD)   64 | 250   SMALL T&R       | Yes  | SN            | Level-3-260C-168 HR | -40 to 85    | K04228NKD    |
| LMK04228NKDT.A        | Active | Production    | WQFN (NKD)   64 | 250   SMALL T&R       | Yes  | SN            | Level-3-260C-168 HR | -40 to 85    | K04228NKD    |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

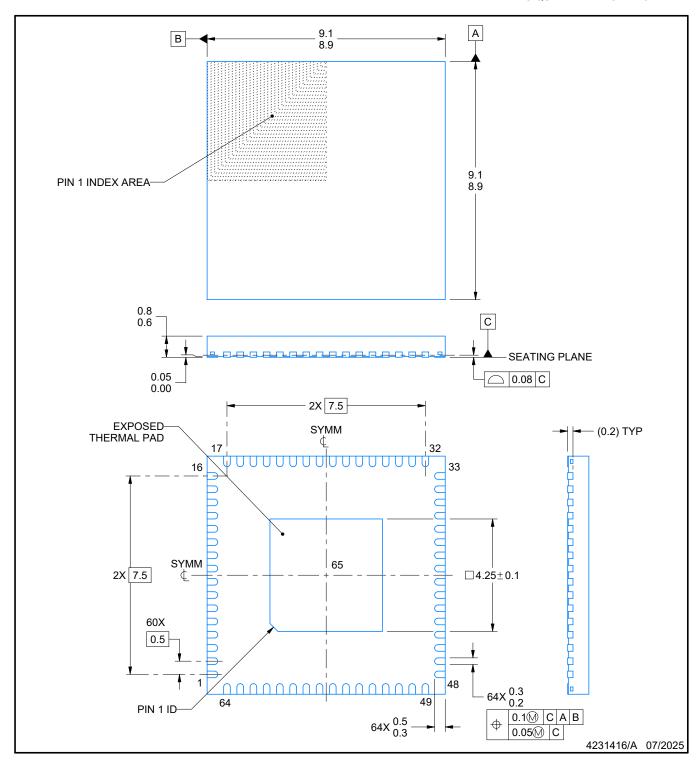
<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PLASTIC QUAD FLATPACK - NO LEAD

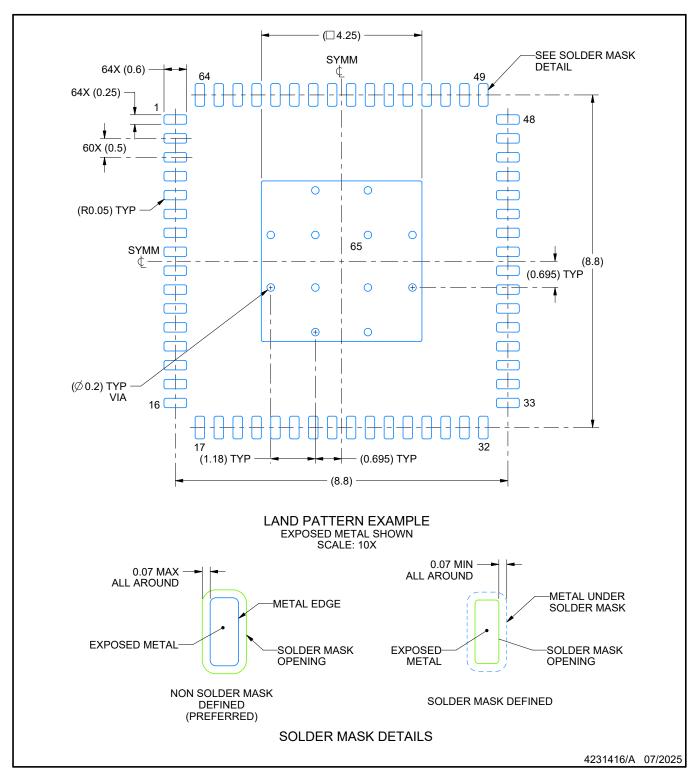


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

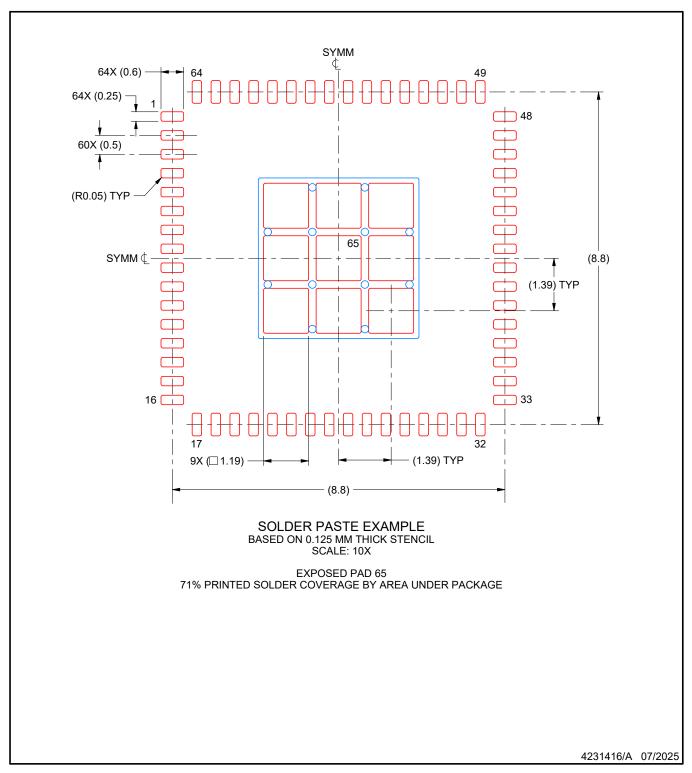


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.





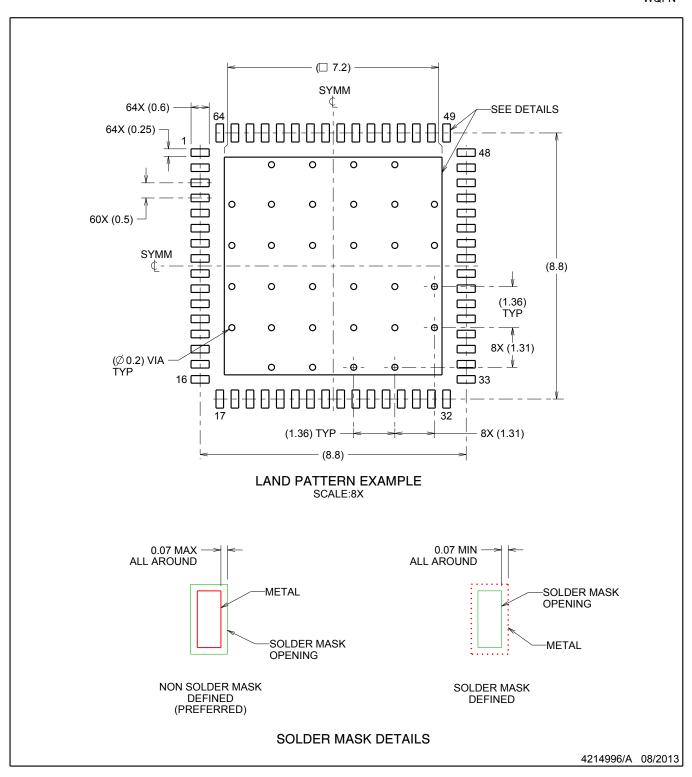
WQFN Α 8.9 PIN 1 INDEX AREA 9.1 0.3 0.2 **DETAIL** OPTIONAL TERMINAL TYPICAL 0.8 MAX С SEATING PLANE (0.1) TYP  $\square$  7.2  $\pm$  0.1 SEE TERMINAL 17 32 60X 0.5 **DETAIL** 4X חחחחח 7.5  $\vdash$ Þ  $64X_{0.2}^{0.3}$ PIN 1 ID 49 (OPTIONAL) 0.1M C AS BS 64X  $^{0.5}_{0.3}$  -0.05M C 4214996/A 08/2013

#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



WQFN

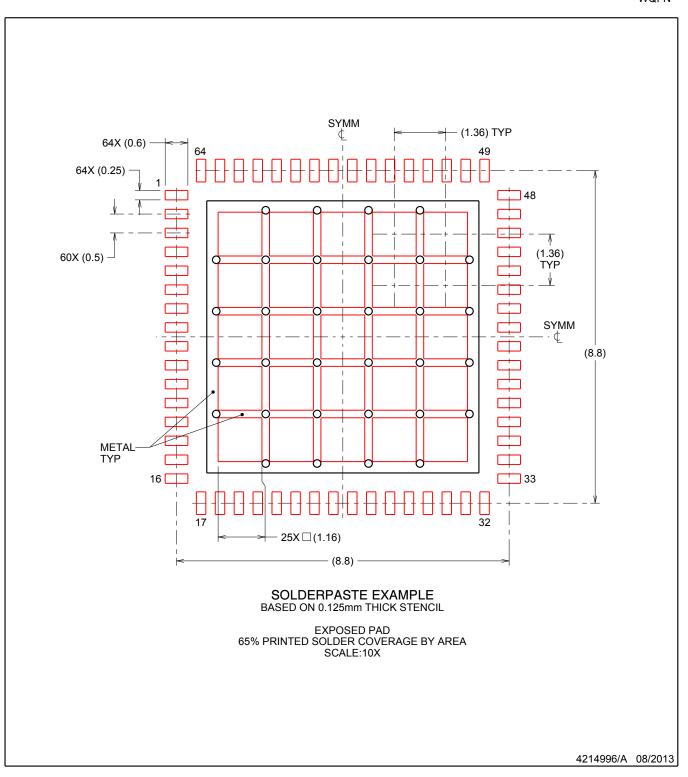


NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).



WQFN



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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